



# Dust

# BUSTER

## Boulder Unmanned Sensor for Transport Events and Repositioner **Spring Final Review**

**Presenters:** Charlie LaBonde, Christine Reilly, Jeff Jenkins, Gabe Castillo, Reidar Larsen, Robert Hakulin

**Team:** Alex St. Clair, Ted Zuzula, Leina Hutchinson, Rachel Tyler, Ryan Aronson

**Customer:** Dr. Xu Wang, Dr. Zoltan Sternovsky

**Advisor:** Dr. Torin Clark



# Overview

Overview

Design

Test  
Overview

Test  
Results

Systems  
Engineering

Project  
Management

# Project Motivation

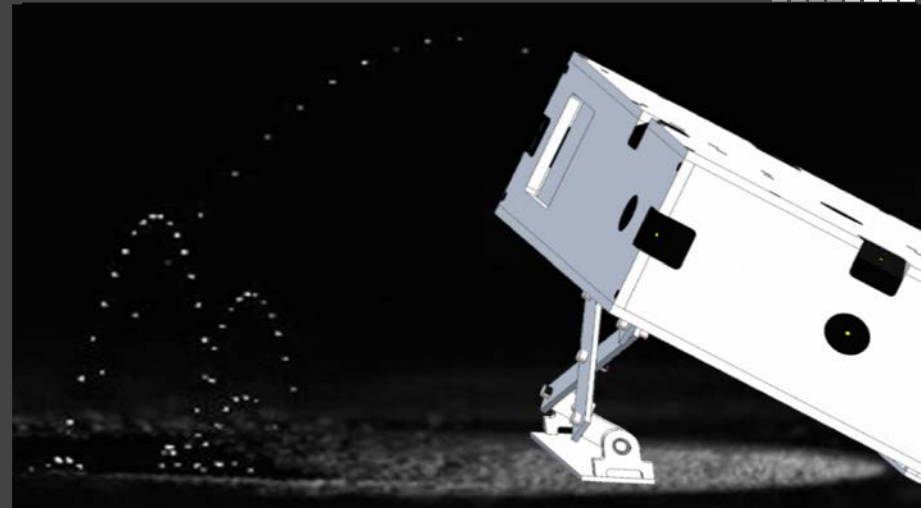


Dr. Wang's research at LASP suggests that charged particles could be lifted by Coulomb force

**Dust transport events:** micron-sized dust particles are charged by various sources in space and ejected from the surface of low-mass bodies

Current instrument is too large for a space application in low-gravity

**Data could be collected with a smaller instrument in a CubeSat form factor, for a potential mission to an asteroid**

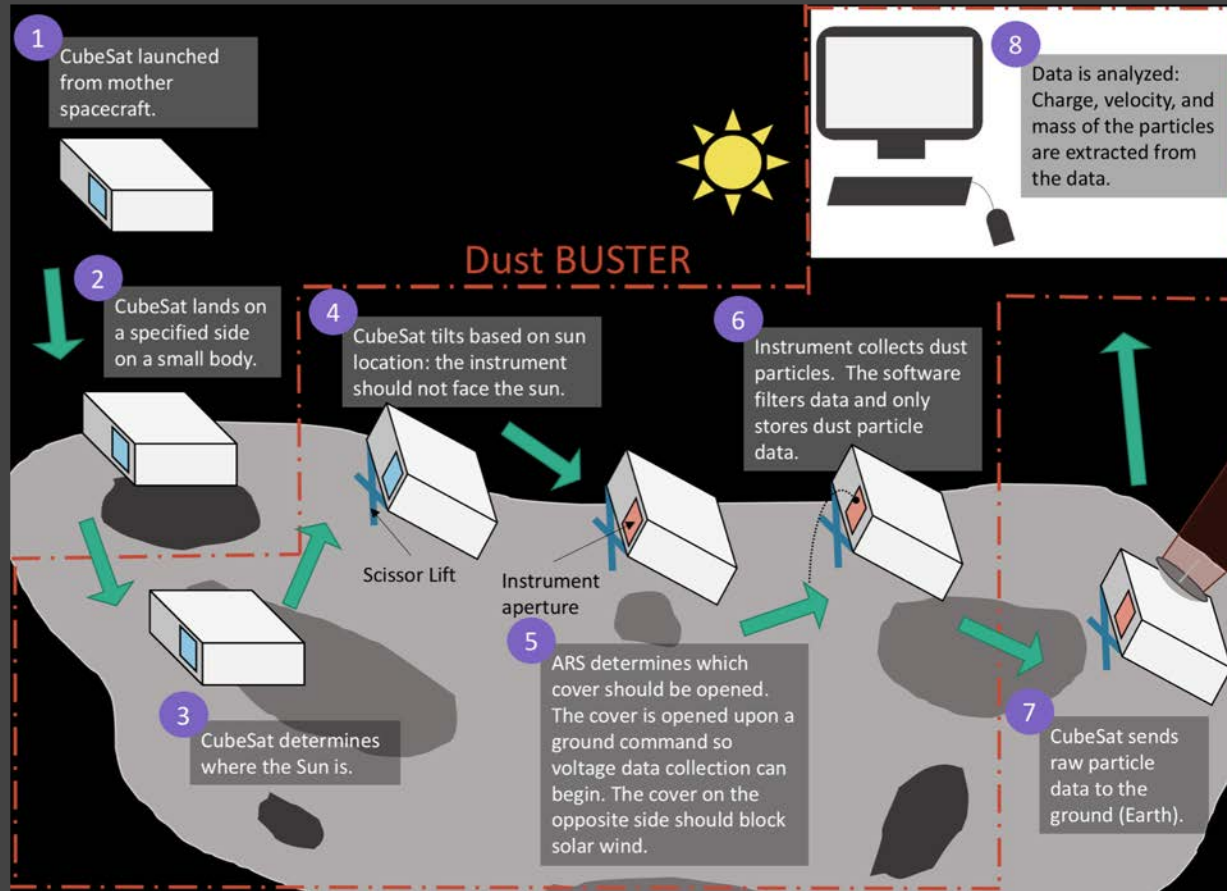


# Project Statement

Dust BUSTER will miniaturize, manufacture, and test a **Technology Readiness Level (TRL) 4** dust instrument to characterize dust transport events similar to those that occur on asteroids. To aid the instrument, the team will also design and test an **Autonomous Repositioning System (ARS)** to tilt a 6U CubeSat to a specified angle for dust collection.



# Overall Mission ConOps



# Levels of Success



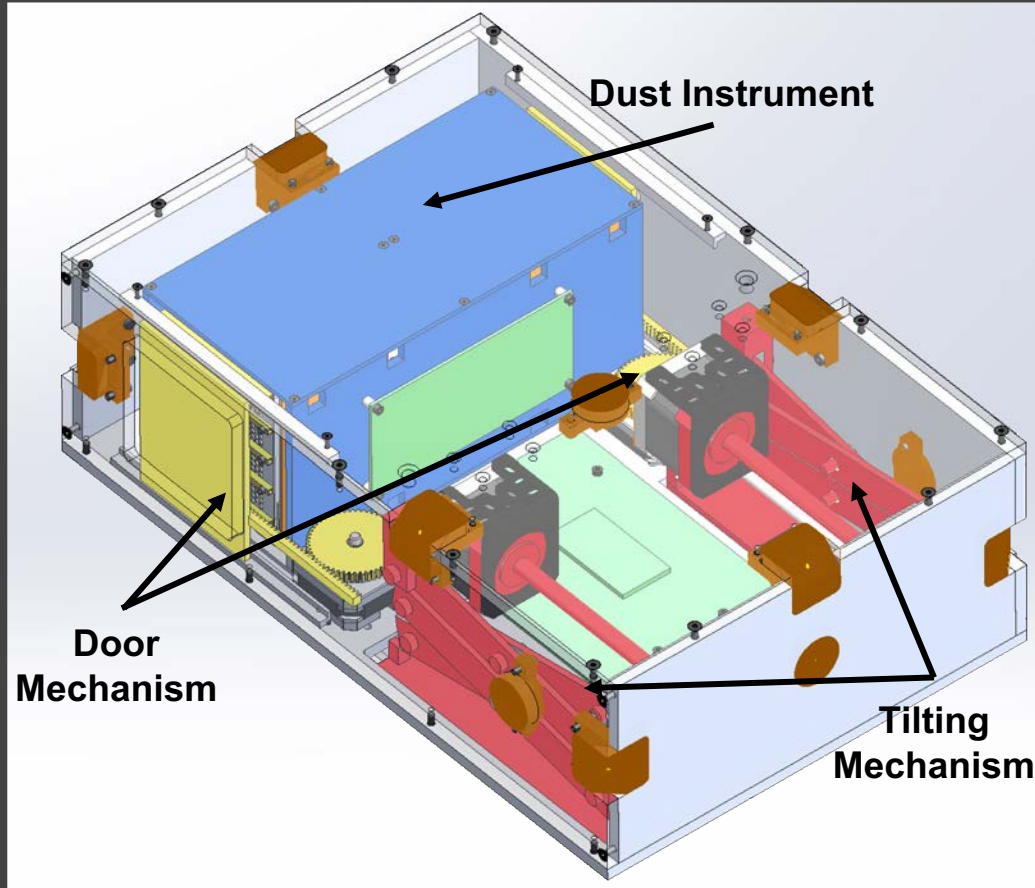
	Level 1	Level 2	Level 3
Instrument	<ul style="list-style-type: none"><li>- 2U TRL 4 dust instrument</li><li>- Operates in vacuum chamber</li><li>- Interfaces mechanically with CubeSat</li></ul>	<ul style="list-style-type: none"><li>- Wire electrodes remain intact upon 10 m/s impact</li></ul>	-
CubeSat/ ARS	<ul style="list-style-type: none"><li>- Construct 6U CubeSat model</li><li>- Tilt CubeSat model up to 45 degrees on a flat surface</li><li>- Determine which side of the CubeSat has the least sun</li></ul>	<ul style="list-style-type: none"><li>- Open loop autonomous tilt with 5° accuracy</li><li>- Operates on sandy surface</li></ul>	<ul style="list-style-type: none"><li>- Closed loop tilt with 1° accuracy</li><li>- Instrument cover opens once under operator command</li></ul>
Software	<ul style="list-style-type: none"><li>- Detect dust via external trigger</li><li>- Send dust data over serial</li><li>- Post processing algorithm extracts mass, velocity, charge</li></ul>	<ul style="list-style-type: none"><li>- Self-triggering dust detection algorithm</li></ul>	<ul style="list-style-type: none"><li>- Determine uncertainty in mass, velocity, and charge</li></ul>



# Design



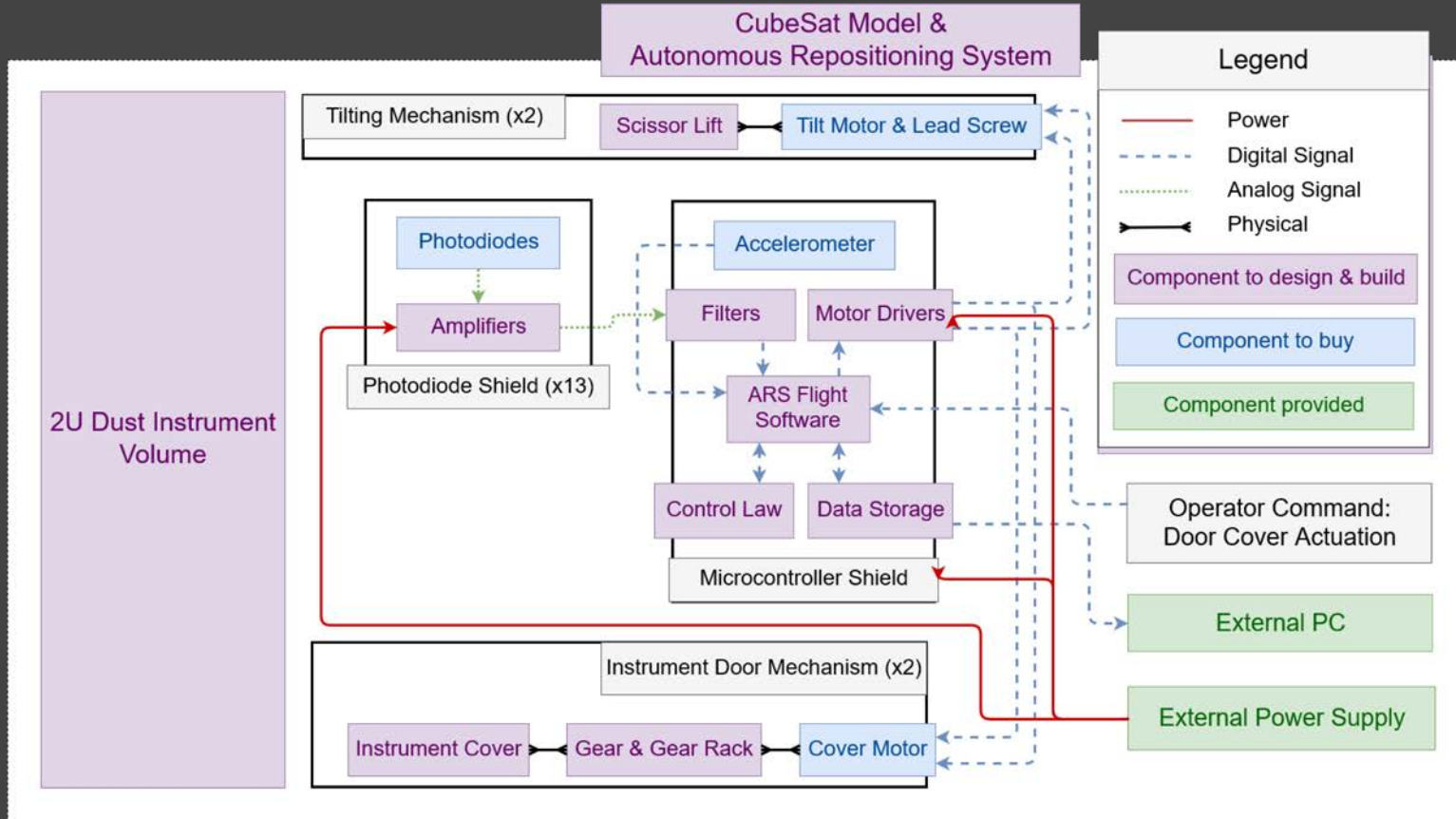
# Design Recap





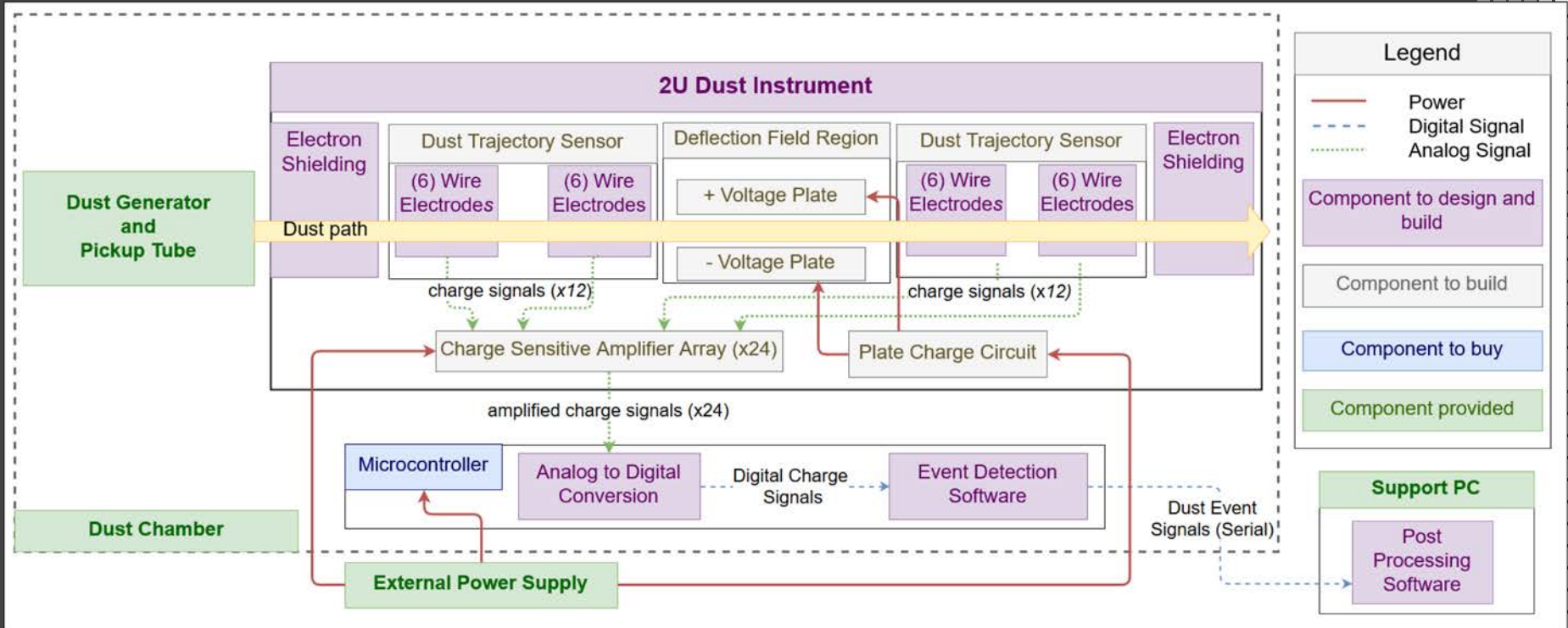


# Autonomous Repositioning System FBD

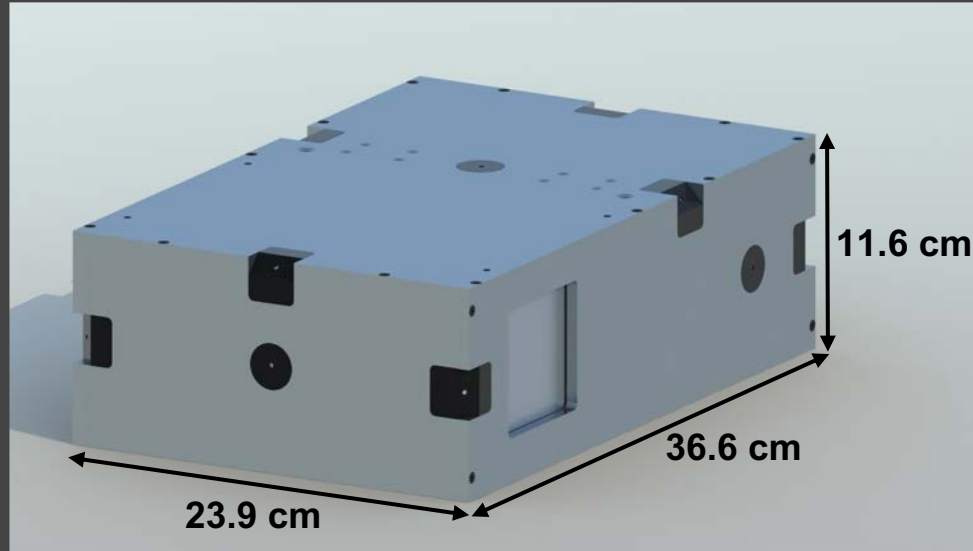




# Instrument Functional Block Diagram

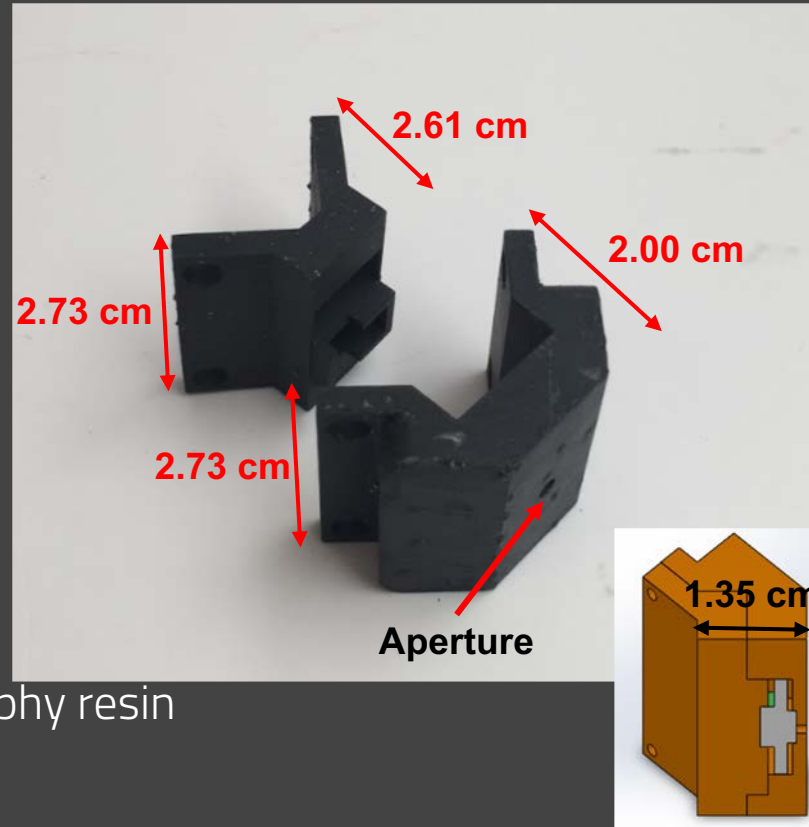
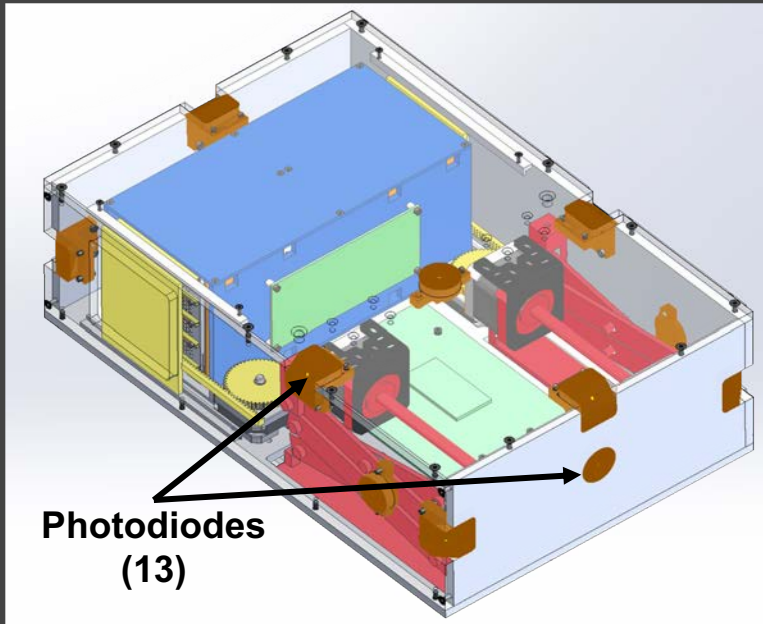


# Design Recap – CubeSat Model



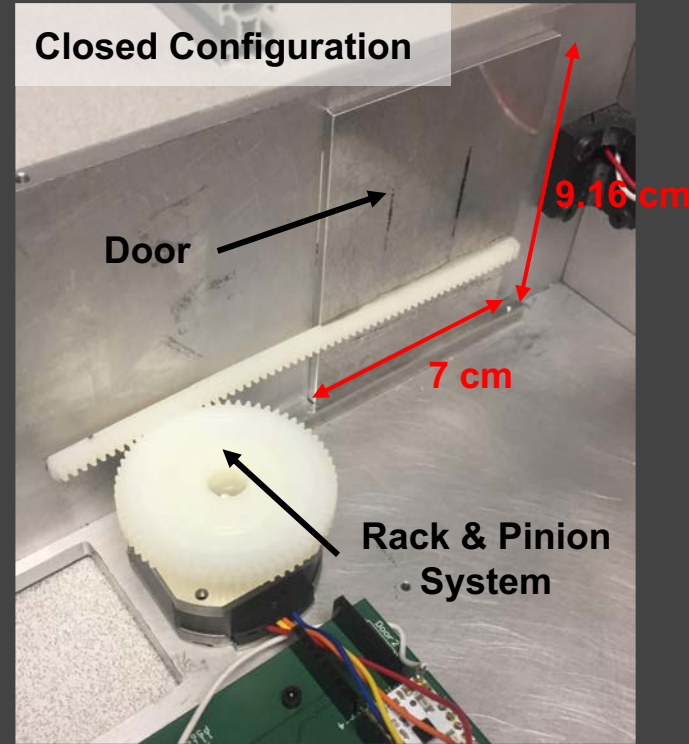
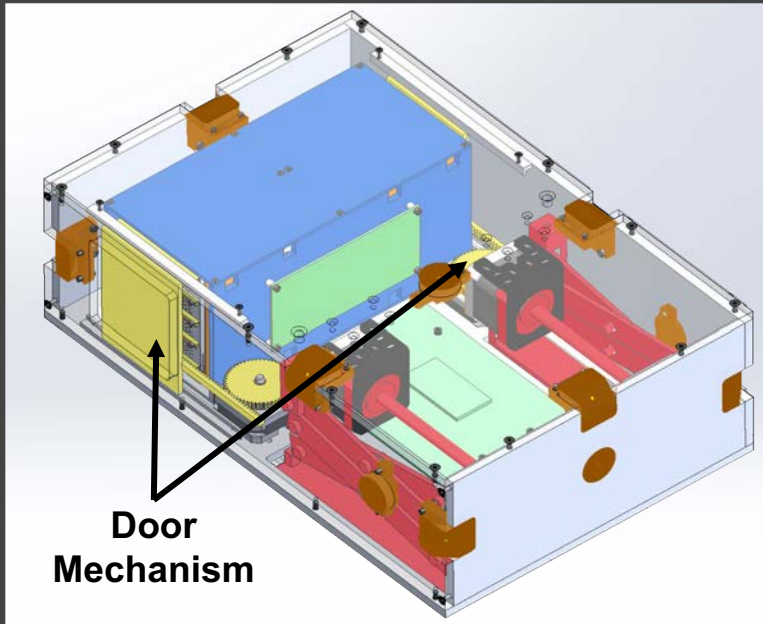
- Material: T-6061 aluminum
- Mass: 8.41 kg (with all systems)
- Dimensions: 23.9 x 36.6 x 11.6 cm

# Design Recap - Photodiodes



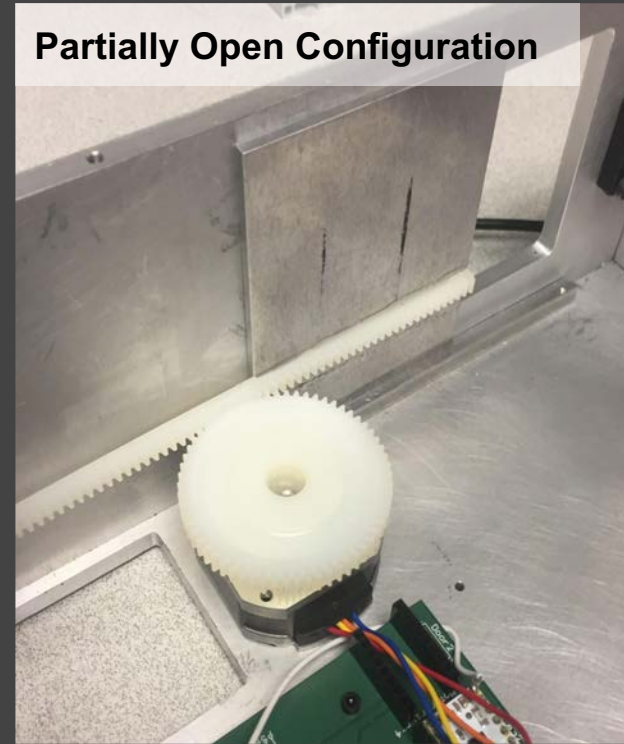
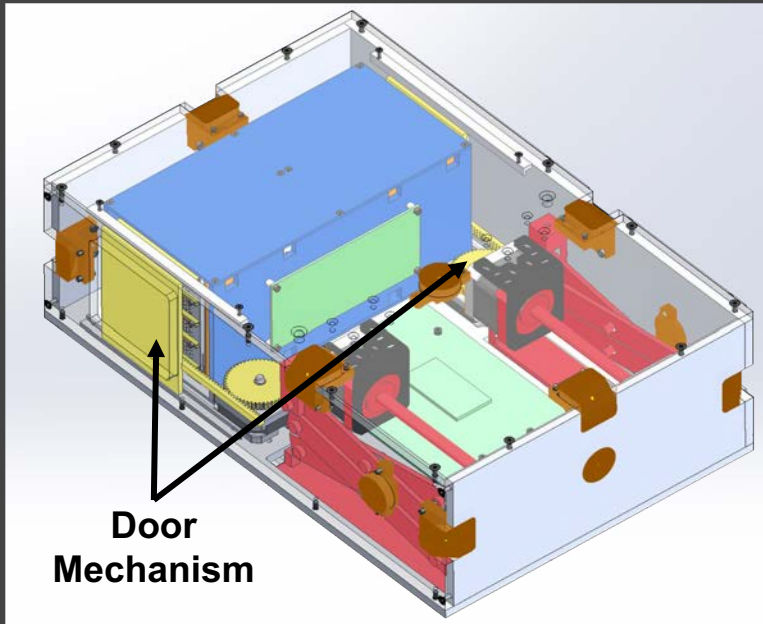
- Material: Formlabs stereolithography resin
- Mass: 0.16 kg (total)

# Design Recap – Door Mechanism



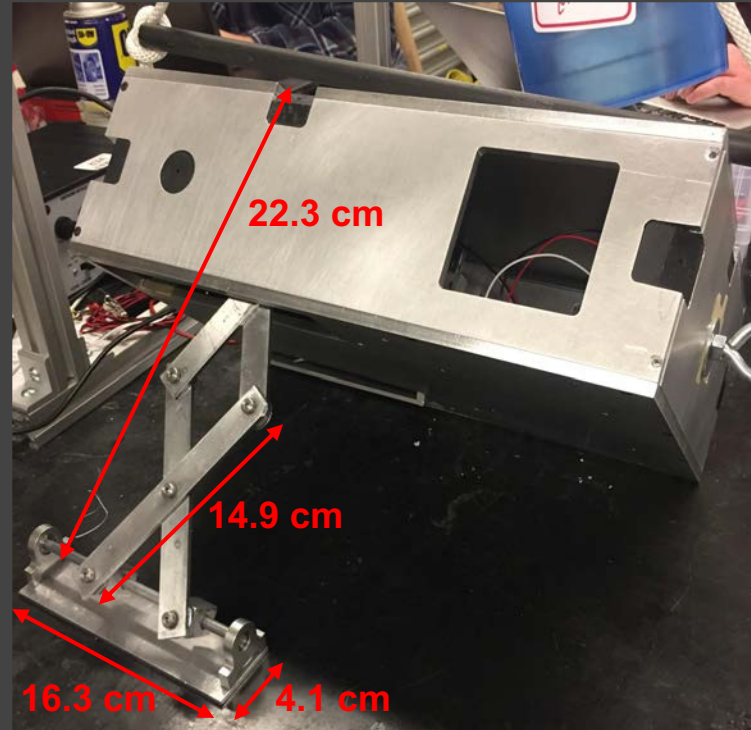
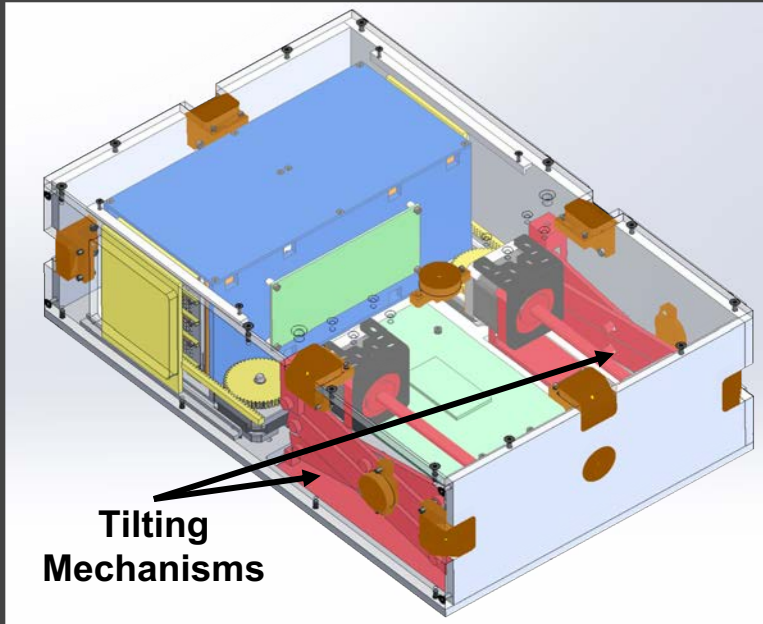
- Material: Aluminum, nylon
- Mass: 0.84 kg (total)

# Design Recap – Door Mechanism



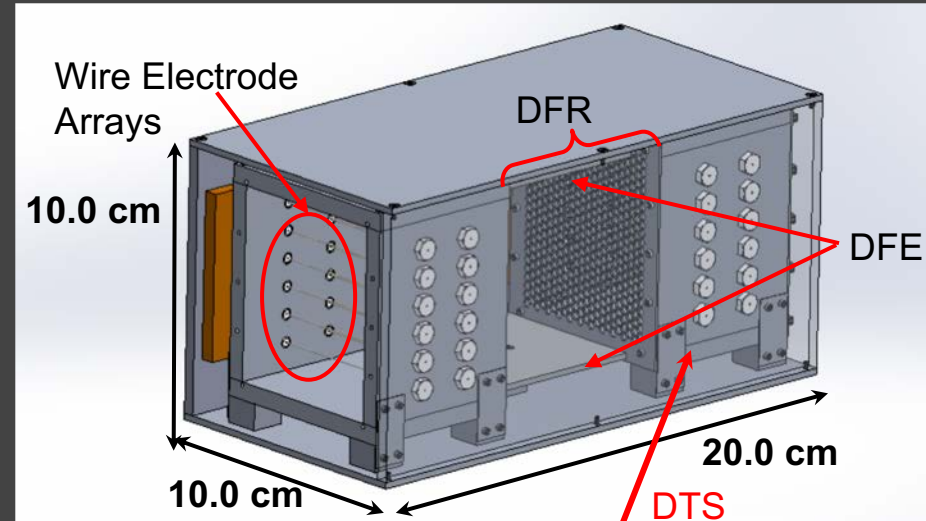
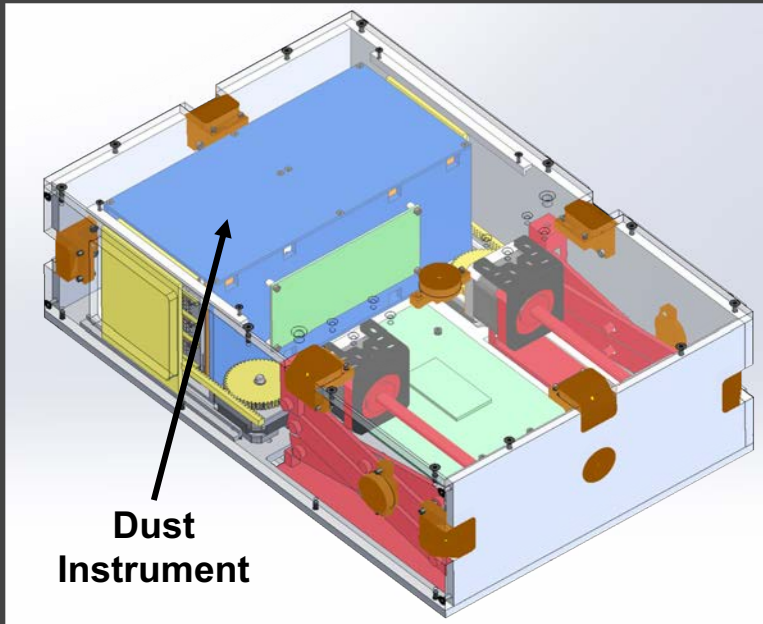
- Material: Aluminum, nylon
- Mass: 0.84 kg (total)

# Design Recap - Scissor Lift

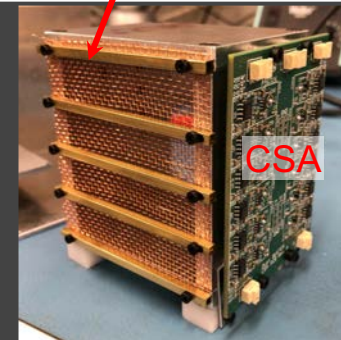


- Material: Aluminum
- Mass: 1.32 kg (total)

# Design Recap - Dust Instrument



- Material: Aluminum, Delrin, PEEK, Stainless steel, Copper
- Mass: 1.47 kg





# Design Recap - Embedded Systems



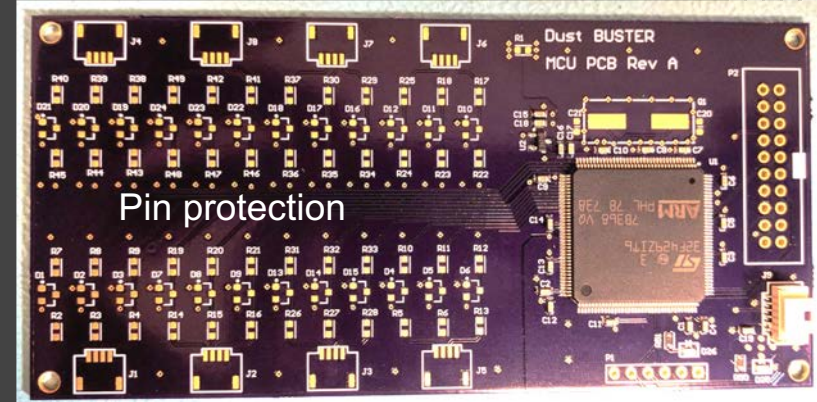
## Microcontroller PCB:

- Handles inputs from all 24 wire electrodes
- Runs real-time software
- Includes protection circuits

## Real-time Software:

- Samples all 24 wire electrodes real-time
- Runs triggering software
- Outputs data over serial

STM32F429ZIT6  
Microcontroller



# Critical Project Elements



Critical Project Element	Relation to Project Success
Surviving Impact	Wire electrodes must survive impact to collect data
Sun determination	Need Sun location to collect good dust data
Tilting mechanism	Tilt required to let dust enter instrument
Real-time event detection	Event detection required to output the correct data



# Test Overview

Overview

Design

Test  
Overview

Test  
Results

Systems  
Engineering

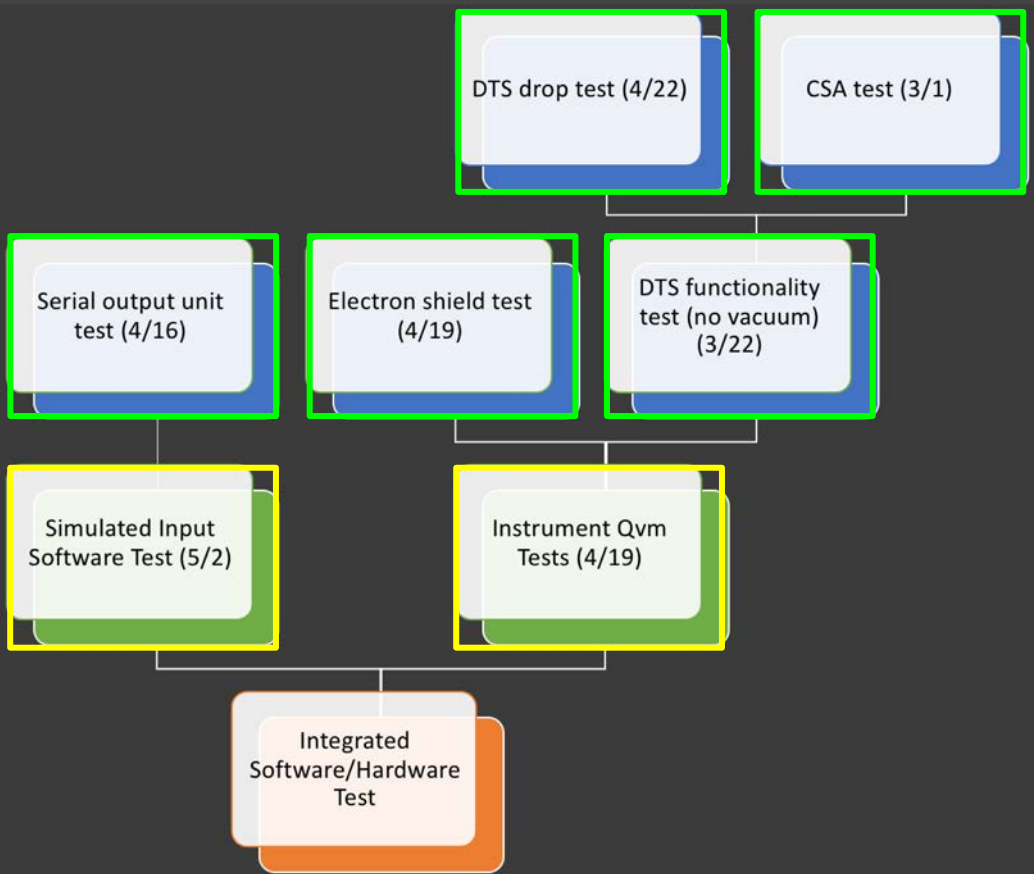
Project  
Management



# Instrument Testing Flow

Complete

In Progress



# Impact Testing



<b>Location</b>	Idea Forge
<b>Equipment</b>	<ul style="list-style-type: none"><li>● Lansmont 15D shock test machine</li><li>● Crossbow CXL10LP3 Accelerometer</li><li>● DTS unit</li><li>● DAQ and LabView VI</li></ul>
<b>Data Out</b>	<ul style="list-style-type: none"><li>● Acceleration data<ul style="list-style-type: none"><li>○ Integrate for impact velocity</li></ul></li><li>● Inspect wire electrodes to determine if broken</li><li>● Iterate at higher impact velocities</li></ul>
<b>Requirements Verified</b>	<ul style="list-style-type: none"><li>● SR 2.5: Instrument wire electrodes shall remain intact after a 10 m/s impact on a rigid surface.</li></ul>



Lansmont Machine

# IMPACT Lab Testing



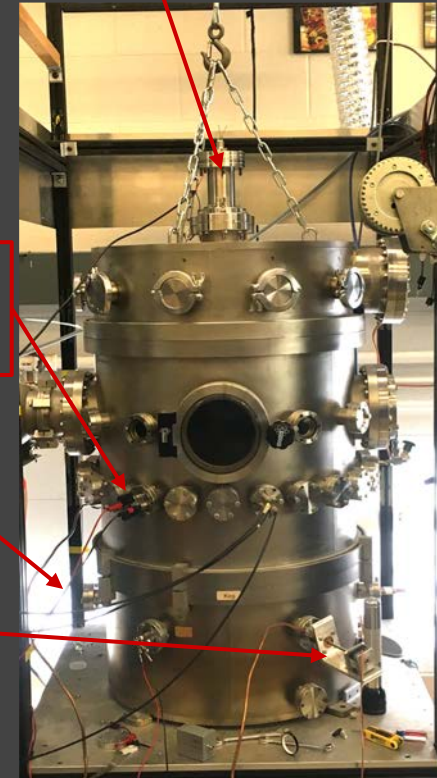
<b>Location</b>	IMPACT Lab (CU East Campus)
<b>Equipment (Customer Provided)</b>	<ul style="list-style-type: none"><li>• Vacuum chamber (w/ pump)</li><li>• Vacuum wall cable interfaces</li><li>• Dust dropper</li><li>• Free electron emitter</li><li>• Power supplies (<math>\pm 2.5V</math>, <math>\pm 15V</math>, <math>\pm 5kV</math>)</li><li>• Data acquisition system</li><li>• Translation table</li></ul>
<b>Data Out</b>	<ul style="list-style-type: none"><li>• Analog voltages<ul style="list-style-type: none"><li>◦ One set each for charge (Q), velocity (v), and mass (m)</li></ul></li></ul>
<b>Requirements Verified</b>	<ul style="list-style-type: none"><li>• FR 2: Detect dust particles that enter the instrument</li><li>• FR 5: Collect dust signals and issue commands to and from the instrument and ARS</li><li>• FR 6: Process data and detect dust events</li></ul>

Dust Dropper

Feed Through Ports

Pump

Translation Table Motor

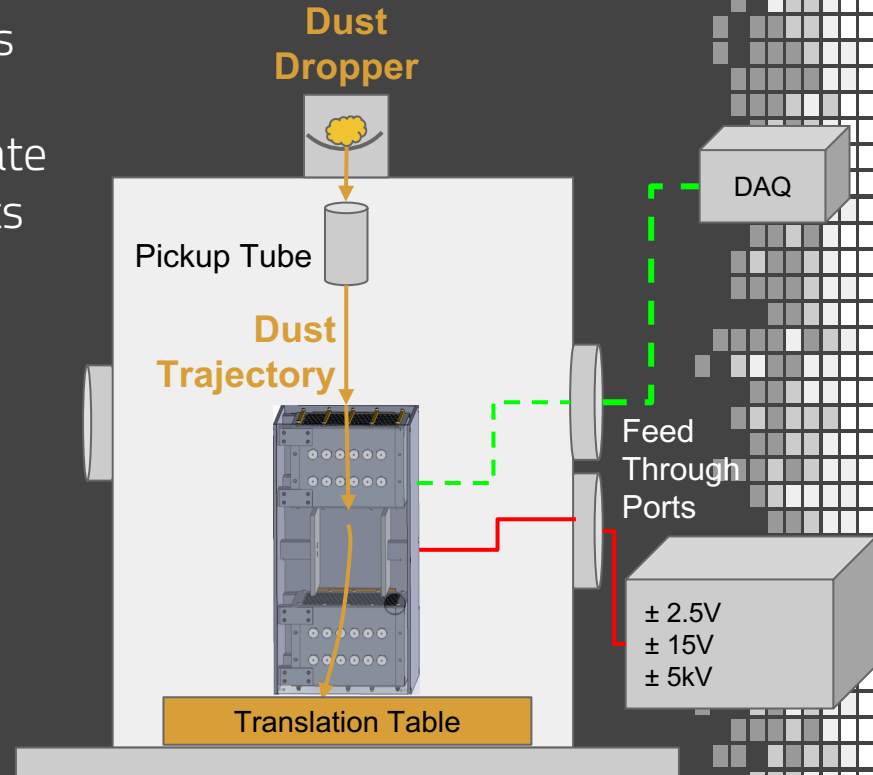


# Full Instrument Test Modifications



Software difficulties required modification to test set-up to be able to verify requirements  
7-channel DAQ will be used to collect data  
Charge will be independently verified separate from mass and velocity in two different tests due to limited number of DAQ inputs

Data Type	Setup
Charge ( $Q$ )	One electrode plane
Mass ( $m$ )	Subset of channels from all four planes
Velocity ( $v$ )	Two electrode planes in one DTS

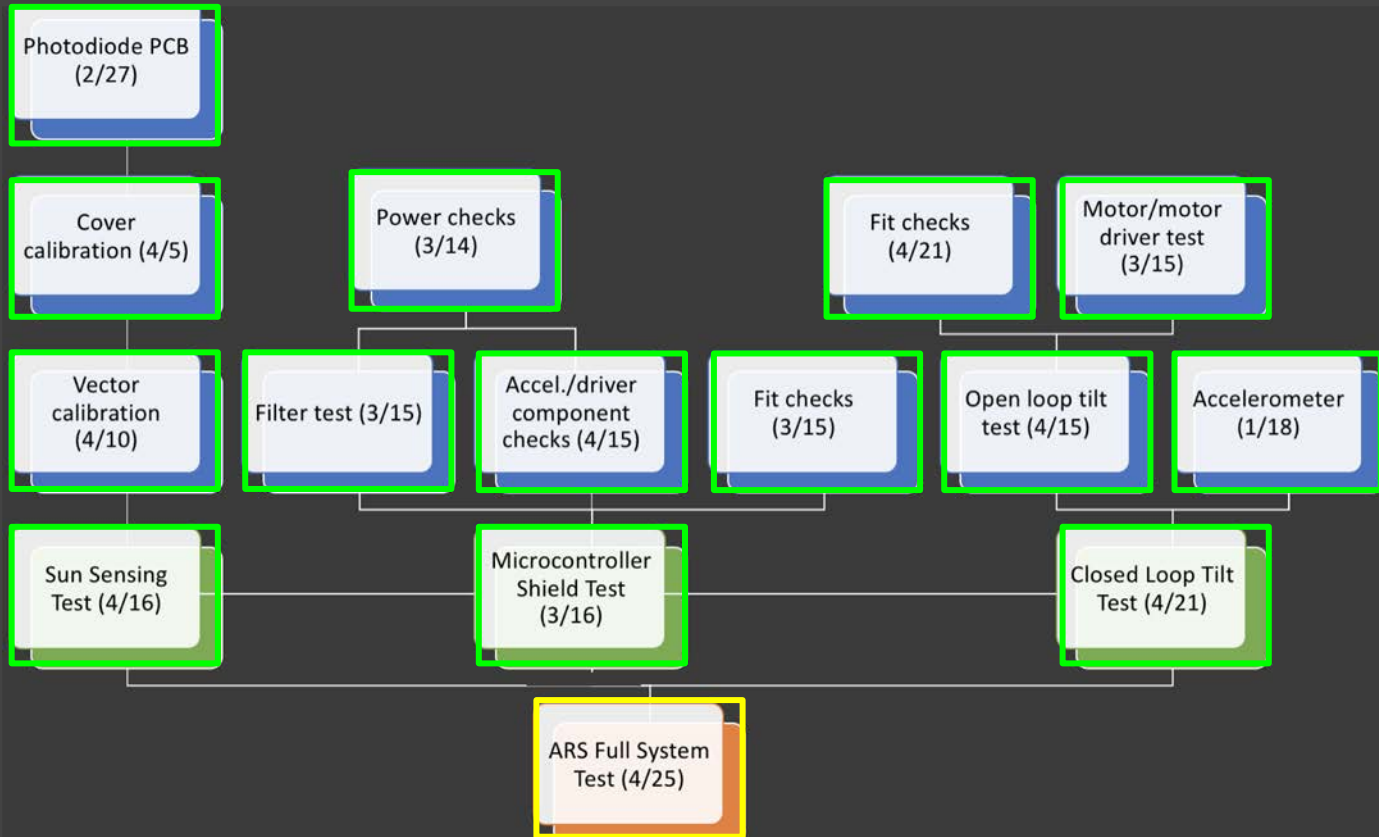


# ARS Testing Flow



Complete

In Progress

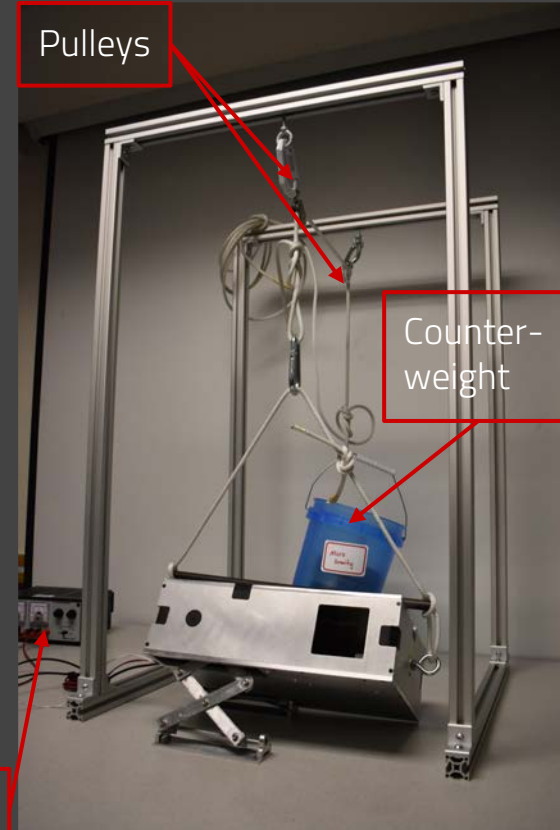




# ARS Tilt Testing



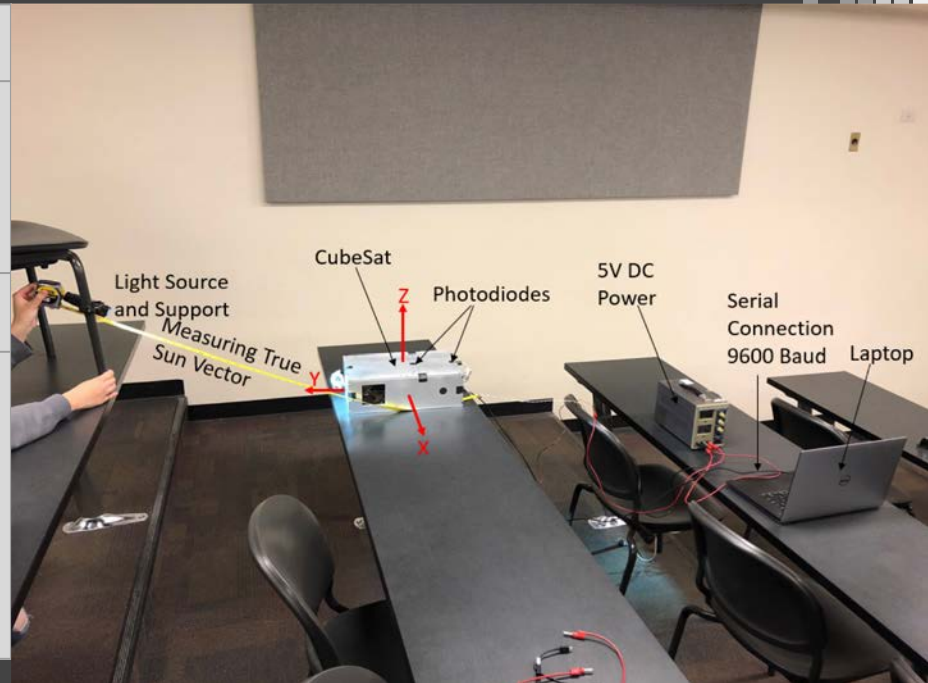
<b>Location</b>	Senior Projects Depot
<b>Equipment</b>	<ul style="list-style-type: none"><li>• Fully assembled CubeSat</li><li>• Power supply (5V and 3V)</li><li>• Pulley/counterweight system</li><li>• PC</li></ul>
<b>Data Out</b>	<ul style="list-style-type: none"><li>• Commanded and achieved tilt angle</li></ul>
<b>Requirements Verified</b>	<ul style="list-style-type: none"><li>• FR 1: Contain the ARS and 2U instrument within 6U volume and mass limits</li><li>• FR 3: Open instrument cover pointing away from the sun to avoid solar wind</li><li>• FR 4: Tilt the CubeSat up to a max of 45° off the surface, optimal for dust collection</li><li>• FR 6: Process data and run ARS algorithms</li></ul>

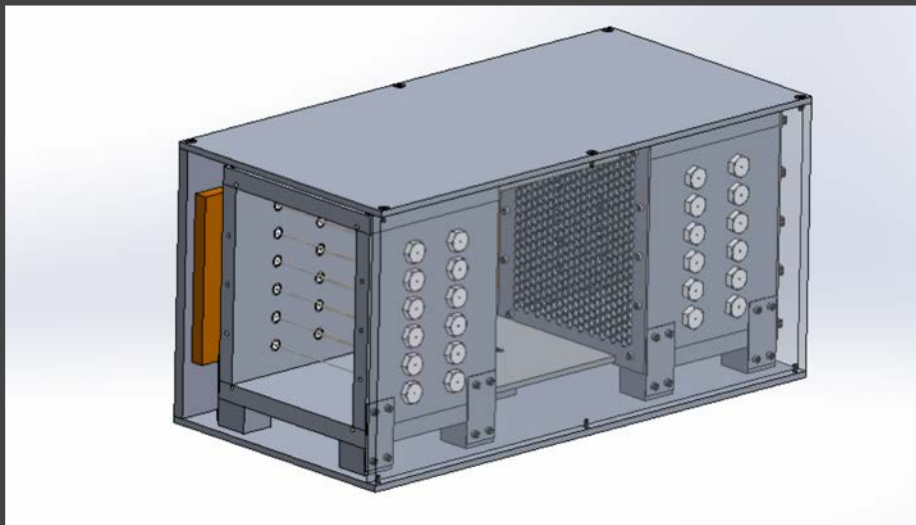


# ARS Sun Testing



<b>Location</b>	Dark Room
<b>Equipment</b>	<ul style="list-style-type: none"><li>• Fully assembled CubeSat</li><li>• Power supply (5V)</li><li>• Flashlight</li><li>• PC</li></ul>
<b>Data Out</b>	<ul style="list-style-type: none"><li>• Sun vector</li></ul>
<b>Requirements Verified</b>	<ul style="list-style-type: none"><li>• FR 3: Open instrument cover pointing away from the sun to avoid solar wind</li><li>• FR 4: Tilt the CubeSat up to a max of 45° off the surface, optimal for dust collection</li><li>• FR 6: Process data and run ARS algorithms</li></ul>





# Instrument Test Results

Overview

Design

Test  
Overview

Test  
Results

Systems  
Engineering

Project  
Management

# DTS Drop Test

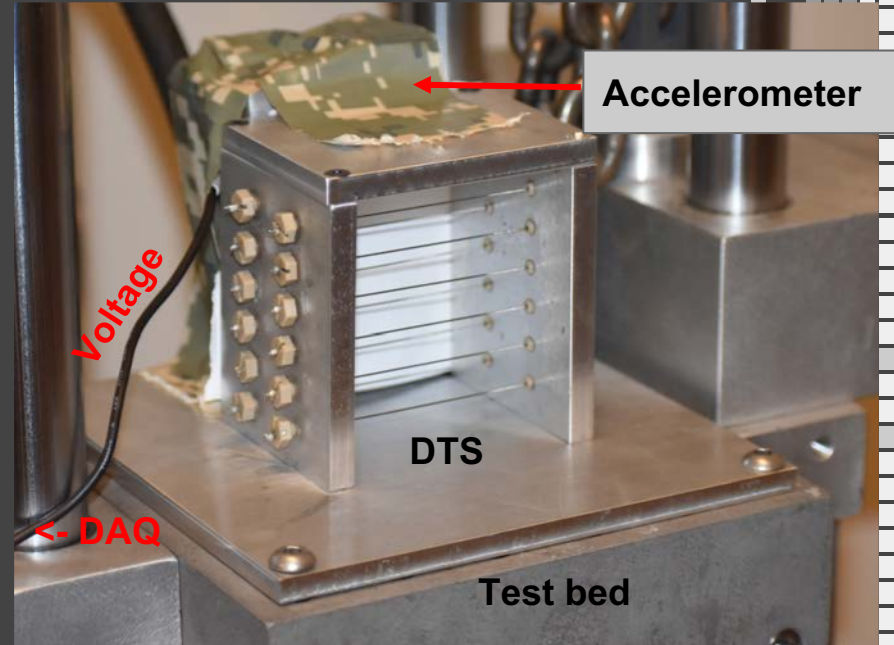


Focusing on wire electrodes

Solidworks model predicts that the wire electrodes will survive a 10 m/s impact

Maximum achievable drop height was 127 cm, corresponding to a measured 4.7 m/s with Lansmont machine

Unable to test a 10 m/s impact



# DTS Drop Test Results

Maximum tested velocity: 4.7 m/s

All 12 wire electrodes remained intact and measurement planes were unaffected

M3 bolt threading weakened allowing structure to wiggle (shown below)

Consider bolt hole redesign

**Requirement 2.5 not fully verified**

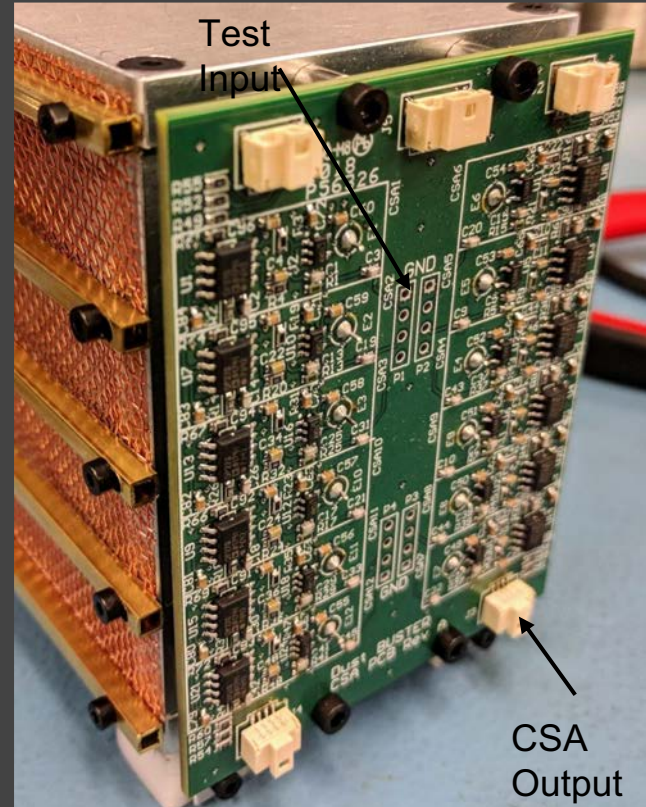


# CSA Verification



## Charge Sensitive Amplifier PCB:

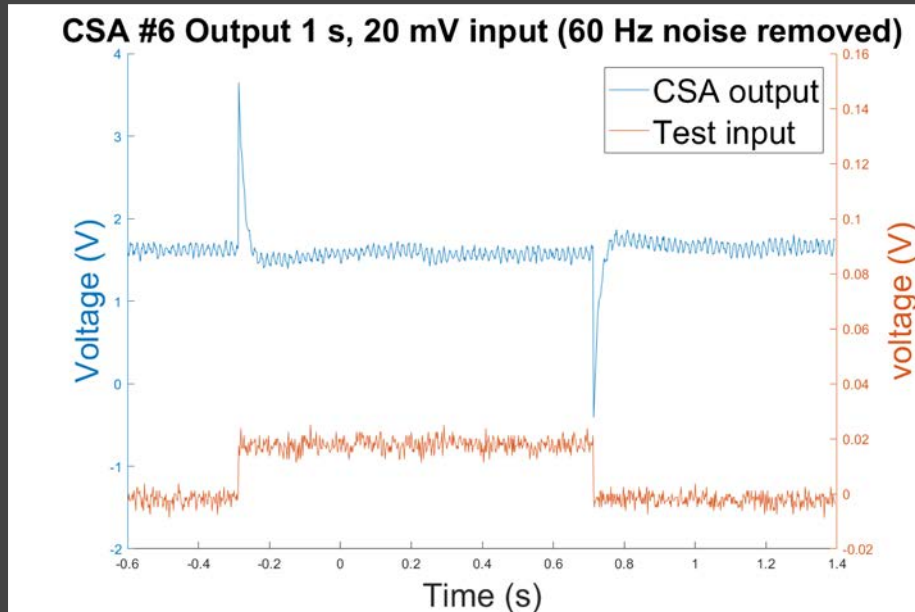
- No revisions needed
- CSAs have customer-accepted noise level and can amplify dust signals as expected
- 1 test board partially populated
- 3 final boards fully populated/verified



# CSA Verification Result



Compare output to expected behavior of ideal circuit

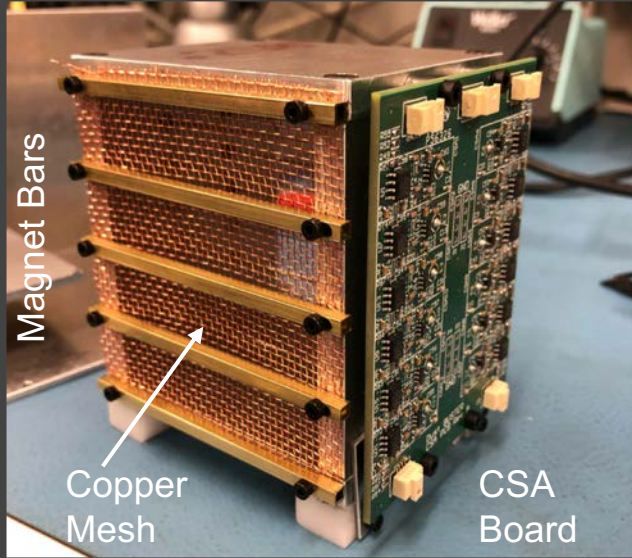


	Ideal Op-amp Model (V)	Result (V)
Average	1.61	1.61
Positive Pulse Magnitude	2.00	2.04
Negative Pulse Magnitude	2.00	2.02

Requirement 5.1 Verified:  
The instrument circuit shall implement a charge sensitive amplifier for each electrode.



# Dust Trajectory Sensor (DTS) Unit Test

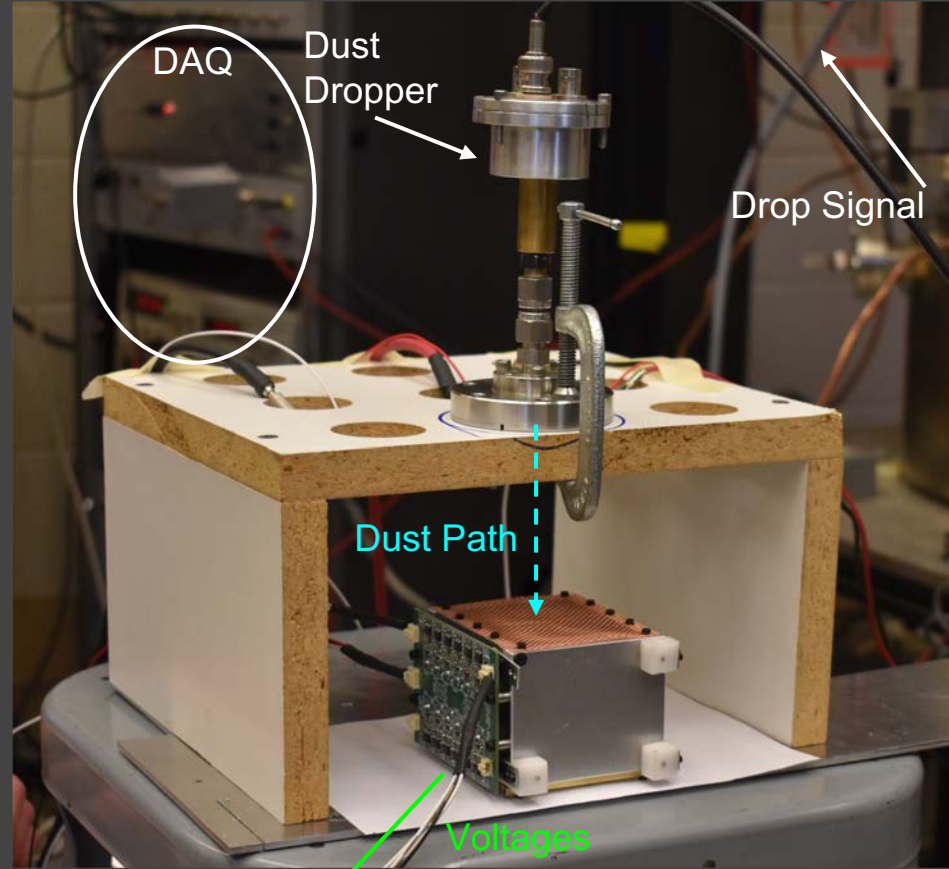


Magnet Bars

Copper Mesh

CSA Board

Fully Constructed DTS Unit



DAQ

Dust Dropper

Drop Signal

Dust Path

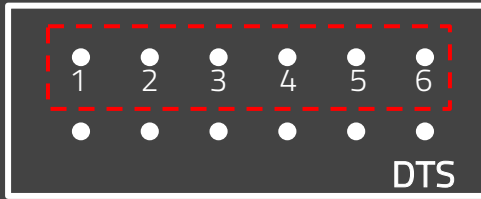
Voltages





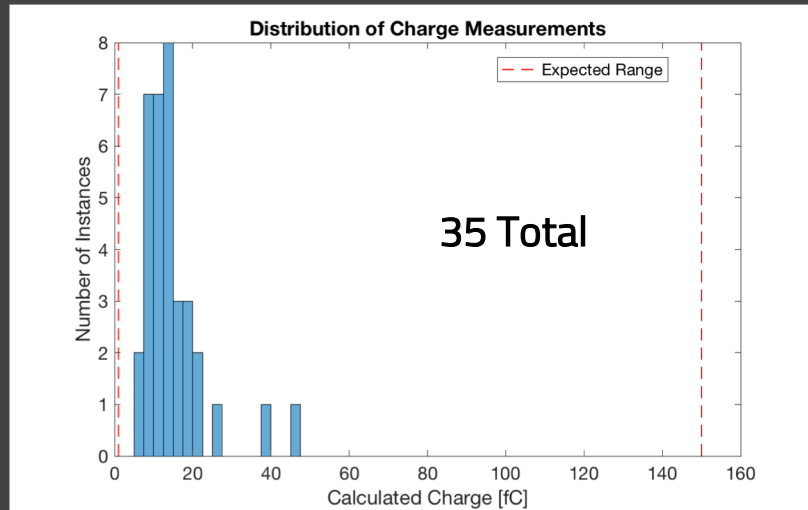
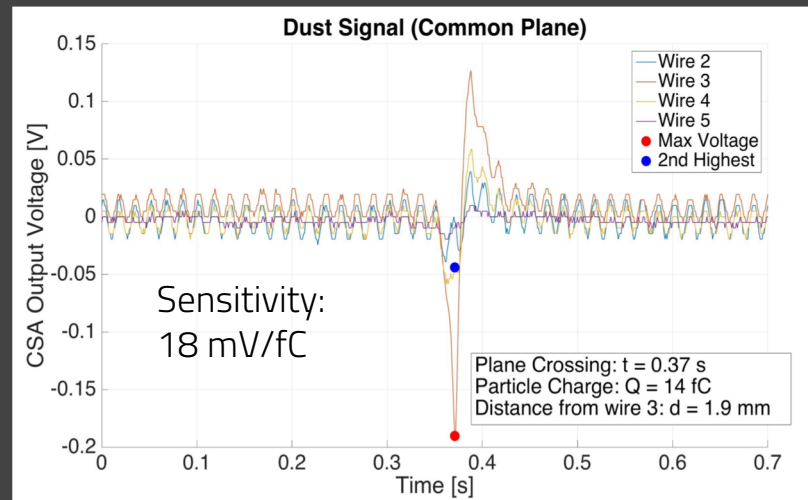
# DTS Charge Test Results

Test Setup:



Due to hardware limitations only 6 channels can be read  
Expected Range (from customer):  
**1-150 fC**  
Experimental Range:  
**5-40 fC**

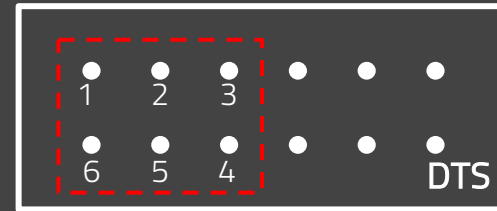
DTS can successfully detect dust event, measure charge, and calculate z-coordinate of plane crossing





# DTS Velocity Test Result

Test Setup:



7 total successful velocity events  
Measure time difference between  
plane crossing

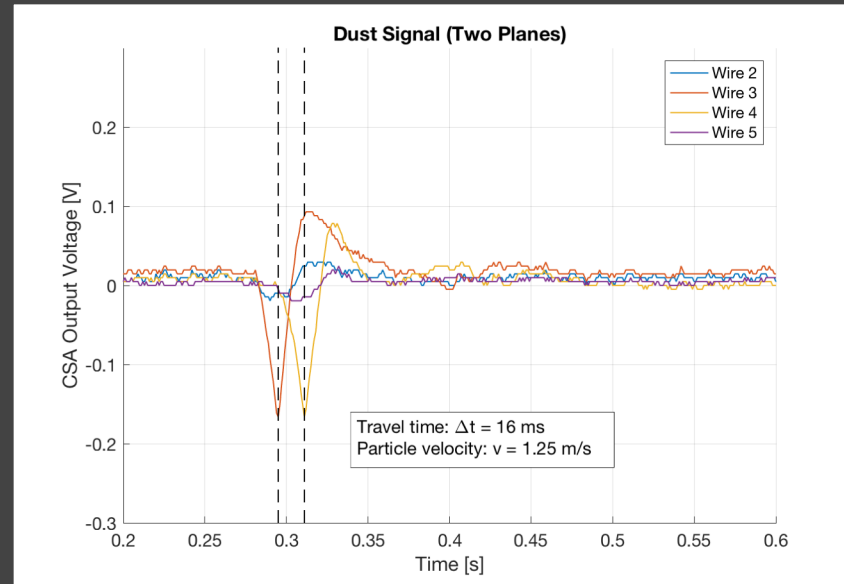
Expected Range (from customer):

**1 - 2 m/s**

Experimental Range:

**0.80 - 1.25 m/s**

DTS can accurately measure velocity  
of the dust particle around range  
requested by the customer



# Embedded System Status



Microcontroller PCB: **Complete**

- No revisions needed

- Can flash code and debug execution

- Protection circuits work as designed

- 2 test boards partially populated

- 1 final board fully populated/verified

Real-time Software: **In Progress**

- Redesigning architecture for simulated ADC data to test rest of software

Software/Hardware Integration: **Incomplete**

# Embedded System Design Rationale



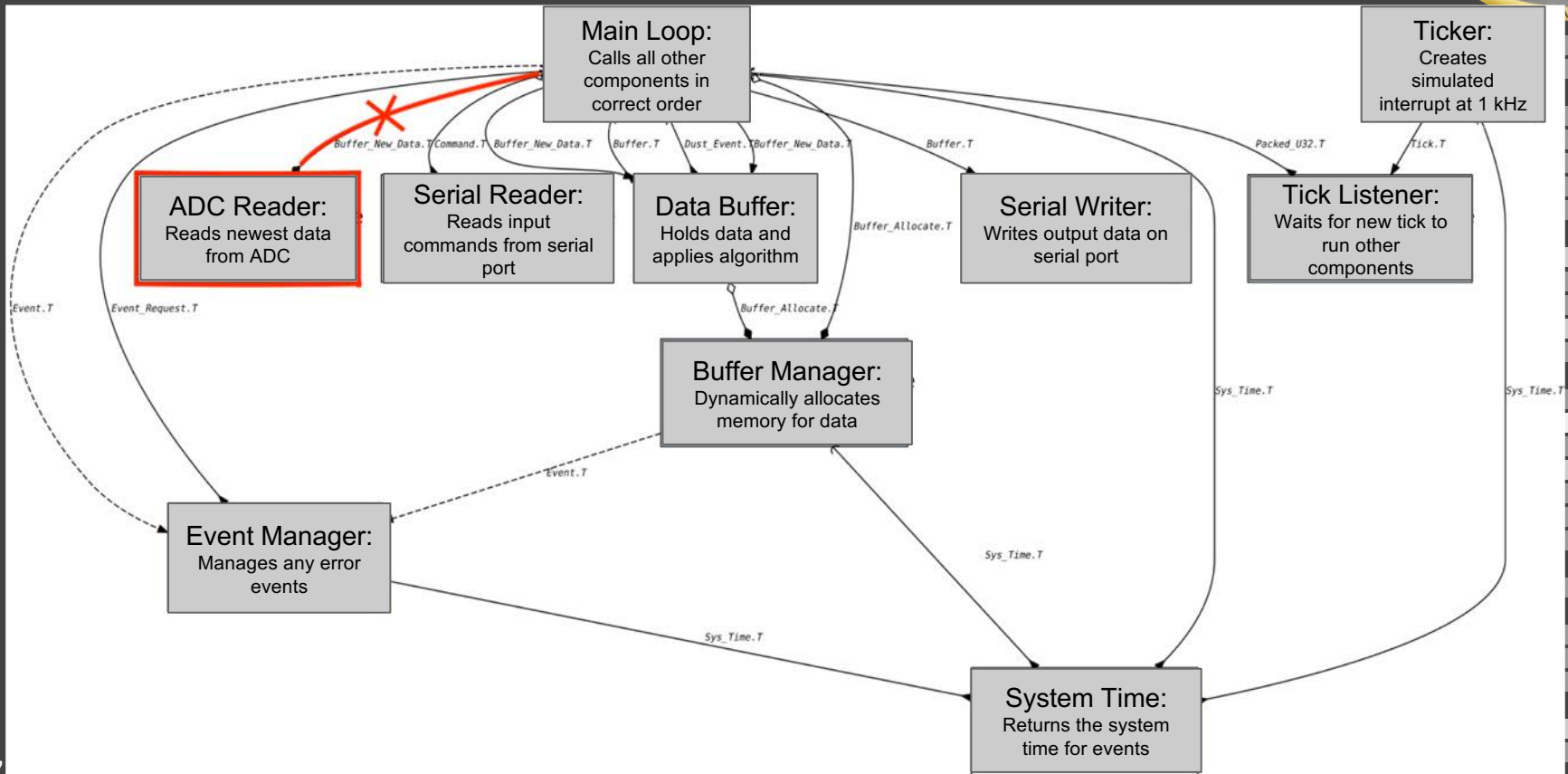
5.2.1 The hardware shall convert analog signals from each of 24 instrument amplifiers to digital at 1 kHz.

6.3 The instrument software shall continuously analyze data in order to detect all dust events.

Custom design chosen so that microcontroller peripherals could handle fast sampling of 24 integrated ADC channels without needing software control

Required adding microcontroller ADC pin protection  
LASP Adamant flight software framework chosen to alleviate real-time software architecture difficulty

# Software System Diagram



# Instrument Remaining Work



## Software/Hardware Integration

Drivers need to be written to configure MCU timer, ADCs, and DMA for 1 kHz sampling and data manipulation

Required MCU configuration is well-known

Interface from MCU peripherals to software needs to be implemented

Simulated dust event data will be used to attempt to trigger the algorithm and print results to text file

Will show ability of software to detect dust, output data, and respond to input user commands

Will verify that system can operate within 1 kHz frequency

# Instrument Conclusions

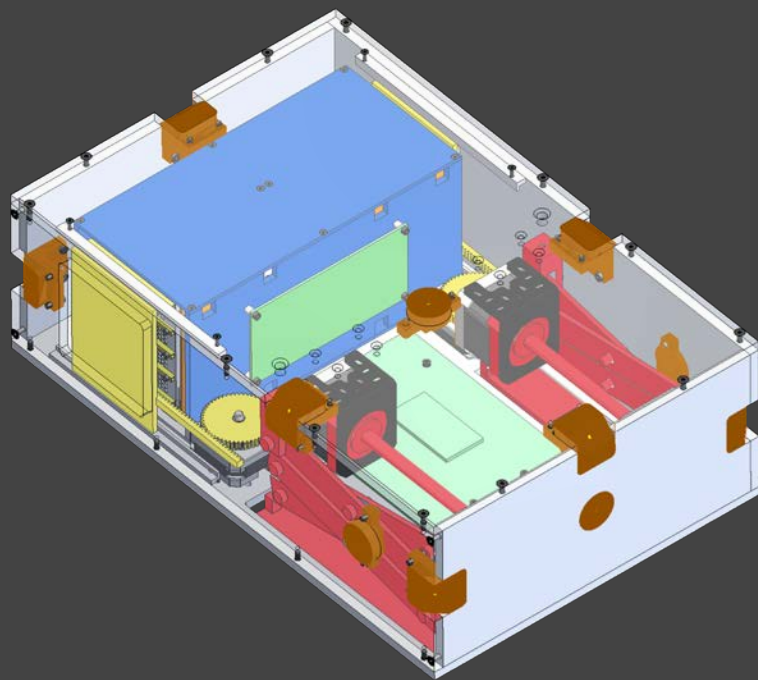


Requirement	Level 1 Success	Level 2 Success	Level 3 Success
Hardware	Detects dust Operates in vacuum	10 m/s impact	-
Software	External trigger Send data over serial Post processing algorithm	Self triggering algorithm	Uncertainty in $Q, v, m$

Requirements for stand-alone embedded system were over-ambitious and tightly-coupled

Team lacked sufficient time and expertise to handle all aspects of the design  
Should have looked for a capable COTS hardware solution in order to focus on software design needs

Adamant framework limited the ability for other team members to help



# ARS Test Results

Overview

Design

Test  
Overview

Test  
Results

Systems  
Engineering

Project  
Management

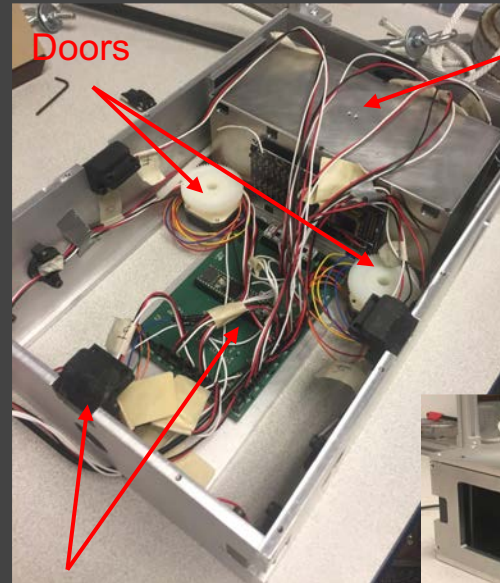


# Mass and Volume Requirements



FR 1 The CubeSat model shall contain the ARS and 2U instrument within 6U volume and mass limits.

All components mounted inside the CubeSat shell and closed  
Final mass of 8.41 kg  
< 12 kg max  
Dimensions: 23.9 x 36.6 x 11.6 cm

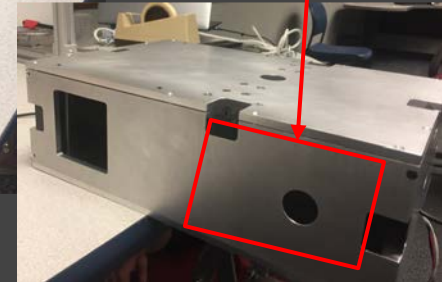


Doors

Instrument

Lift inside

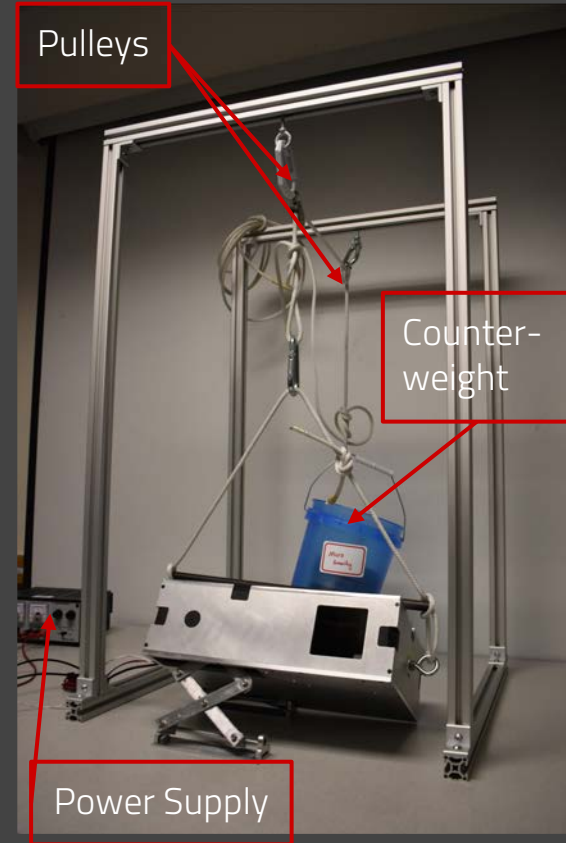
Photodiodes/  
ARS electronics



# Tilt Test Setup



Used a rope and pulley system  
Rope connects CubeSat to counterweight through pulley system  
Attaches to center of mass of CubeSat  
Power is provided using external power supply  
Measure angles using accelerometer and protractor  
Command teensy to step motors by a predetermined amount from model  
Open loop by manual commanding  
Closed loop using accelerometer feedback





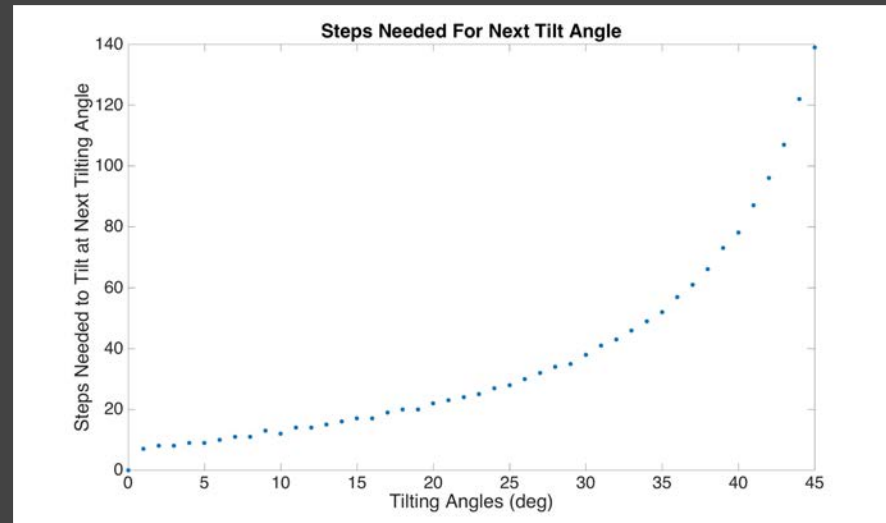
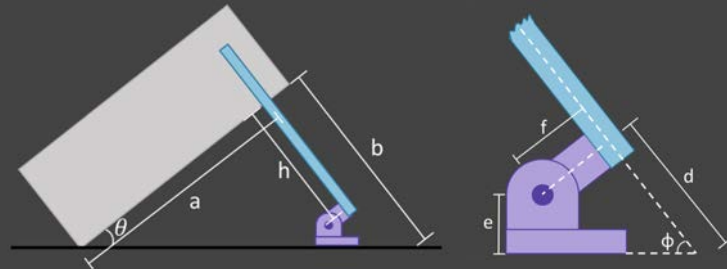
# Tilting Model

Tilting model calculates tilt angle based off of geometry in CubeSat

Takes into account "foot" and internal portion of the leg

Initial tests showed some deviations from our model, especially at early tilt angles

Were a result of manufacturing tolerance stack up and test setup problems



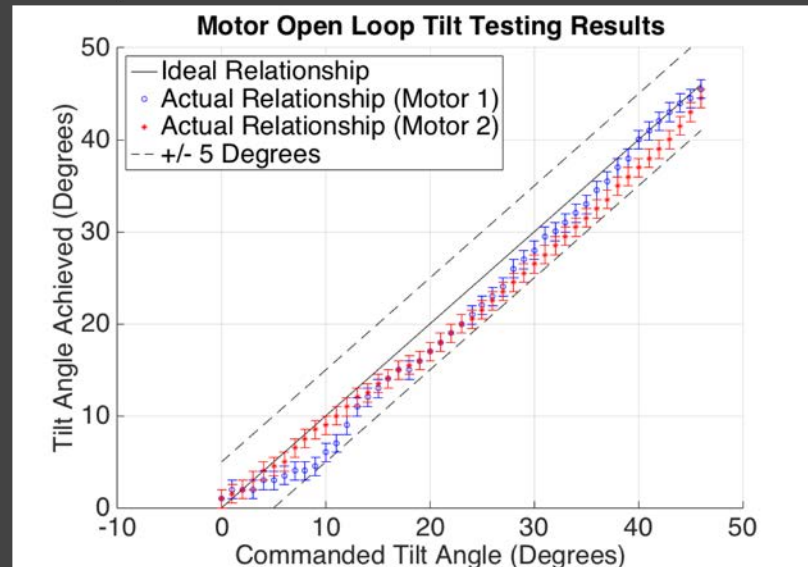
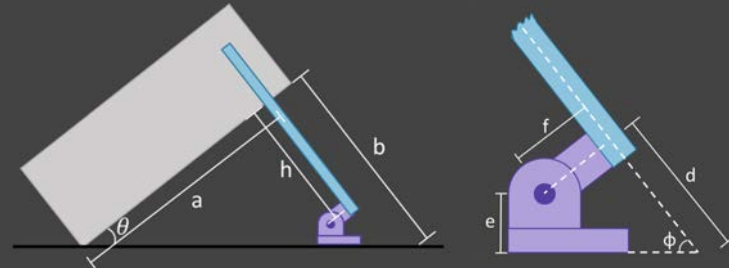
# Tilting Model

Tilting model calculates tilt angle based off of geometry in CubeSat

Takes into account "foot" and internal portion of the leg

Initial tests showed some deviations from our model, especially at early tilt angles

Were a result of manufacturing tolerance stack up and test setup problems



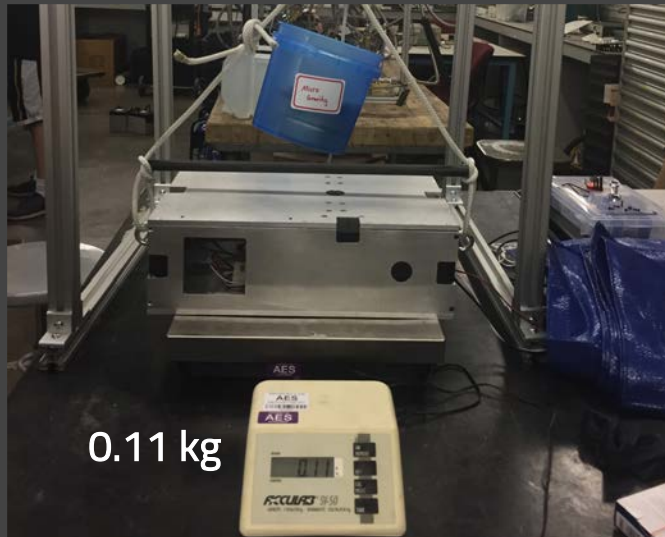


# Tilting Test Problems

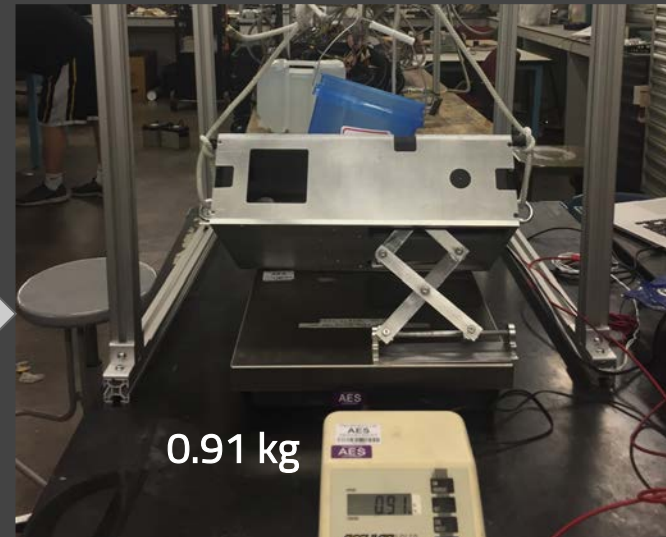
Friction in pulley made it difficult to consistently represent microgravity environment

As tilt angle increased, mass that the scale was reading increased from 0.11 kg to 0.91 kg

Had to further reduce weight of CubeSat as it was tilting



Tilt 30°



# Tilting Test Problems



Tolerance stack up led to issues in leg deployment

Leg platform jammed against leg opening

Opening was shifted 0.07" towards CubeSat edge

Legs were short 0.05"

Only gave ourselves 0.1" margin

Also lead to increased friction in scissor lift

Lead to missed steps during tilting, especially at low tilt angles

Ultimately cannot verify that we can tilt the mass that we designed for



**Requirement 4.122 Incomplete:** The actuators shall be able to tilt a mass equal to 100g, with a 20g resolution, under earth's gravity field.

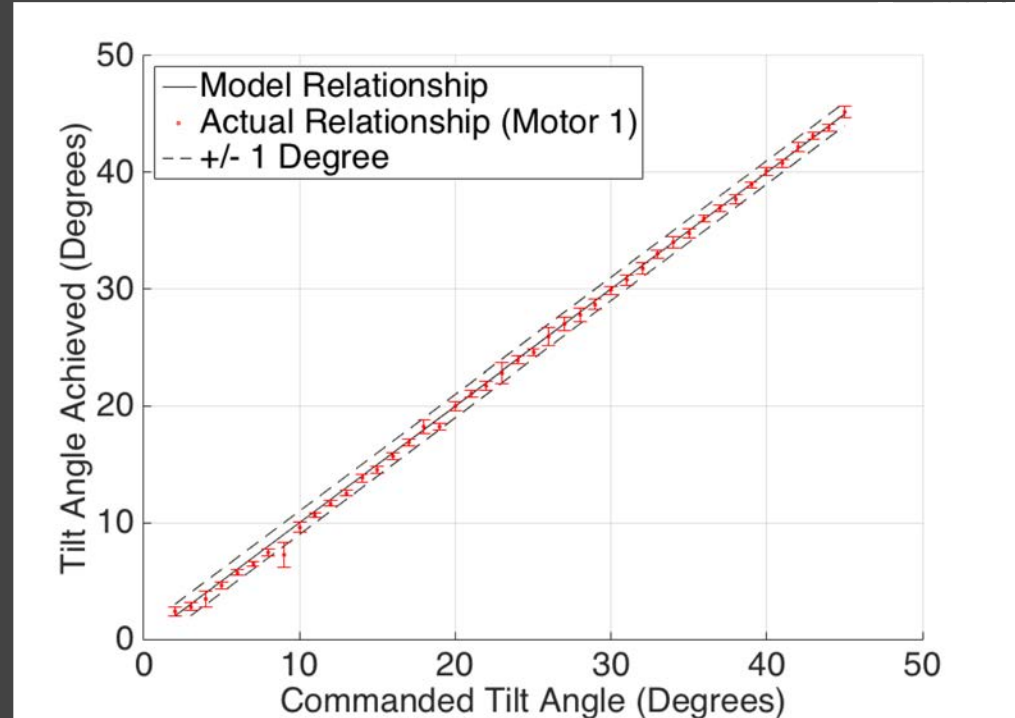
# Closed-Loop Tilting Results



Meets third level of success  
(1° increments w/ 1°  
accuracy )

Closed loop control improved  
tilting precision and helped  
deal with missed steps issue  
Only have data for one lift  
due to a motor failure

Requirement 4.121 Verified: The actuators shall be able to tilt the CubeSat in 1 degree increments with an accuracy of +/- 0.5 degrees



# Tilting Test Conclusions



Requirement	Level 1 Success	Level 2 Success	Level 3 Success
Tilting Accuracy	Tilt CubeSat model up to 45 degrees on a flat surface	Open loop autonomous tilt with 5° accuracy	Closed loop tilt with 1° accuracy

System can meet tilting requirements

Can't verify it can meet mass tilting requirement

Should have taken more care in manufacturing

Or potentially left time to re-manufacture parts

Attempt to find a better way to represent a microgravity environment

Rope/pulley with lower friction

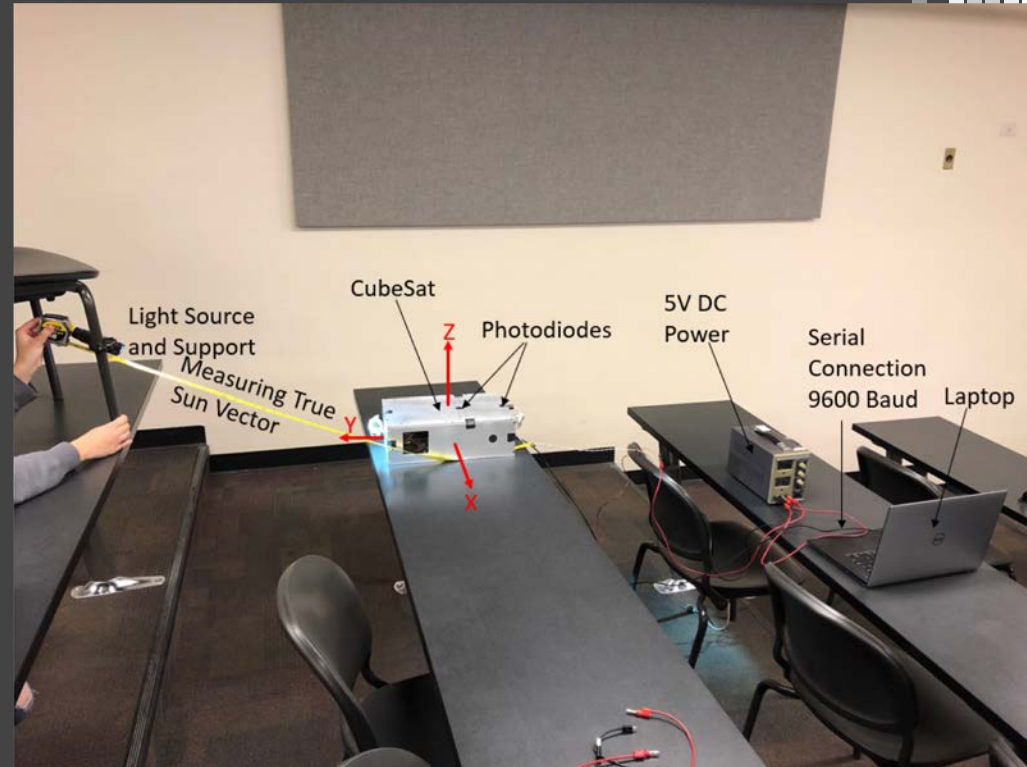
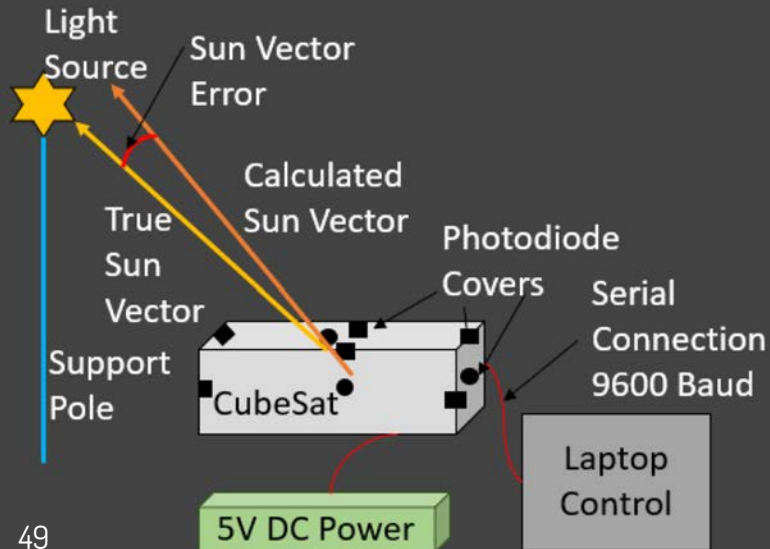
Different testing method

Potentially change where torque is being applied in the scissor lift



# Sun Sensing Characterization Test Setup

True sun vector measured in X,Y,Z CubeSat Body Axes  
Compared to computed sun vector



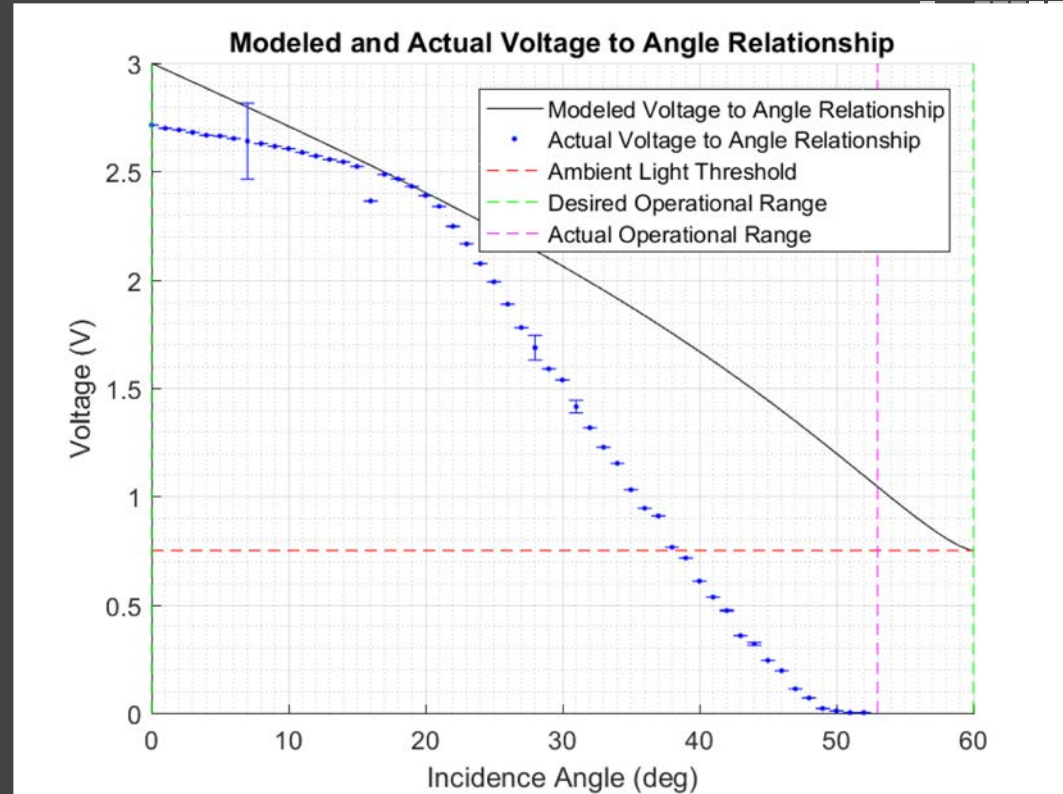
# Angle to Voltage Relationship Errors



Photodiode roll-off was greater than expected based on data sheet, using up margin for ambient light

Modeled vs actual slope  
Data sheet values used in models

3D printed covers required modifications to reach 60° FOV  
Cover calibration data (with error bars)



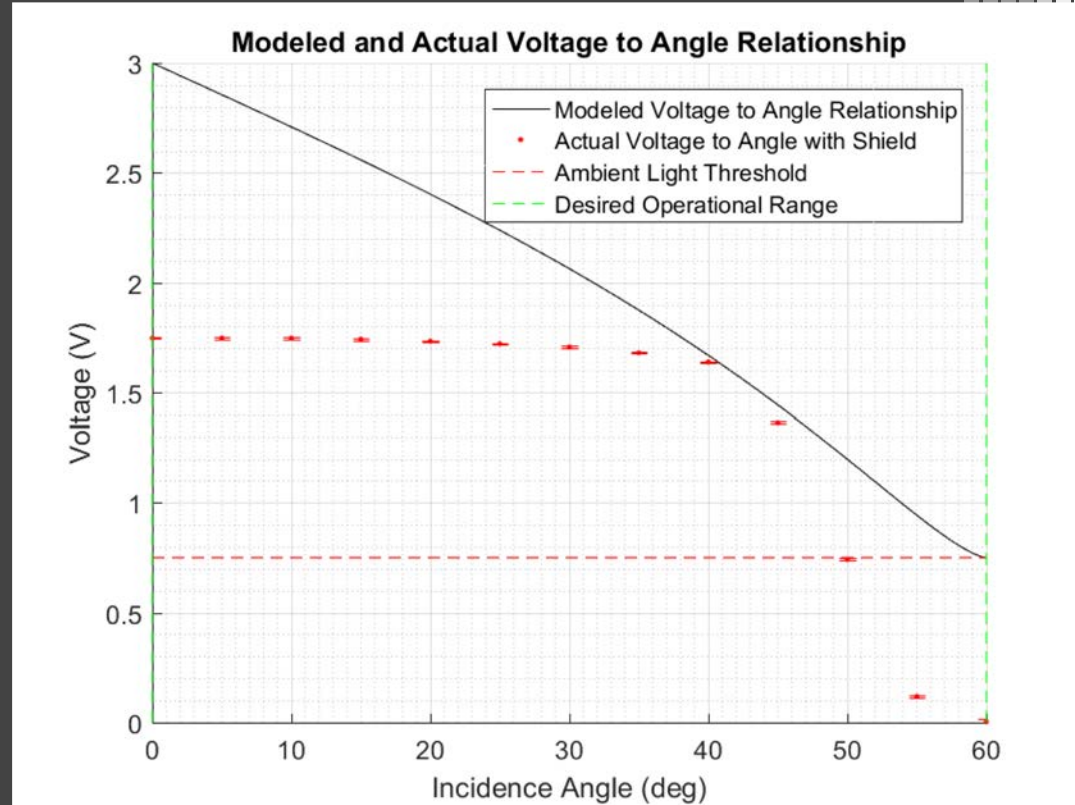
# Angle to Voltage Relationship Errors



Diode in MCU pin protection circuit clipped voltages lower than desired

Vector calibration data  
(with error bars)

Low resolution at low incidence angles



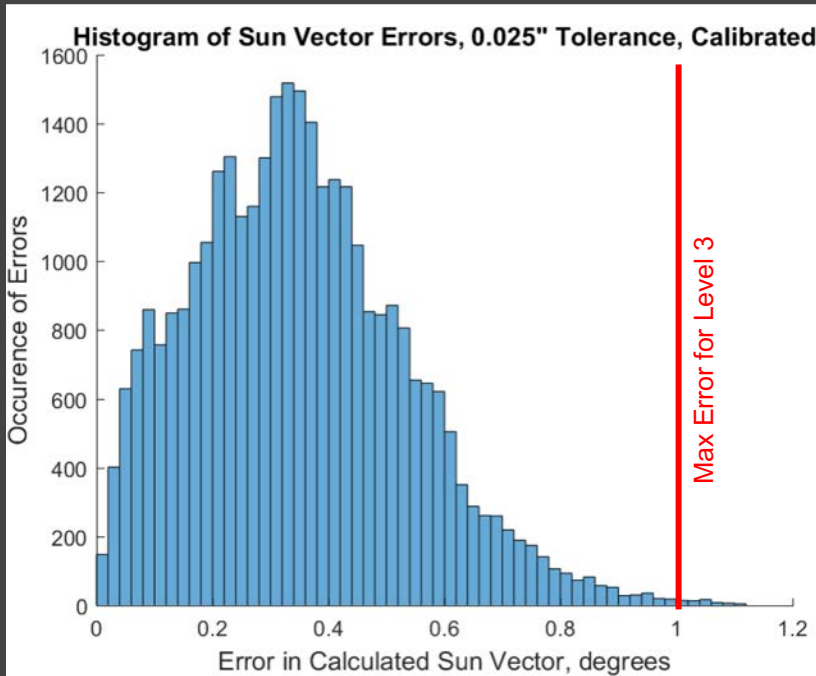


# Sun Sensing Characterization Results

**Purpose:** Verify the sun vector  $1^\circ$  accuracy requirement

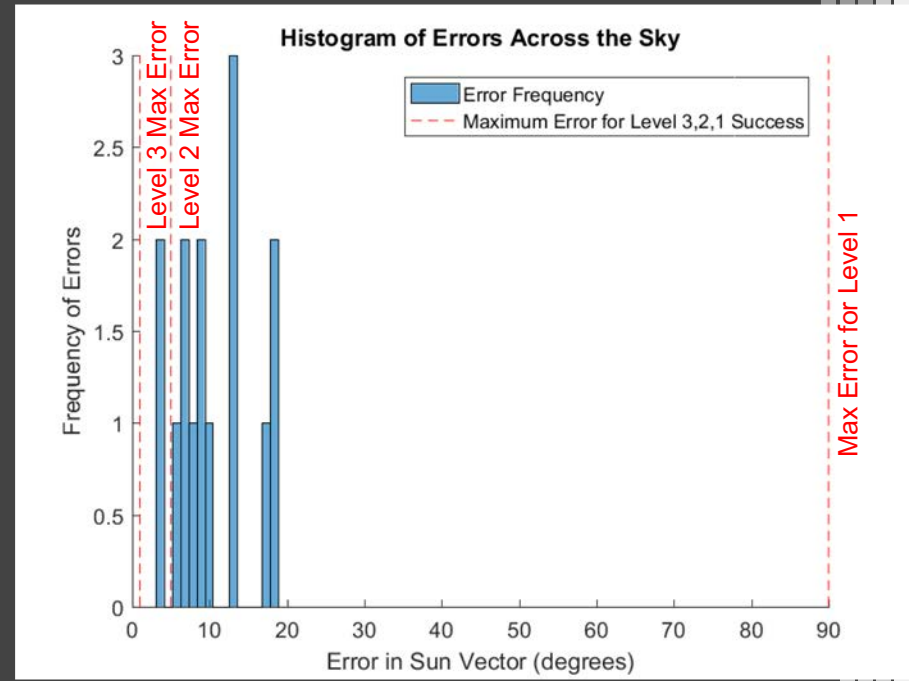
Original Modeled Errors

Designed for level 3 ( $1^\circ$ )



Tested Errors

Achieved level 1 success ( $90^\circ$ )



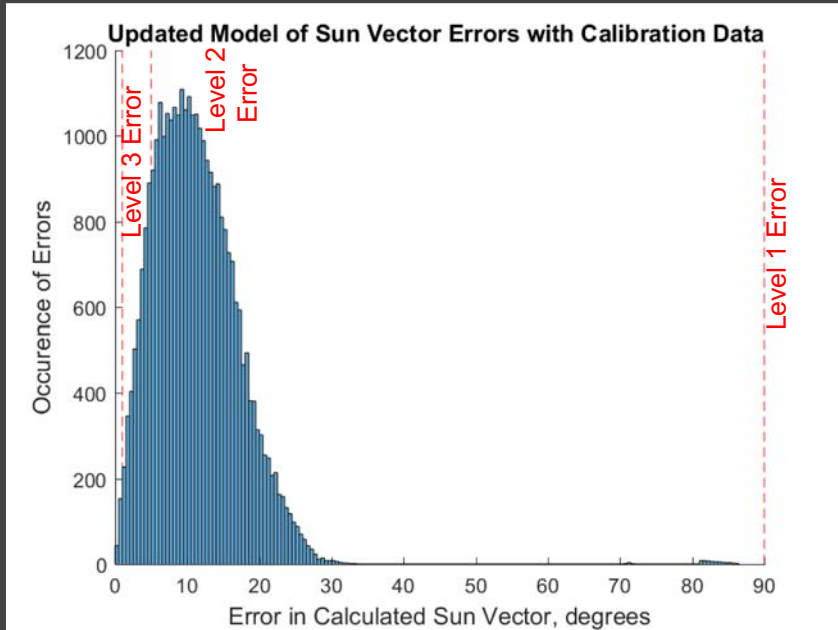
# Sun Sensing Characterization Results

**Purpose:** Verify the sun vector  $1^\circ$  accuracy requirement



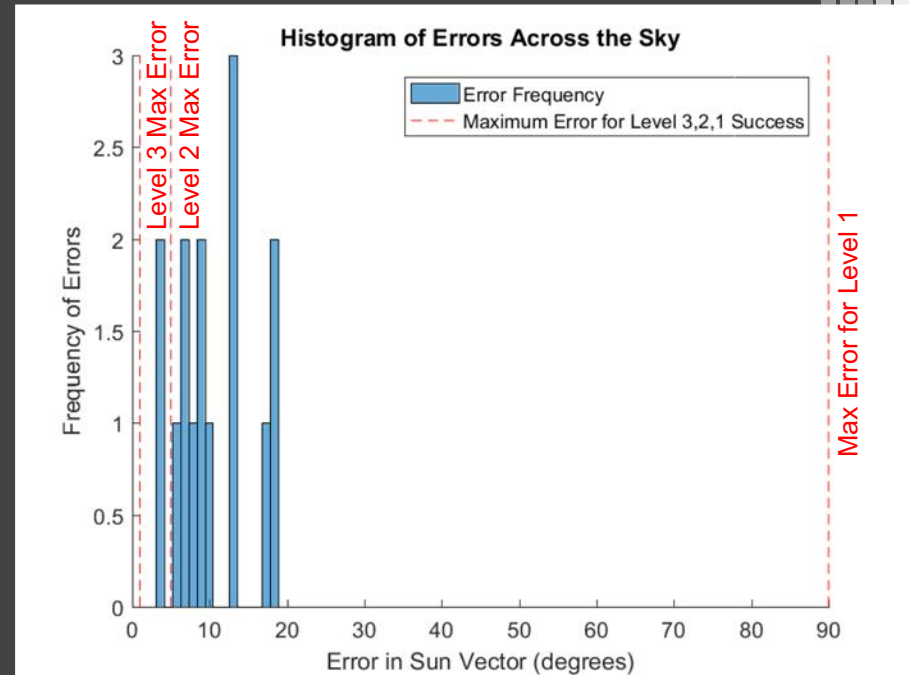
Updated Modeled Errors

Added Calibration Data to Model



Tested Errors

Achieved level 1 success ( $90^\circ$ )

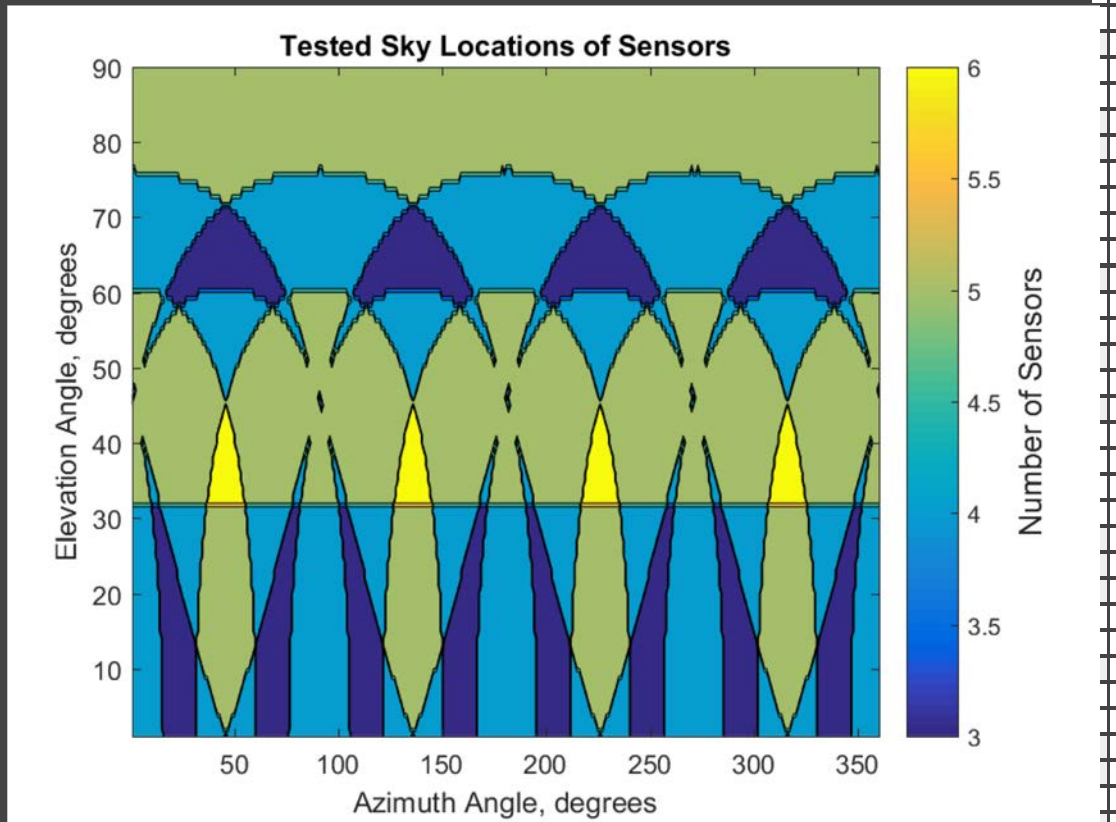




# Full Sky Coverage Model

Designed for at least 3 photodiodes on each part of the sky with significant margin

All locations had at least 3 sensors





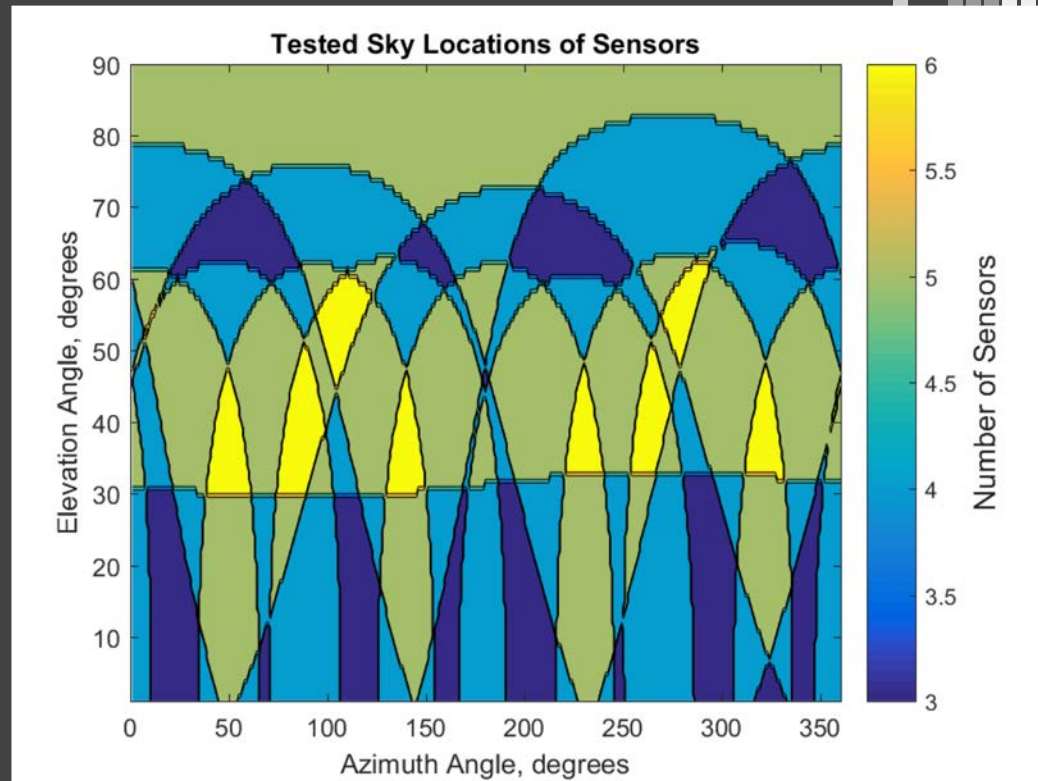
# Full Sky Coverage Requirement Verification

Component test calibration results

Known alignment of photodiodes and fields-of-view

Geometry used to derive true sky coverage map

Full Sky Coverage Requirement Verified by Analysis





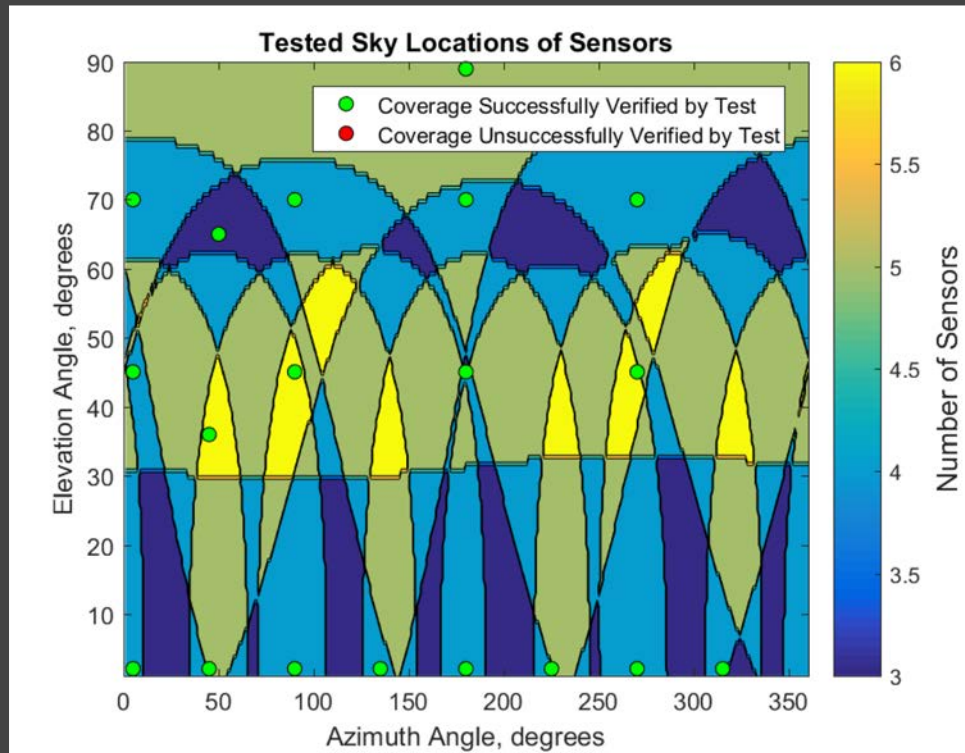
# Full Sky Coverage Requirement Verification

Component test calibration results

Known alignment of photodiodes and Fields-Of-View

Test locations based on unique combinations of sensors in modeled coverage map

Full Sky Coverage Requirement Verified by Analysis and Test





# Sun Sensing Conclusions



Requirement	Level 1 Success	Level 2 Success	Level 3 Success
Sun Vector Accuracy	90°	5°	1°
Full Sky Coverage	Verified	-	-

Small errors in voltage to angle conversion propagated to large errors in sun vector

Calibrations were extremely valuable to get system working, but took more effort than expected

Filters effectively reduced noise

Requirements needed more detail for testing environment and how much accuracy customer actually needed



# Systems Engineering

Overview

Design

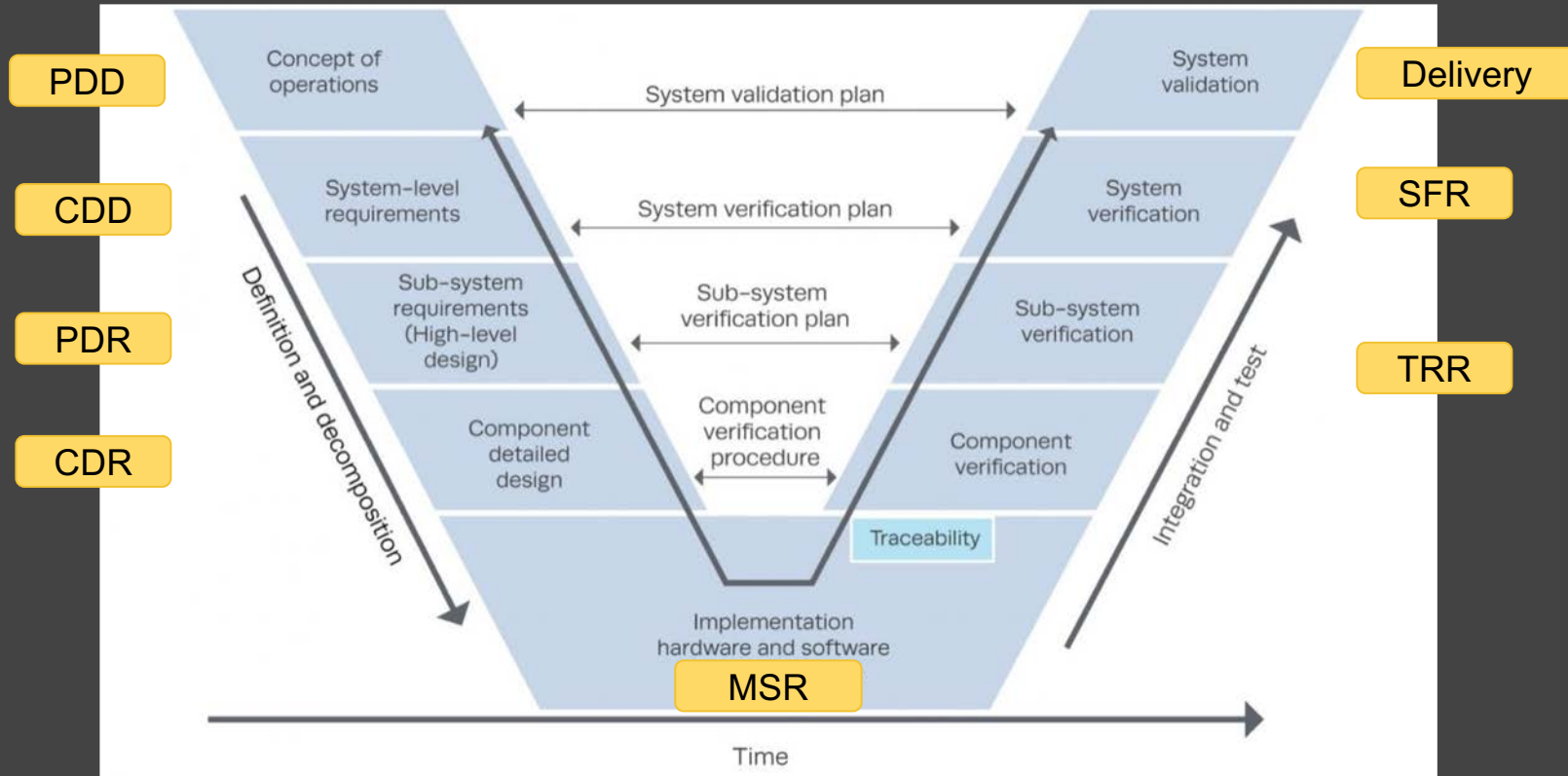
Test  
Overview

Test  
Results

Systems  
Engineering

Project  
Management

# Systems Engineering Process

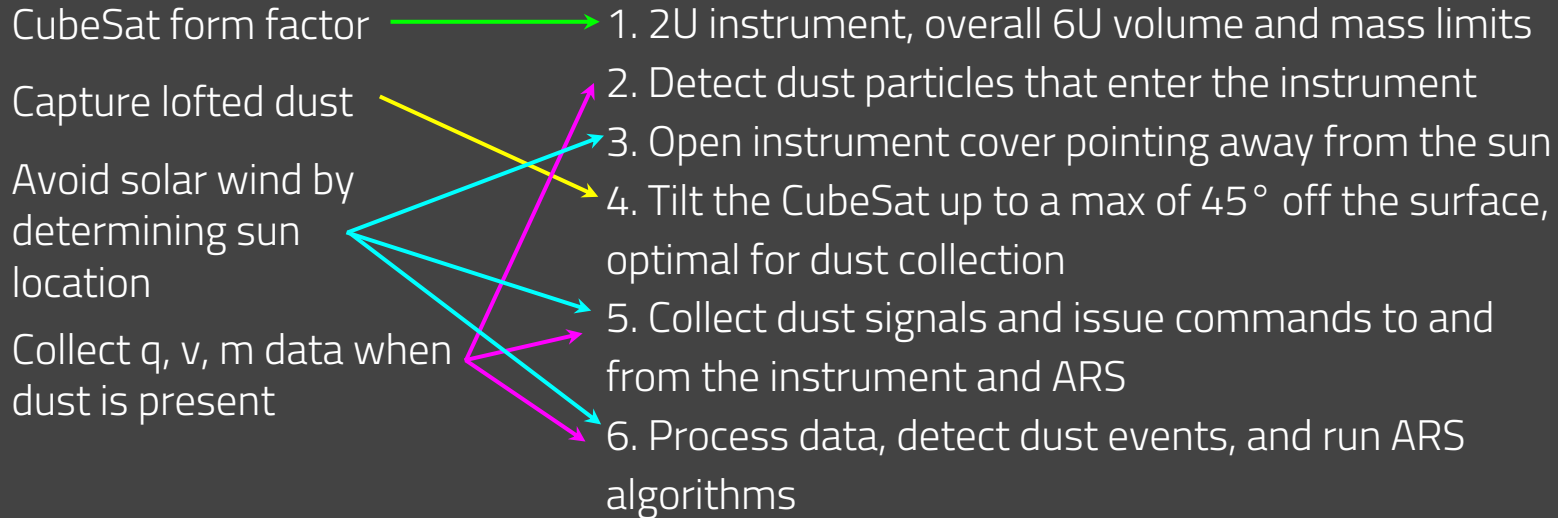




# Requirements Flow Down

## Functional Objectives

## Requirements



Lessons Learned: Utilize more resources to understand the work necessitated by requirements and project scope from the beginning

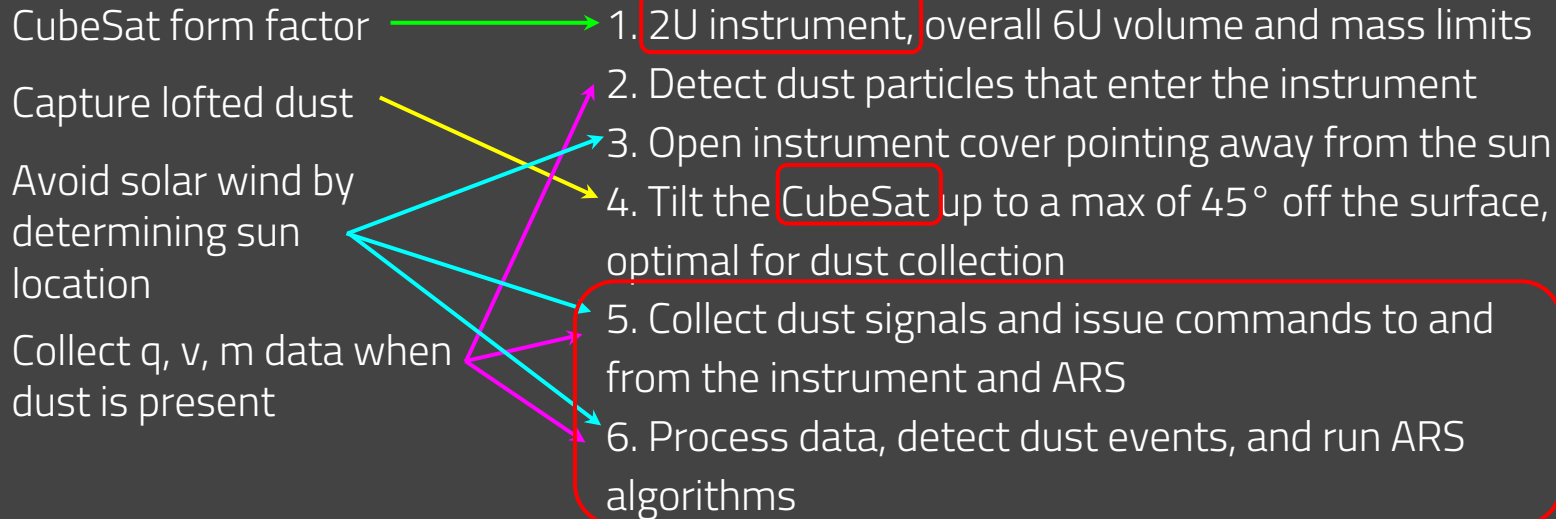




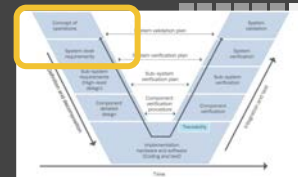
# Requirements Flow Down

## Functional Objectives

## Requirements



Lessons Learned: Utilize more resources to understand the work necessitated by requirements and project scope from the beginning





# Key Trades

Mechanisms

Sun-Sensing

Instrument  
Electronics/Software

Should have given greater weight to:

The difficulty of developing a new system from scratch (instrument and sun sensing)

Looked further into other COTS systems

Stringency of manufacturing tolerances for a design (scissor lift and sun sensing)

Team expertise and experience (all)

Amount of resources the team can dedicate to the sub-system in time allotted (all)

Lessons Learned: Trade studies should heavily consider all factors in the implementation of a design, not just the design itself





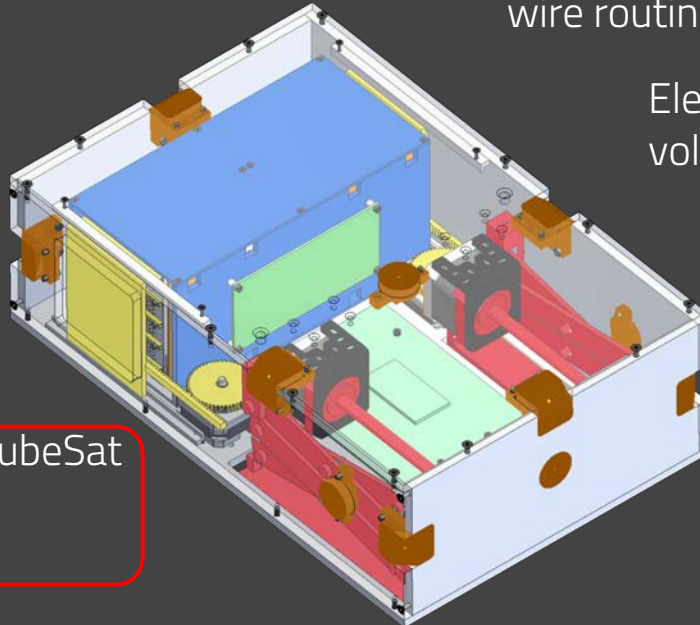
# Interfaces

EMI and ESD precautions, electrical isolation

Software and hardware interaction

Mounting to test apparatus

Precision mounting in CubeSat body for mechanisms and photodiodes



Clearance and ports for connectors and wire routing

Electrical components and voltage/current levels

Clearance and lubrication for door and scissor lift

Combining tilting, sun sensing, and accelerometer software

Lessons Learned: Interface management saved time during integration, difficulties with datasheets, software, and mounting in real life vs CAD



# Risks in Retrospect



		Severity				
		1	2	3	4	5
Likelihood	5			INST-2, INT-5		
	4		ARS-6			
	3		ELEC-1	STRUCT-2		
	2				MECH-1, ARS-1	ELEC-4
	1					

## Legend

	Low (1-3)		Moderate (4-9)		High (10-15)		Extreme (16-25)
--	-----------	--	----------------	--	--------------	--	-----------------





# Updated Risks



Risk	Description	Status	Total
INT-4	Limited instrument testing pre-vacuum	Tested DTS w/out vacuum first	4
INST-2	Don't have past test data	Still true, but now have our own	5
ELEC-1	Need to remake PCB	No remakes for instrument	4
MECH-1	Mechanism mounting errors	Misalignment in scissor lift	12
ARS-1	Photodiode noise	Mitigated with filters	2
ARS-6	Inconsistencies in photodiode apertures	Calibrated and adjusted	8
ELEC-4	Noise from connections and EMI	Mitigated with circuit design	5
STRUCT-2	Wire electrode does not survive impact	Survived up to 4.7 m/s	3



# System Integration and Testing Risks



## Additional or Updated Risks:

- Learning curve for instrument software and Ada (updated)

  - LASP engineer helped mitigate software risk but had limited experience in hardware/software integration

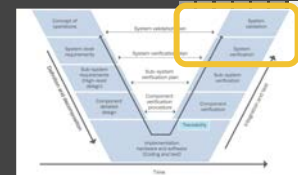
- Hardware inconsistent with datasheets (new)

  - Did not catch differences in photodiodes and door motors until integrated/tested

- Test setup impacts results (new)

  - Limited ability to simulate microgravity

Lessons Learned: Anticipated risks were effectively mitigated; challenges arose from unforeseen or underestimated risks





# Project Management

Overview

Design

Test  
Overview

Test  
Results

Systems  
Engineering

Project  
Management

# Management Approach



1st Semester	2nd Semester
Rigid and structured schedule	Dynamic and flexible schedule
Every team member worked on documentation	Split technical and documentation work (MSR, TRR, AIAA)
2 hour full team meetings	Brief status updates
Individual focused work	Group focused work (warm body approach)

## Project Resources

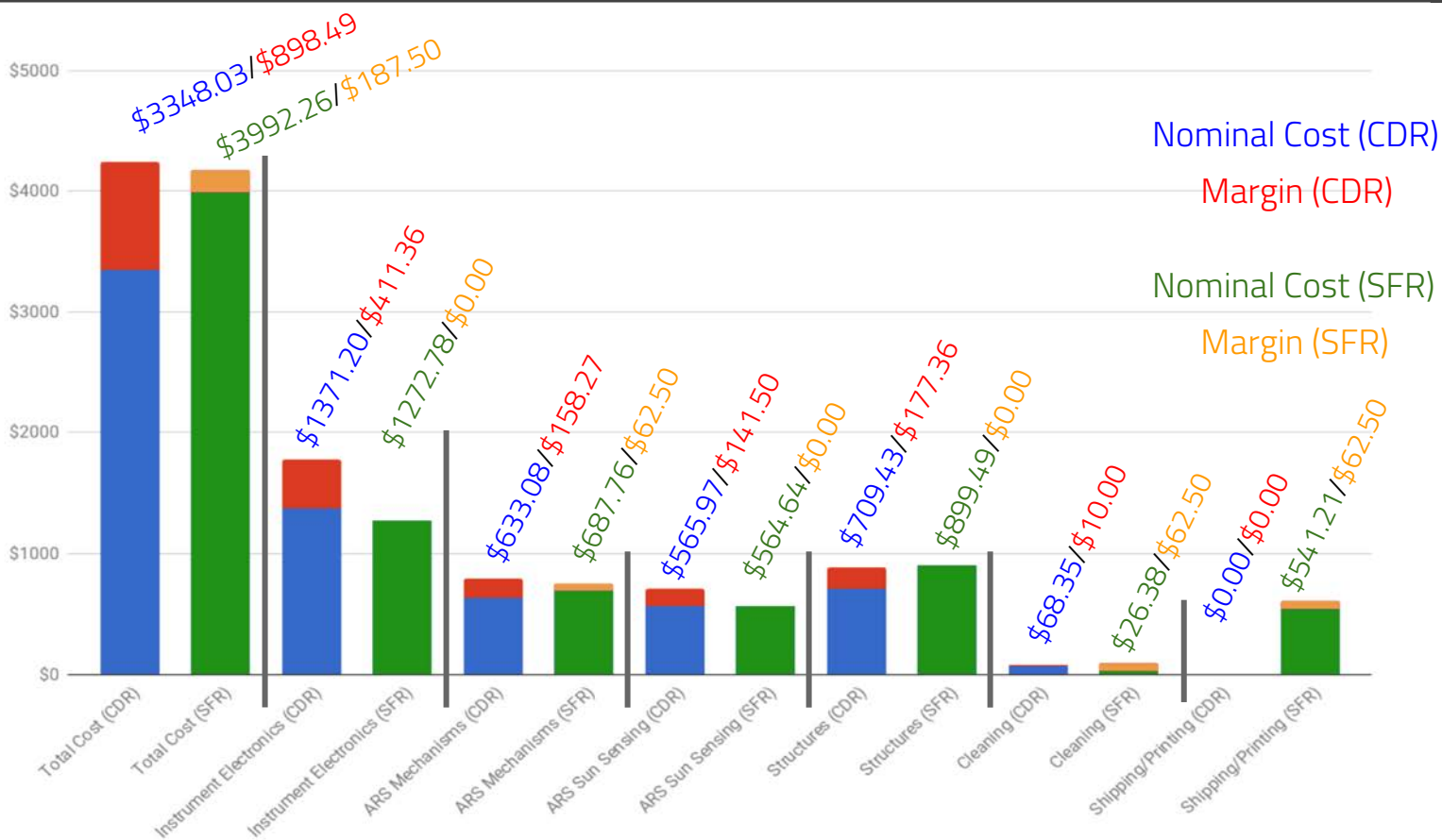
Slack (Communication), Team Gantt (Scheduling), Google Drive (Documentation)

# PM Lessons Learned

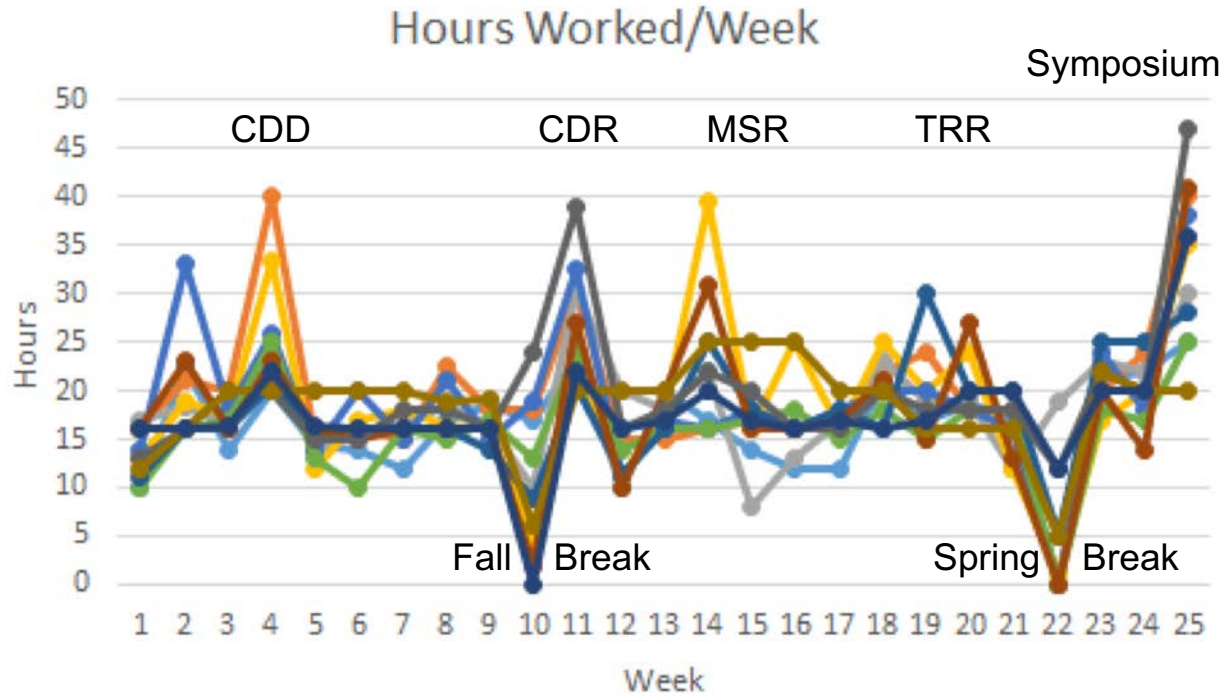


Successes	Challenges
Gantt Charts (1st semester)	Gantt Charts (2nd semester)
Increased customer communication	Didn't understand complexity of certain components
Individual leadership	Misallocation of resources
Brief meetings	Overextended team

# CDR Cost Plan vs. Final Budget



# Time is \$\$\$



Hours	5004
Rate	\$31.25/hr
Labor	\$156,375
Overhead	\$312,750
Materials	\$3,993
Total	\$473,117

# Acknowledgements



PAB - Specific technical advice

Dr. Clark - Advising with a broken arm

Dr. Wang & Dr. Sternovsky - Design, review, and testing

Kevin Dinkel - LASP framework

Joseph Samaniego-Evans - Instrument testing

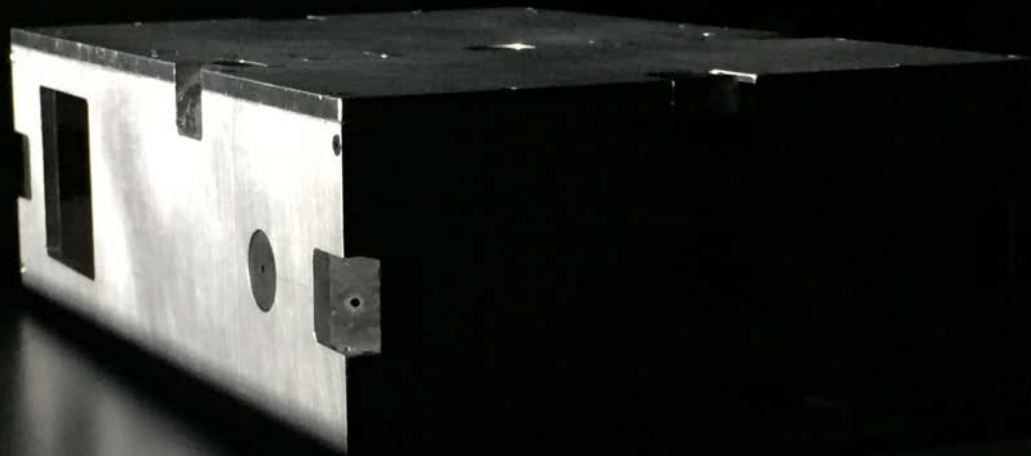
Adrian Stang - Machining

Stu Tozer, BioServe - Cleaning

Dan Godrick - Accelerometer

Andrew Dahir - QB50 turn table and cleaning





Thank you!

Feedback?

# Slide Directory



Title	Inst Test results	Systems Engineering	Backup Slides
<p> <a href="#">Project Motivation</a>  <a href="#">Project Statement</a>  <a href="#">Overall Mission ConOps</a>  <a href="#">Levels of Success</a> </p> <p> <a href="#">Design Solution</a>  <a href="#">CAD Model</a>  <a href="#">ARS FBD</a>  <a href="#">Inst FBD</a>  <a href="#">CubeSat Model</a>  <a href="#">Photodiodes</a>  <a href="#">Door closed</a>  <a href="#">Door open</a>  <a href="#">Scissor Lift</a>  <a href="#">Dust Instrument</a>  <a href="#">Instrument Electronics</a>  <a href="#">CPE Table</a> </p> <p> <a href="#">Test Overview</a>  <a href="#">Inst Test flow</a>  <a href="#">Impact testing</a>  <a href="#">Lab test</a>  <a href="#">Modified test</a>  <a href="#">ARS test flow</a>  <a href="#">ARS tilt test</a>  <a href="#">ARS Sun test</a> </p>	<p> <a href="#">DTS drop test</a>  <a href="#">Drop test results</a>  <a href="#">CSA verification</a>  <a href="#">CSA Results</a>  <a href="#">DTS Unit test</a>  <a href="#">DTS Charge test results</a>  <a href="#">DTS velocity Test results</a>  <a href="#">Embedded system status</a>  <a href="#">Embedded system design rational</a>  <a href="#">Software system diagram</a>  <a href="#">Inst remaining work</a>  <a href="#">Inst conclusion</a> </p> <p> <a href="#">ARS Test Results</a>  <a href="#">Mass and volume</a>  <a href="#">Tilt test setup</a>  <a href="#">Tilt mode</a>  <a href="#">Tilt model open</a>  <a href="#">Tilt problems</a>  <a href="#">Tilt problems</a>  <a href="#">Closed loop results</a>  <a href="#">Tilt test conclusion</a>  <a href="#">Sun sensing test setup</a>  <a href="#">Angle to voltage</a>  <a href="#">Angle to voltage</a>  <a href="#">Sun sensing characterization</a>  <a href="#">Sun sensing characterization</a>  <a href="#">Full sky model</a>  <a href="#">Full sky verification</a>  <a href="#">Full sky verification</a>  <a href="#">Sun sensing conclusions</a> </p>	<p> <a href="#">Systems engineering process</a>  <a href="#">Requirements</a>  <a href="#">Requirements</a>  <a href="#">Key trades</a>  <a href="#">Interfaces</a>  <a href="#">Risks</a>  <a href="#">Updated Risks</a>  <a href="#">Integration and test risks</a> </p> <p> <a href="#">Project Management</a>  <a href="#">Approach</a>  <a href="#">Lessons learned</a>  <a href="#">Cost plan</a>  <a href="#">Time</a>  <a href="#">Acknowledgements</a>  <a href="#">Thank you</a> </p>	<p> <a href="#">Analog electronics</a>  <a href="#">Impact testing</a>  <a href="#">DTS stand alone</a>  <a href="#">MCU/Trigger</a>  <a href="#">Electron shield</a>  <a href="#">Full inst test</a>  <a href="#">Qvm</a>  <a href="#">Electron deflection</a>  <a href="#">Sun sensing</a>  <a href="#">Tilting backup</a>  <a href="#">Impact test model</a>  <a href="#">**DROP TEST FOOTAGE**</a>  <a href="#">Embedded system</a>  <a href="#">Tilt and sun sensing</a>  <a href="#">Sun vector</a> </p>



# Backup Slides



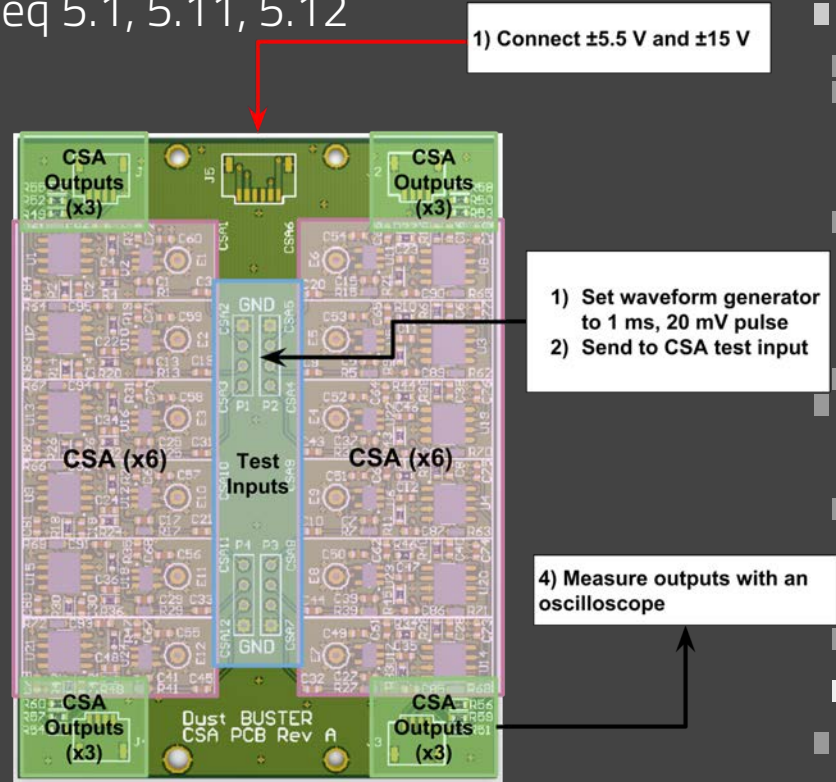
# Analog Electronics: Charge Sensitive Amplifier

Verify our implementation of customer's design for a charge sensitive amplifier, Req 5.1, 5.11, 5.12

**Purpose:** Measure each CSA's amplification of a simulated dust event.

**Facility:** Electronics Lab  
Power supply ( $\pm 5V$  &  $\pm 15V$ )  
Waveform generator  
Oscilloscope & probe  
ESD mat/straps  
Assembled CSA PCB

**Measurement:** voltage of the amplified signal (gain = 100)





# Analog Electronics: Charge Sensitive Amplifier

Verify our implementation of customer's design for a charge sensitive amplifier, Req 5.1, 5.11, 5.12

**Purpose:** Measure each CSA's amplification of a simulated dust event.

Facility: Electronics Lab

Power supply ( $\pm 5V$  &  $\pm 15V$ )

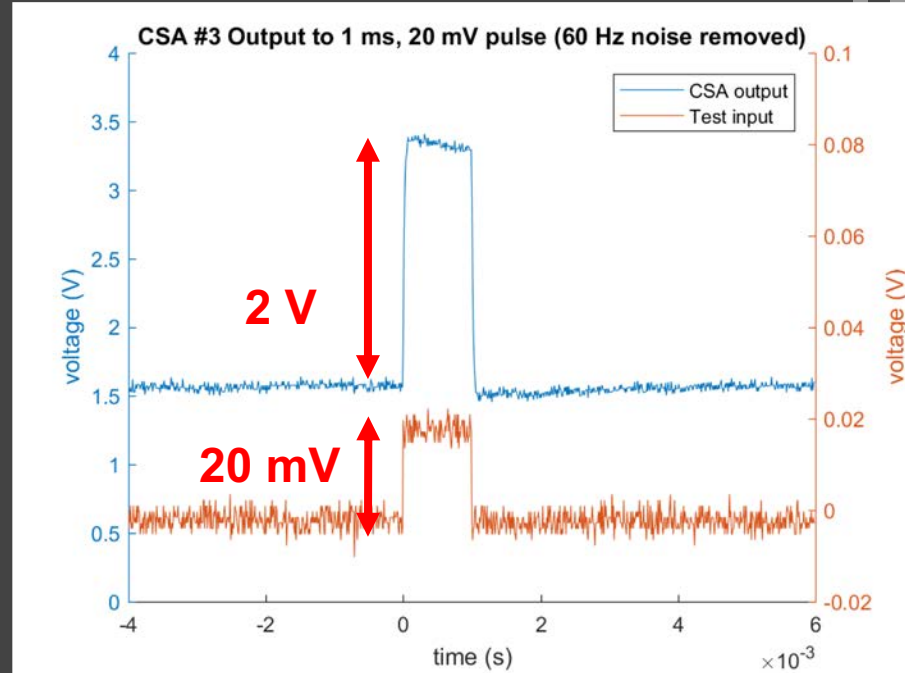
Waveform generator

Oscilloscope & probe

ESD mat/straps

Assembled CSA PCB

Measurement: voltage of the amplified signal (gain = 100)





# Impact Testing

Verify that Wire Electrodes can withstand 10 m/s impact (Req 2.5.1)

**Purpose:** Drop a DTS at successively larger impact velocities to characterize failure (when wire electrode becomes free to move)

**Facility:** Idea Forge

Lansmont 15D Shock Test Machine

One DTS unit

Accelerometer

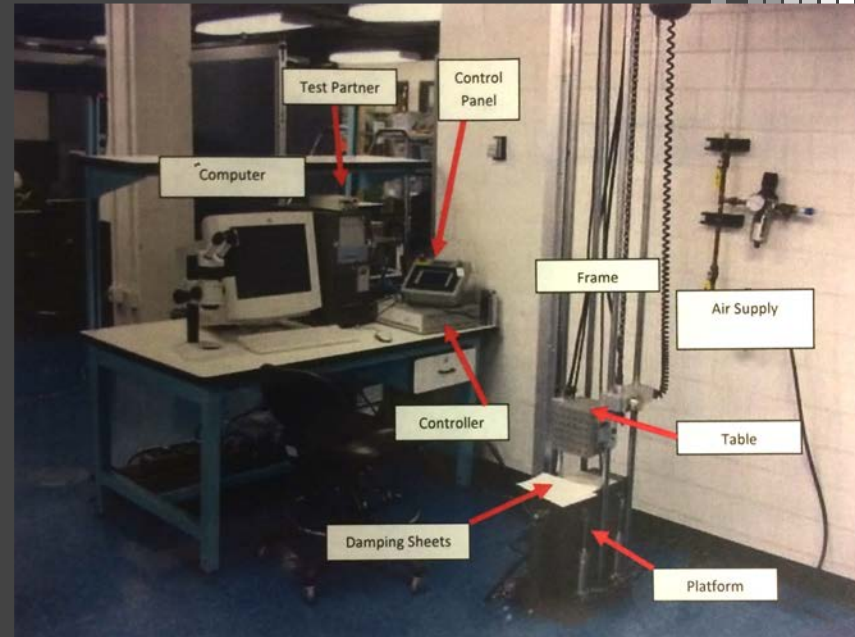
**Procedure:**

Mount DTS to drop test table

Raise table up to desired height and drop

Visually inspect wire electrodes for broken or freely moving wires

Drop again at new height



# Impact Testing



Verify that Wire Electrodes can withstand 10 m/s impact (Req 2.5.1)

## Testing Set-up:

Preliminary drops without DTS to determine drop height vs velocity relationship

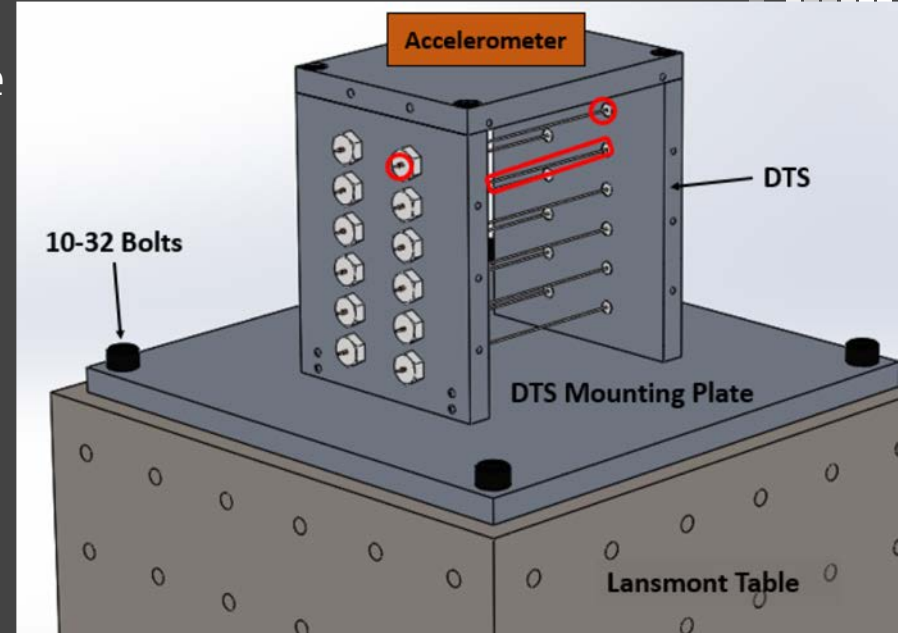
Wire electrodes installed as rigid bar (no slack) with no requirement for tension

Analyzing for failure (wires free to move) at 3 locations after each test

## Limitations:

Only 1 DTS to test

Material deformations are difficult to analyze





# DTS Stand-alone

Verify wire electrode and CSA correctly respond to dust event

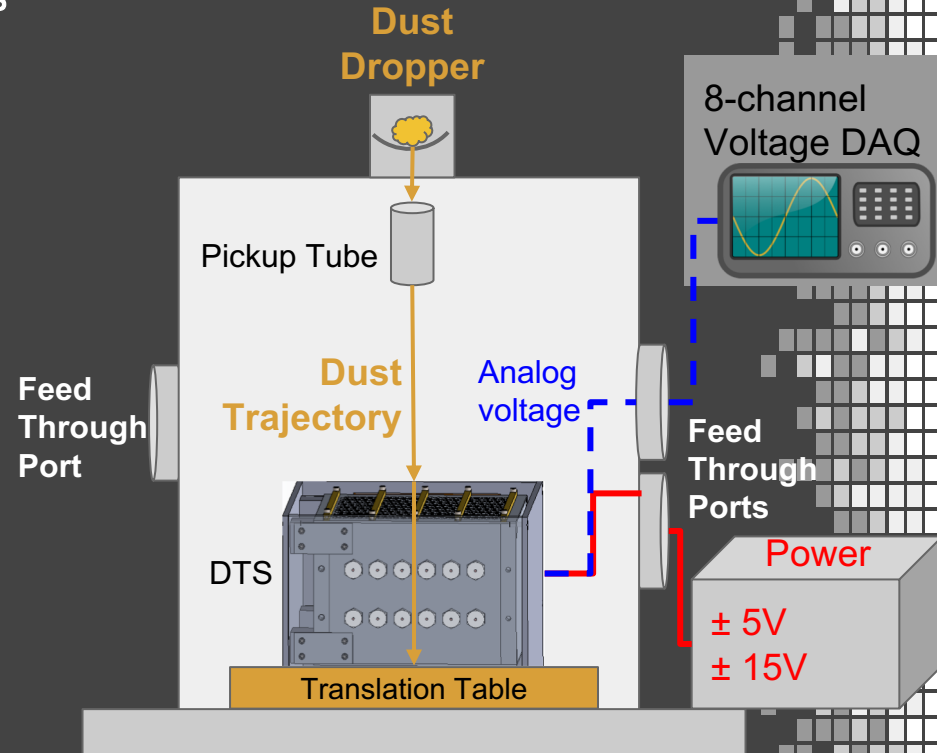
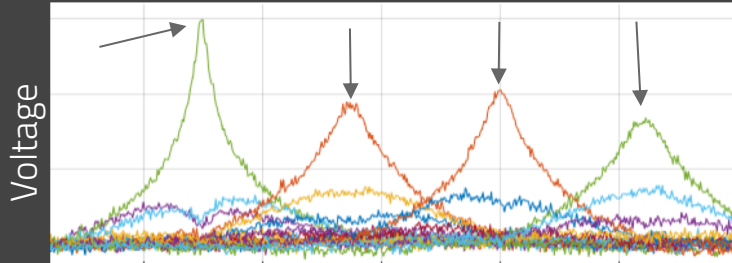
**Purpose:** Confirm the wire electrode connections and CSA conversion from charge to voltage, and signal amplification

**Facility:** IMPACT no vacuum

**Measure:** Live analog voltage output from CSA board (8 wires at a time)

**Success:** Signal roughly matches expected shape and voltage magnitude (~2 V)

Sample Shape:







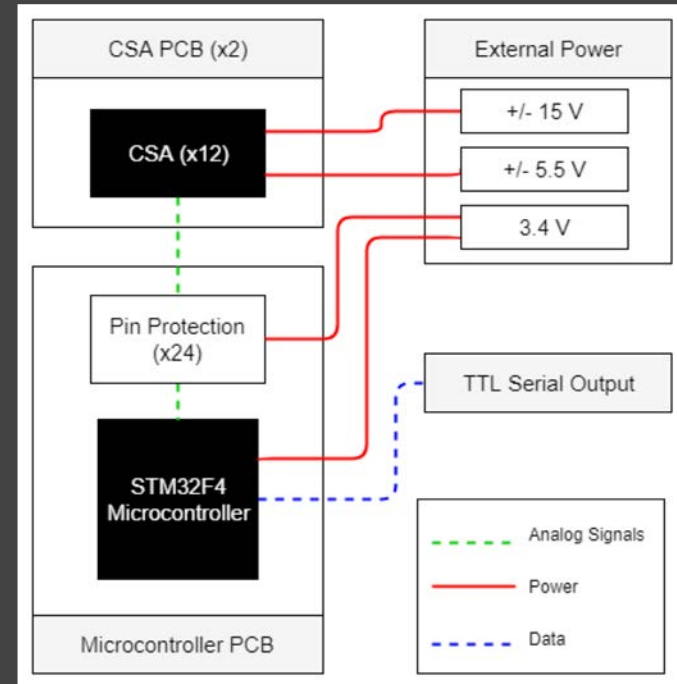
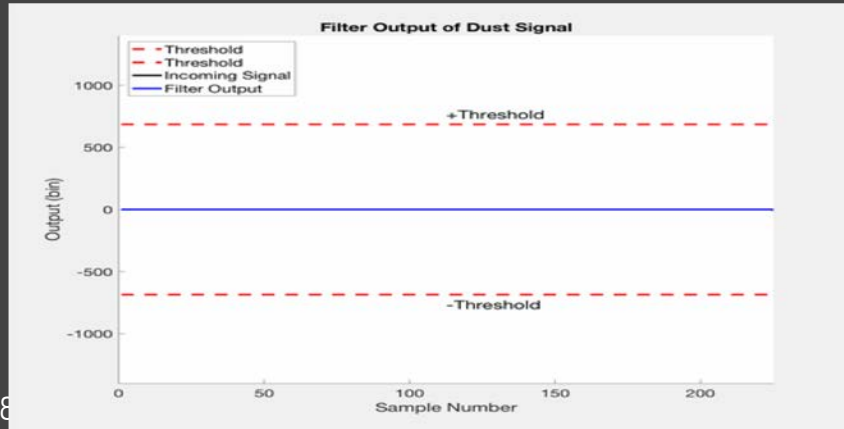
# MCU/Trigger software

Verify trigger threshold and MCU data processing

**Purpose:** Test the ability of the trigger to correctly identify dust events and MCU's ability to process and send data over serial

**Facility:** IMPACT no vacuum

**Output:** CSA digital voltage over serial



# Electron Shield

Verify that electrons are repelled in TRL4 environment

**Purpose:** Verify magnetic shield blocks electrons up to 100 eV of energy which would cause noise on the wire electrodes

**Facility:** IMPACT vacuum (for free electrons)

**Procedure:**

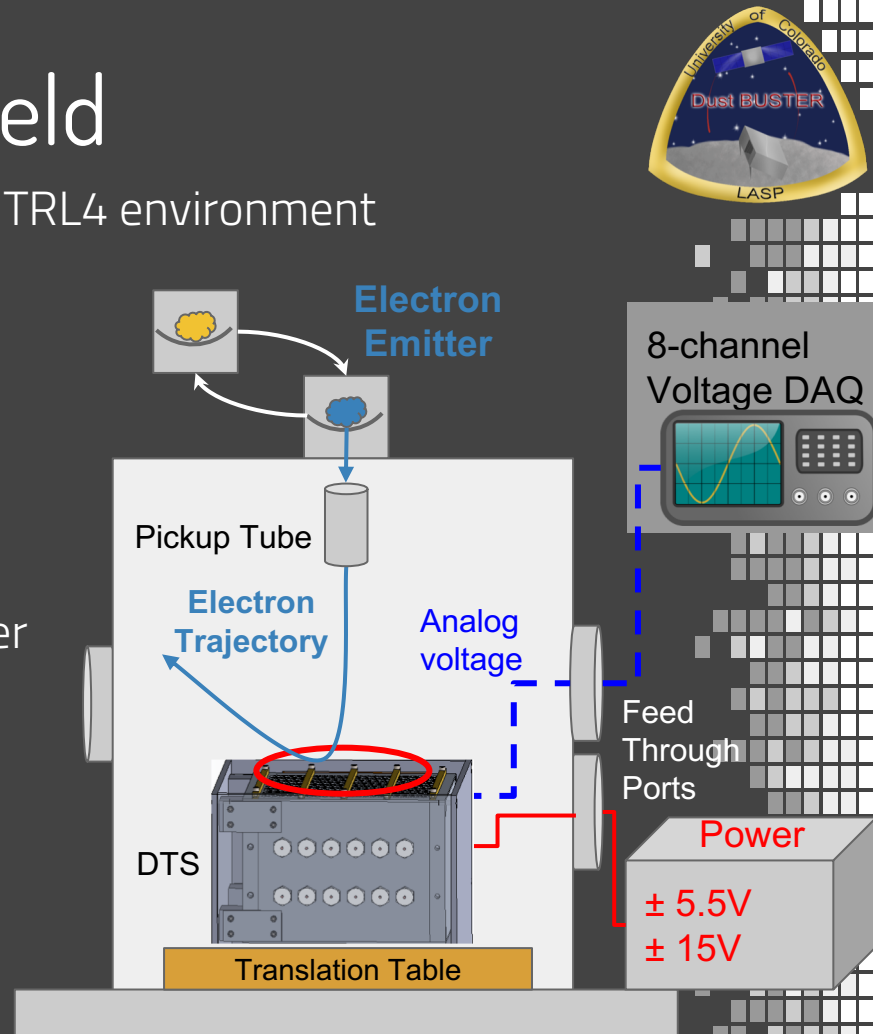
Replace dust dropper with electron emitter

Apply set voltage to emit electrons up to 100 eV of energy

Measure response from CSA over test duration (1 min)

**Measure:** Digital Voltage

**Success:** Null Voltage (random noise)





# Full Instrument Test

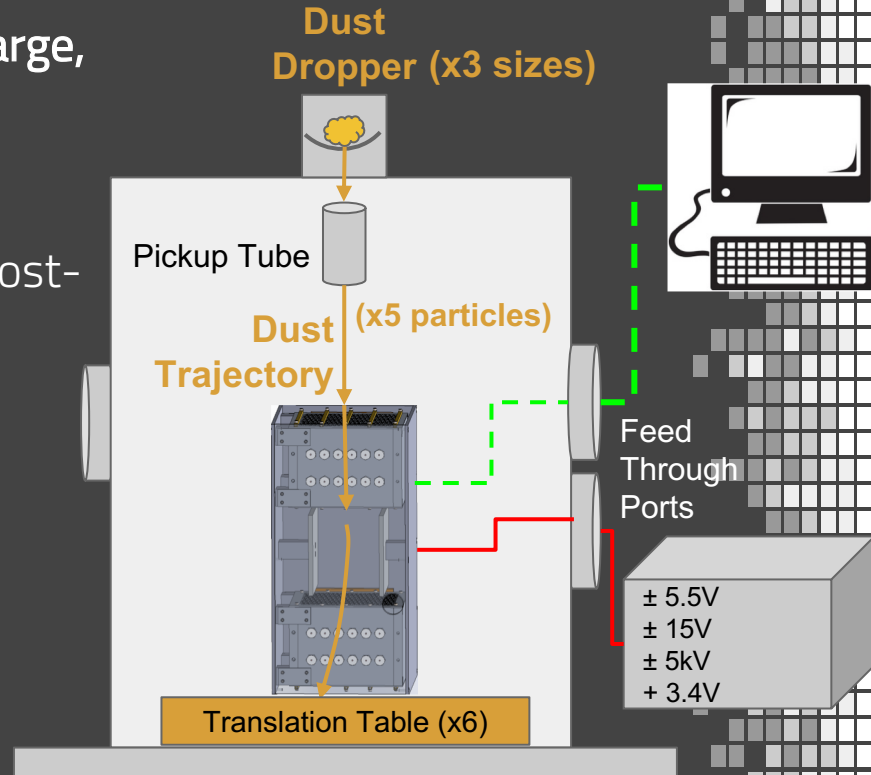
Verify that instrument detects dust particles that enter the instrument. Req 2, 5, 6

**Purpose:** Detect a dust event and extract the charge, mass, and velocity of the particle.

**Facility:** IMPACT vacuum

**Measure:** Output digital voltage in a data file to post-processing software, calculate charge, mass and velocity distribution (~90 dust events total)

Data Type	Expected Range
Charge ( $Q$ )	1 - 160 fC
Mass ( $m$ )	~100 $\mu$ g
Velocity ( $v$ )	1 - 2 m/s



# Methods for $Q$ , $v$ , & $m$ extraction



## Definitions:

$p$  ~ plane number

$n$  ~ wire number in given plane

$i$  ~ wire w/ highest voltage

$j$  ~ wire w/ 2<sup>nd</sup> highest voltage

$t_p$  ~ time particle crosses plane  $p$

$d$  ~ wire spacing

$\Delta x$  ~ plane spacing

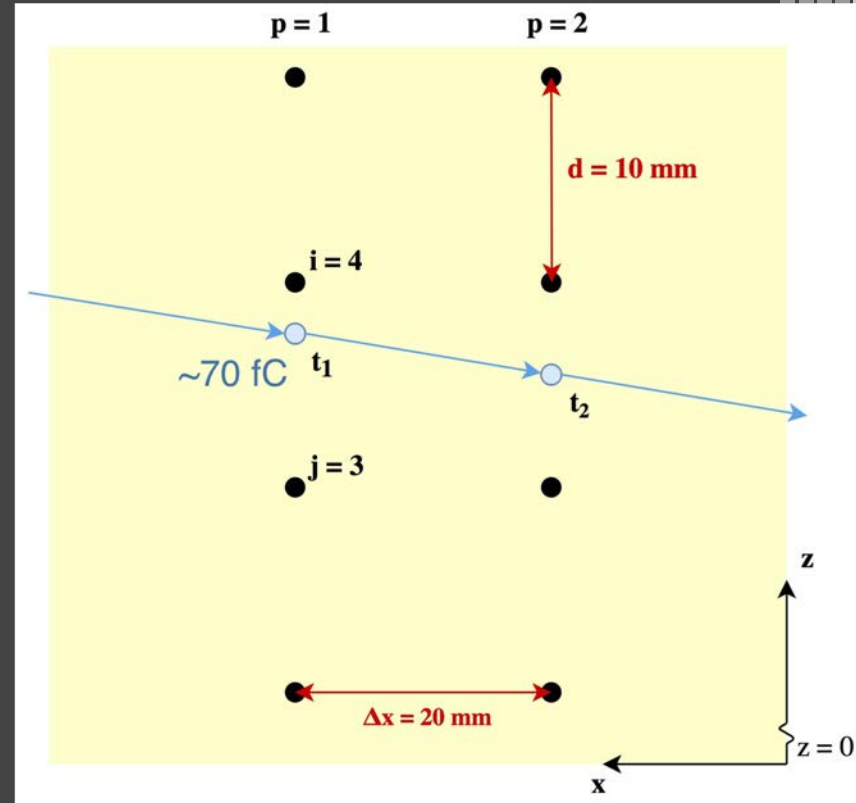
$h_n$  ~  $z$ -coordinate of wire  $n$

$q_n$  ~ charge induced on wire  $n$

$V_n$  ~ voltage signal from wire  $n$

$\rho$  ~ CSA sensitivity

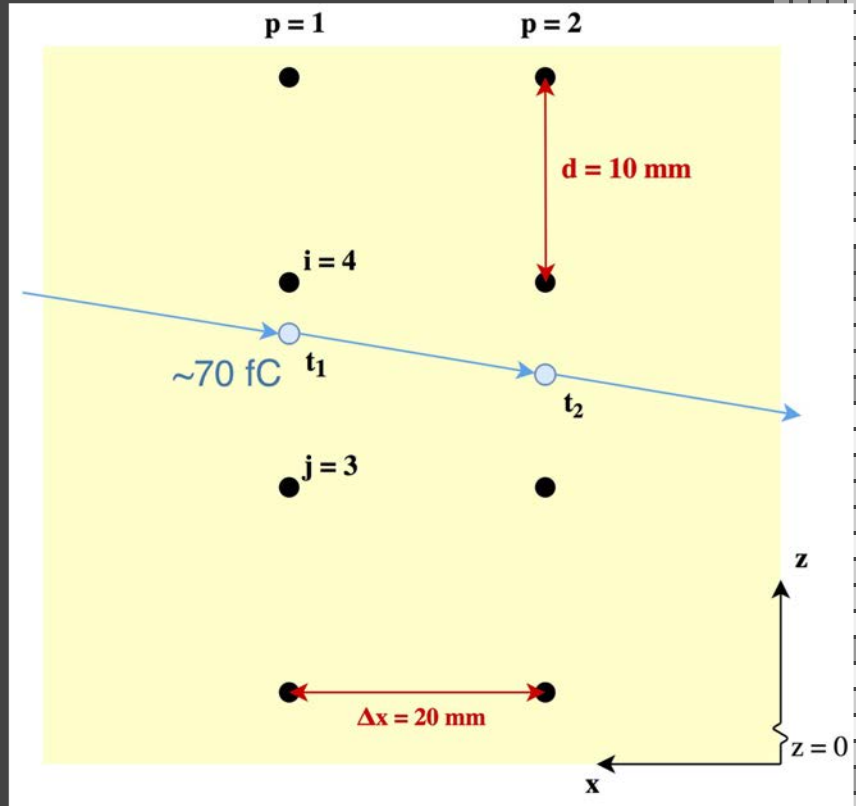
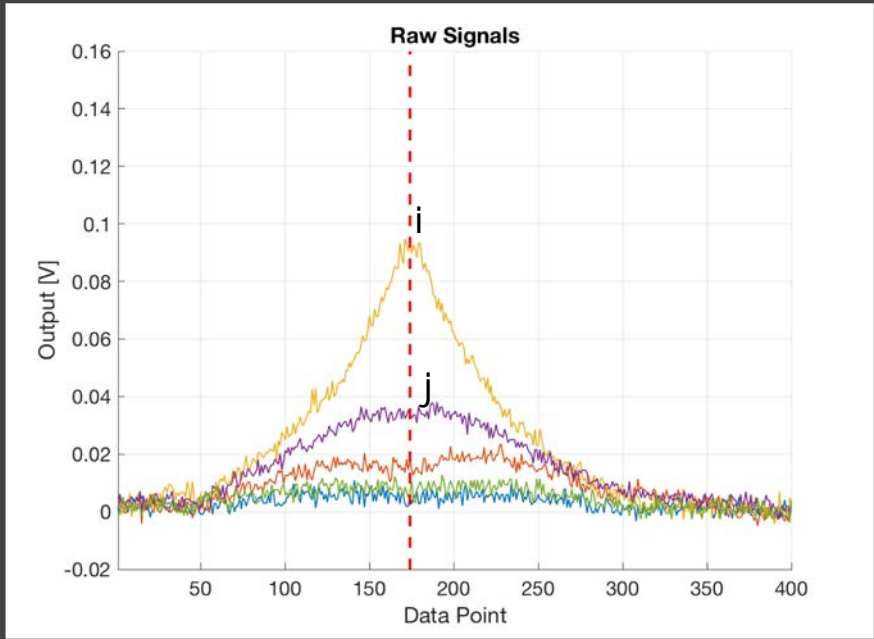
DTS Unit (sub-section)





# Methods for Q, v, & m extraction

## DTS Unit (sub-section)



Charge Sensitive Amplifier (CSA)  
creates voltage from induced charge:  
Sensitivity:  $\rho = 18 \text{ mV/fC}$



# Methods for Q, v, & m extraction

Key assumption: when particle crosses a wire plane the induced charge is only on the wires in that plane

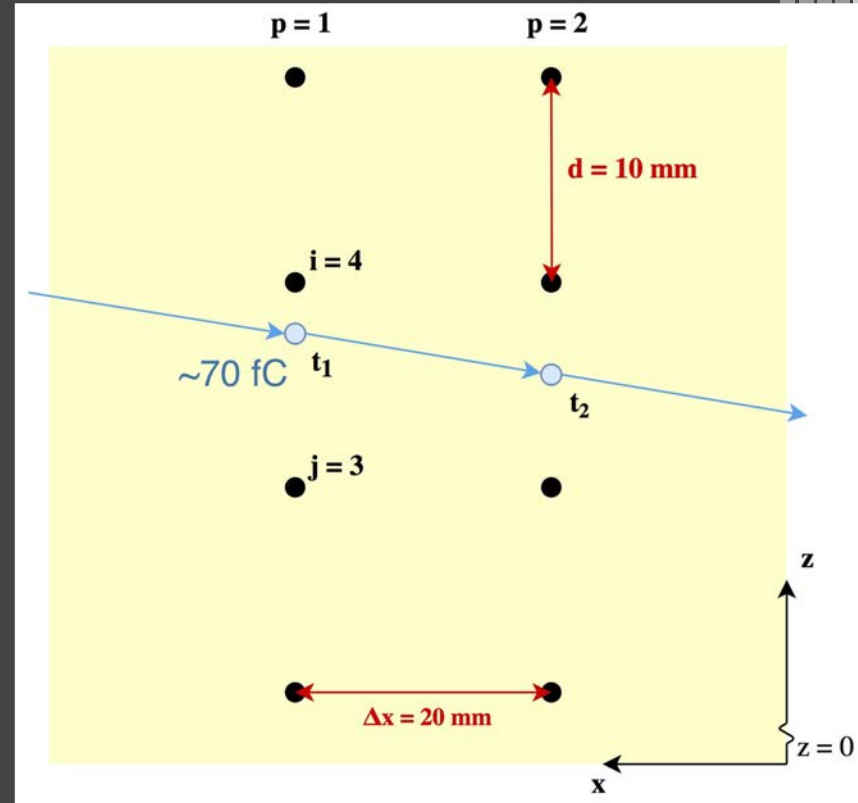
## Steps:

1. Q calculation (@ t = t<sub>1</sub>)

$$Q = \rho \sum_{n=1}^6 V_n$$

n ~ wire number  
(in plane)

DTS Unit (sub-section)





# Methods for Q, v, & m extraction

## Steps (Cont.):

- Distance from closest wire

$$d_i = \frac{d}{1 + V_i/V_j}$$

- Absolute z-coordinate

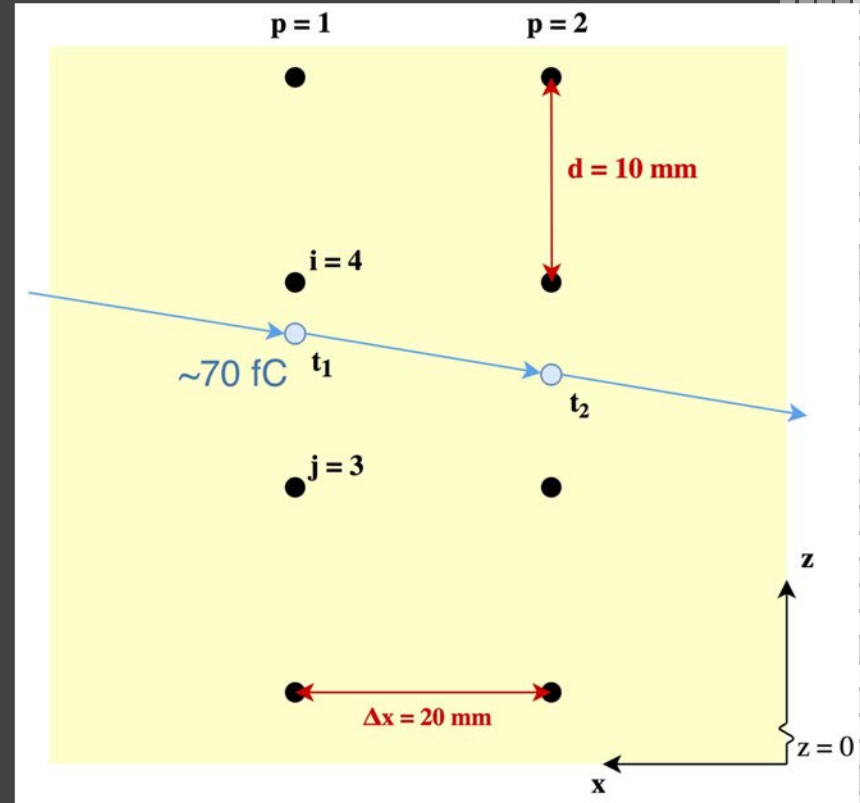
$$\text{If } i > j \rightarrow z_p = h_i - d_i$$

$$\text{If } i < j \rightarrow z_p = h_i + d_i$$

- Repeat steps 2 & 3 for every plane

$$(p = 1 \rightarrow 4)$$

DTS Unit (sub-section)





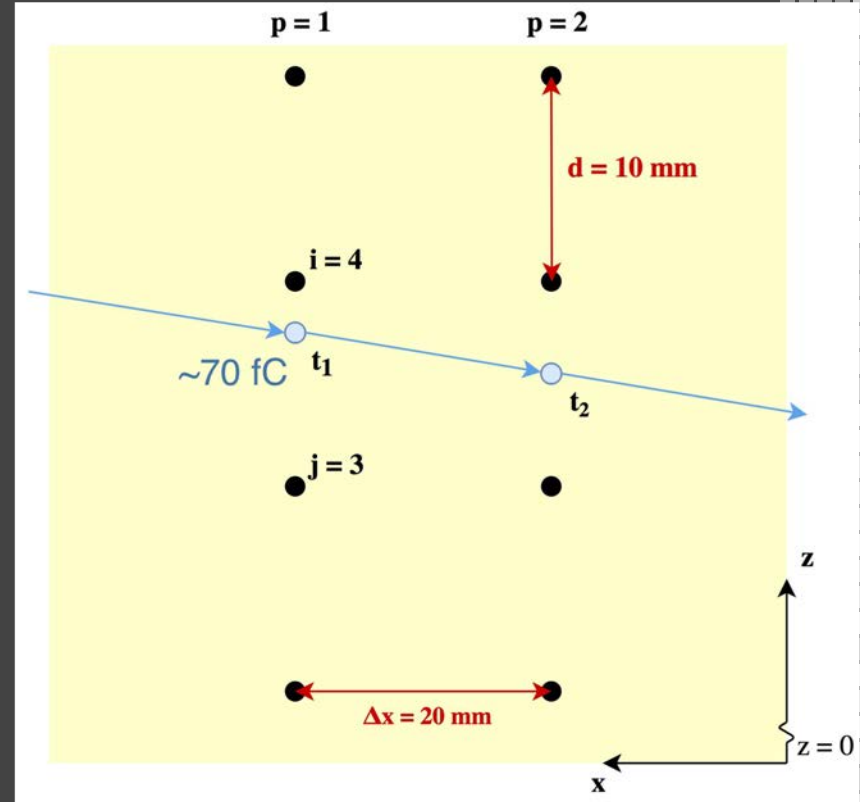
# Methods for Q, v, & m extraction

## Steps (Cont.):

### 5. Velocity calculation

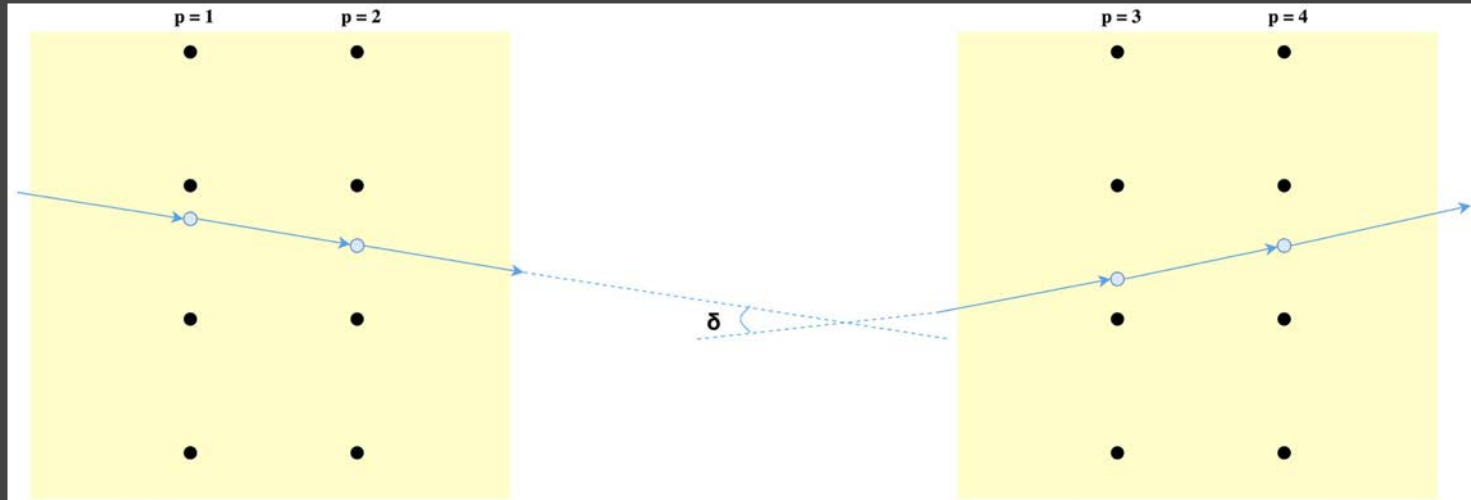
$$v = \frac{\sqrt{(\Delta x)^2 + (z_1 - z_2)^2}}{t_2 - t_1}$$

DTS Unit (sub-section)





# Methods for $Q$ , $v$ , & $m$ extraction

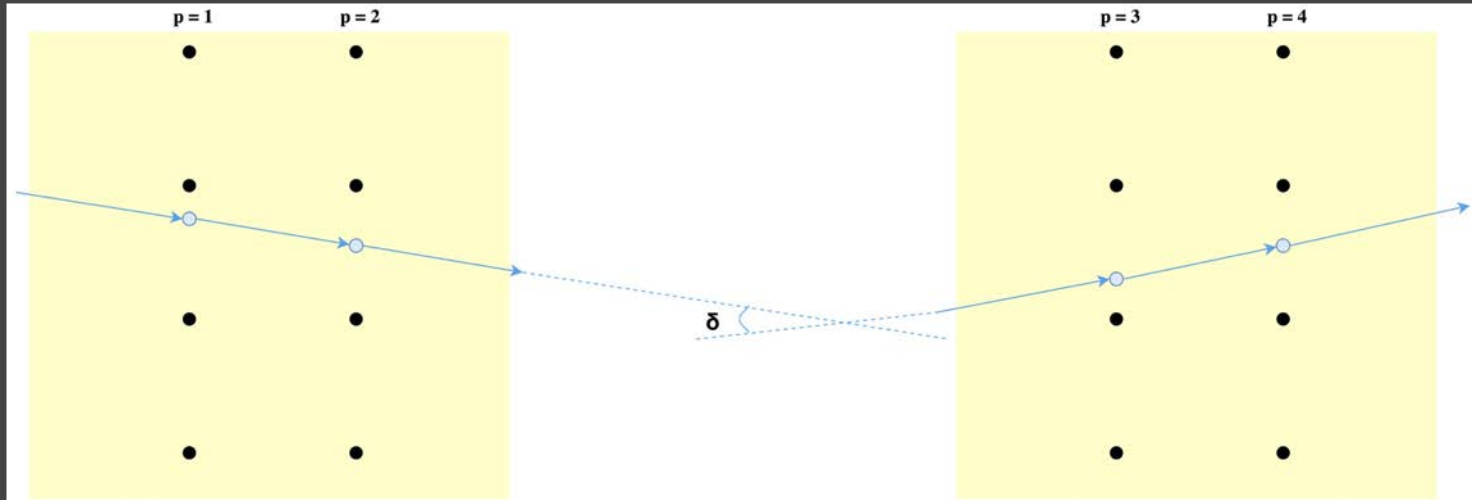


Steps (Cont.):

6. Calculate turning angle  $\delta$

$$\tan(\delta) = \frac{\Delta x(z_1 - z_2 - z_3 - z_4)}{(\Delta x)^2 + (z_4 - z_3)(z_2 - z_1)}$$

# Methods for $Q$ , $v$ , & $m$ extraction



Steps (Cont.):

7. Calculate mass (where  $l = 0.07$  m is the length of the deflection region)

$$m = \frac{QE l}{v^2 \tan(\delta)}$$

# Electron Deflection



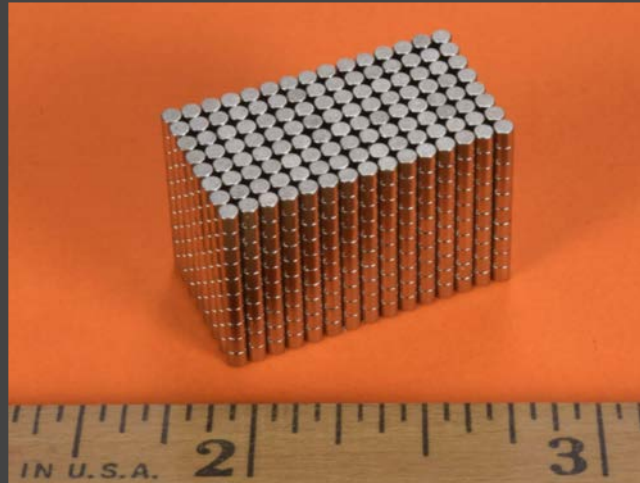
Cylindrical magnets:

$$D = 1.59 \pm 0.10 \text{ mm}$$

$$t = 1.59 \pm 0.10 \text{ mm}$$

Magnetic Remanence:

$$B_r = 1.48 \text{ T}$$

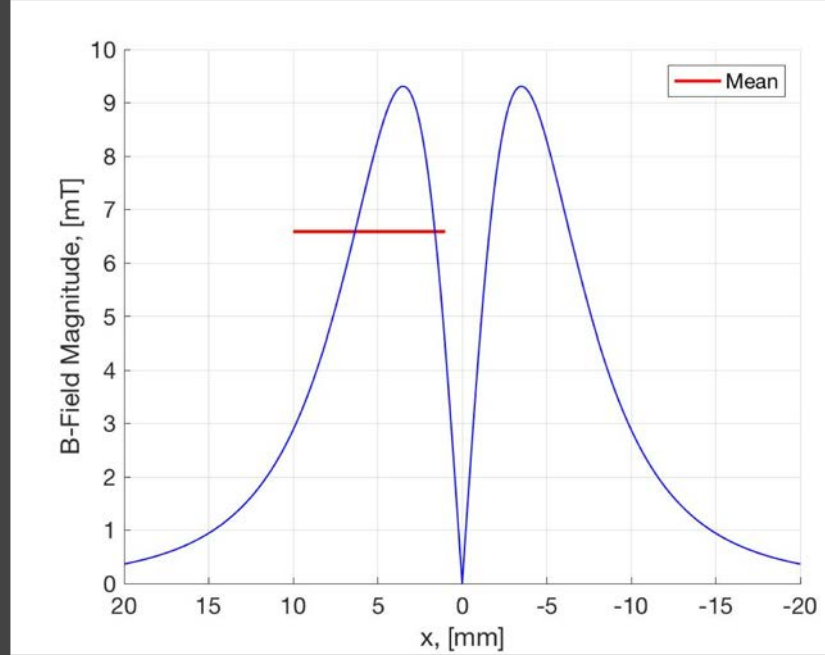
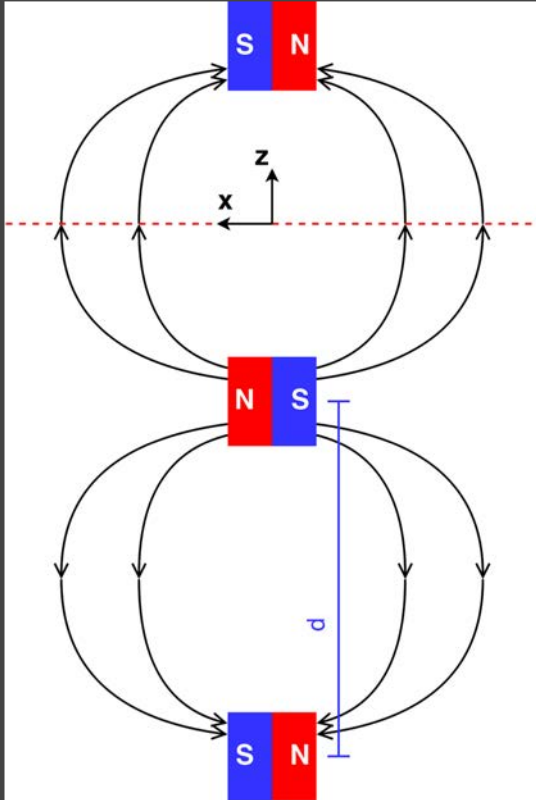


Need to prove gyroradius of 100 eV electron to be sufficiently as to not penetrate the instrument more than 1 cm (first wire plane)

Gyroradius:  $\rightarrow r_q = \frac{mv}{qB}$

# Electron Deflection

Using 5 magnet bars:  $d = 17.5$  mm



From 10 → 1 mm:  $B_{\text{mean}} \approx 5.3$  mT

$r_q \approx 6.3$  mm  
( $e^-$  gyroradius)





# Characterization of Sun-sensing

Verify the system can find the sun to within  $1^\circ$  over the full sky.

Requirements 3.21 and 3.22

**Purpose: Characterize the accuracy of the photodiodes, covers, and algorithm across the sky.**

Facility: Bobby's Lab with overhead lights off

Measurements:

- Measured light source position

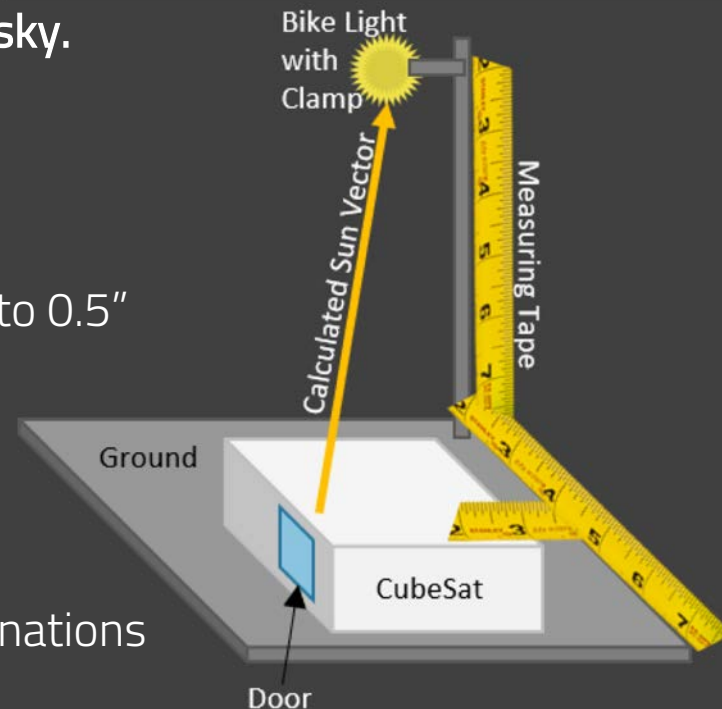
  - 5ft distance to source, know position to 0.5" for  $0.5^\circ$

- CubeSat calculated sun vector

  - Based on photodiode measurements

Full sky characterization:

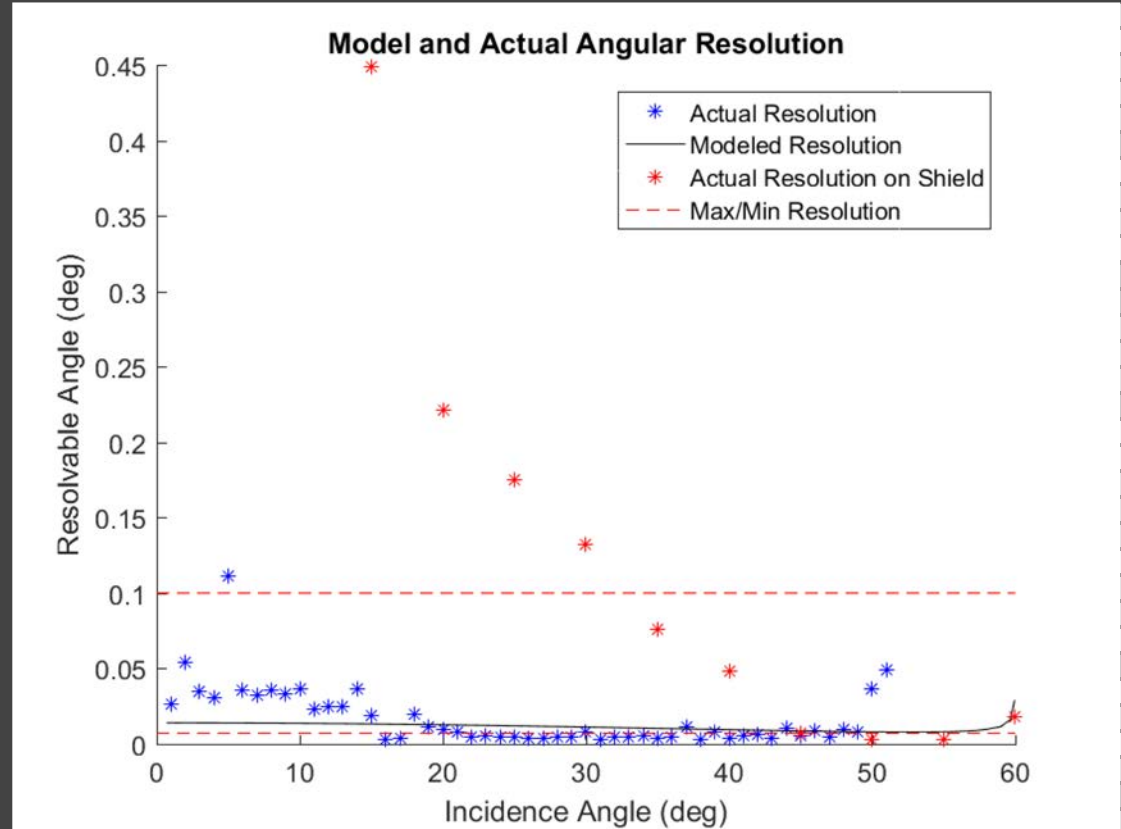
- 32 locations that use all photodiode combinations



# Sun Sensing Problems/Issues



Did not realize we could have too much resolution  
There is a minimum resolution  
Did not add margin to minimum





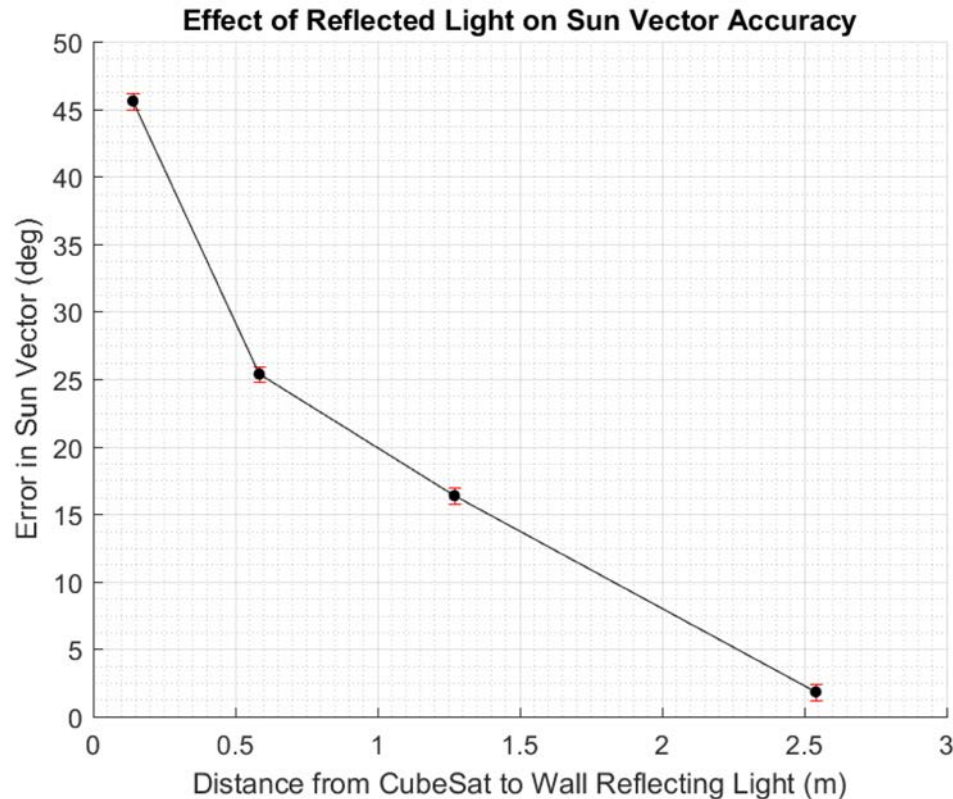
# Reflected Light Caused Additional Errors

Designed ambient light margin reduced due to unexpected roll-off

Sun sensing was not tolerant to reflected light

Testing locations were chosen away from walls to compensate

No requirement for testing environment





# Integrated Tilting and Sun-sensing

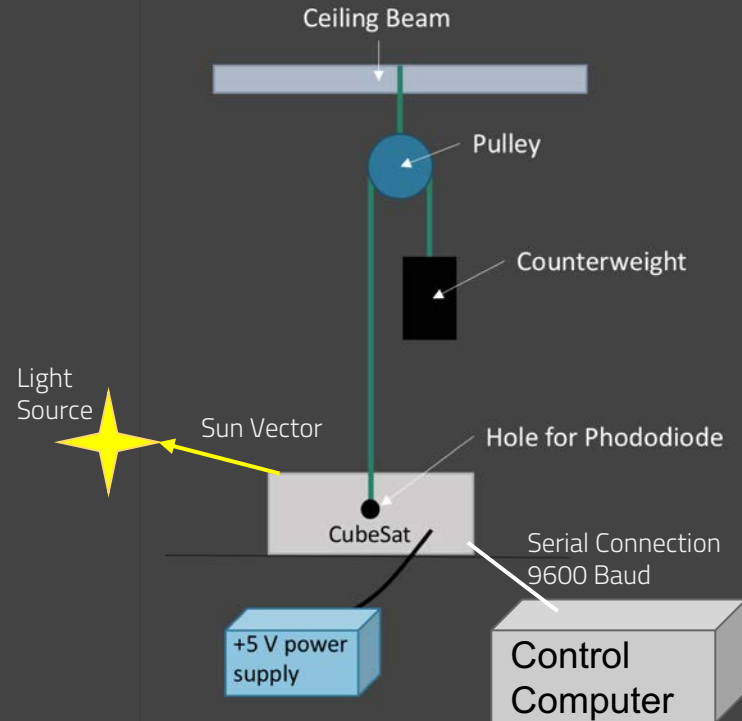
Verify integration of tilting mechanism, door, and sun sensing for  $1^\circ$  accuracy and closed-loop tilting - Requirements 3 and 4

**Purpose:** Measure the tilt angle of the Cubesat as it responds to light locations

Facility: Senior Project Depot

Measurements:

Tilting angle of the cubesat using accelerometer - compare to calculated ideal tilt based on actual light source position







# Integrated Tilting and Sun-sensing

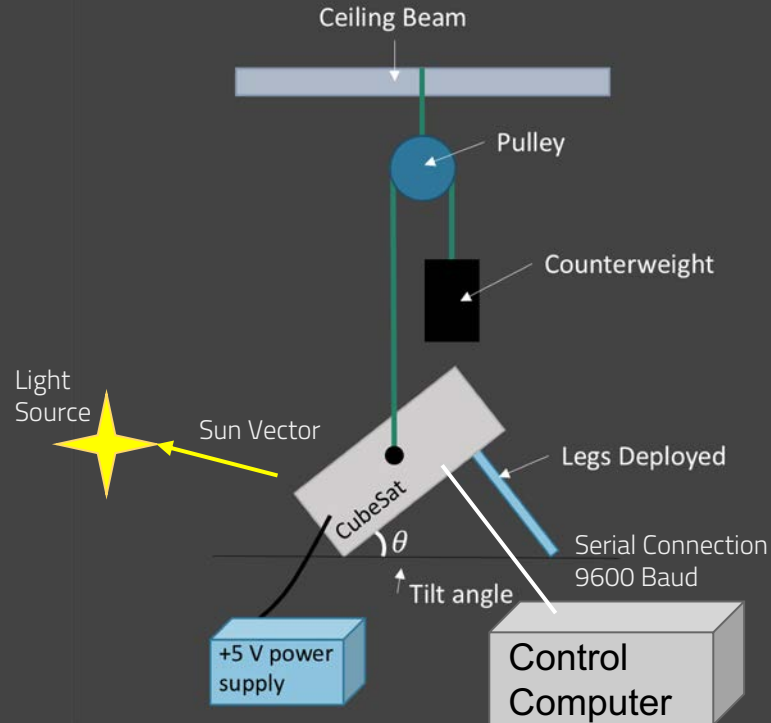
Verify integration of tilting mechanism, door, and sun sensing for  $1^\circ$  accuracy and closed-loop tilting - Requirements 3 and 4

**Purpose:** Measure the tilt angle of the Cubesat as it responds to light locations

Facility: Senior Project Depot

Measurements:

Tilting angle of the cubesat using accelerometer - compare to calculated ideal tilt based on actual light source position





# Photodiode Cover Calibration

Verify the photodiodes can measure the sun angle to within  $0.5^\circ$  over the  $60^\circ$  field of view. Requirements 3.21 and 3.22

Purpose: Provide a calibration for the photodiode output to sun angle

Facility: Bobby's Lab

Cubesat

QB50 Turntable

Light Source (bike light)

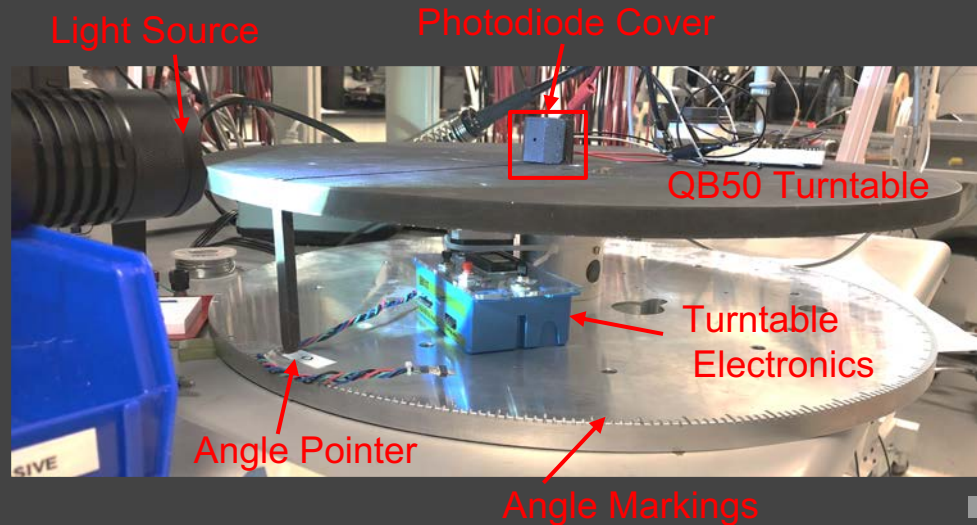
5V Power Supply

Measurements: Output voltage to oscilloscope

Procedure:

Set up turntable and photodiode

Turn  $1^\circ$  increments, measure voltage



# Photodiode Vector Calibration



Verify the pointing of each individual photodiode. Requirements 3.21 and 3.22 ■

Purpose: Provide a calibration for the pointing of each photodiode on the CubeSat

Facility: Bobby's Lab

Cubesat

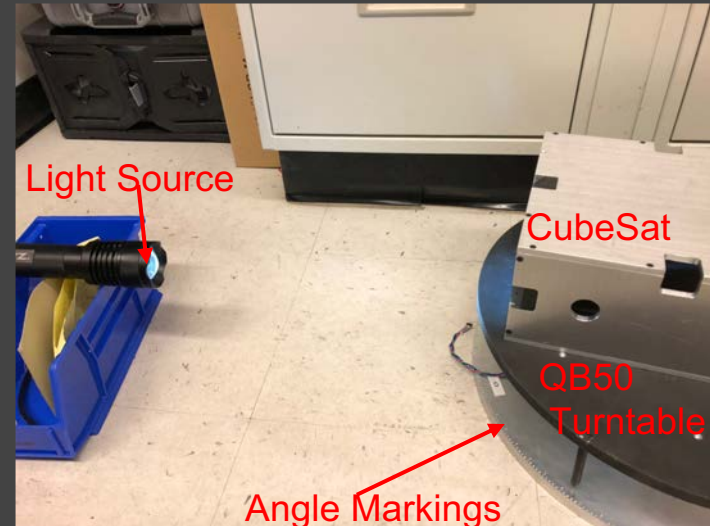
QB50 Turntable

1 increments, 0.25" to within 0.005"

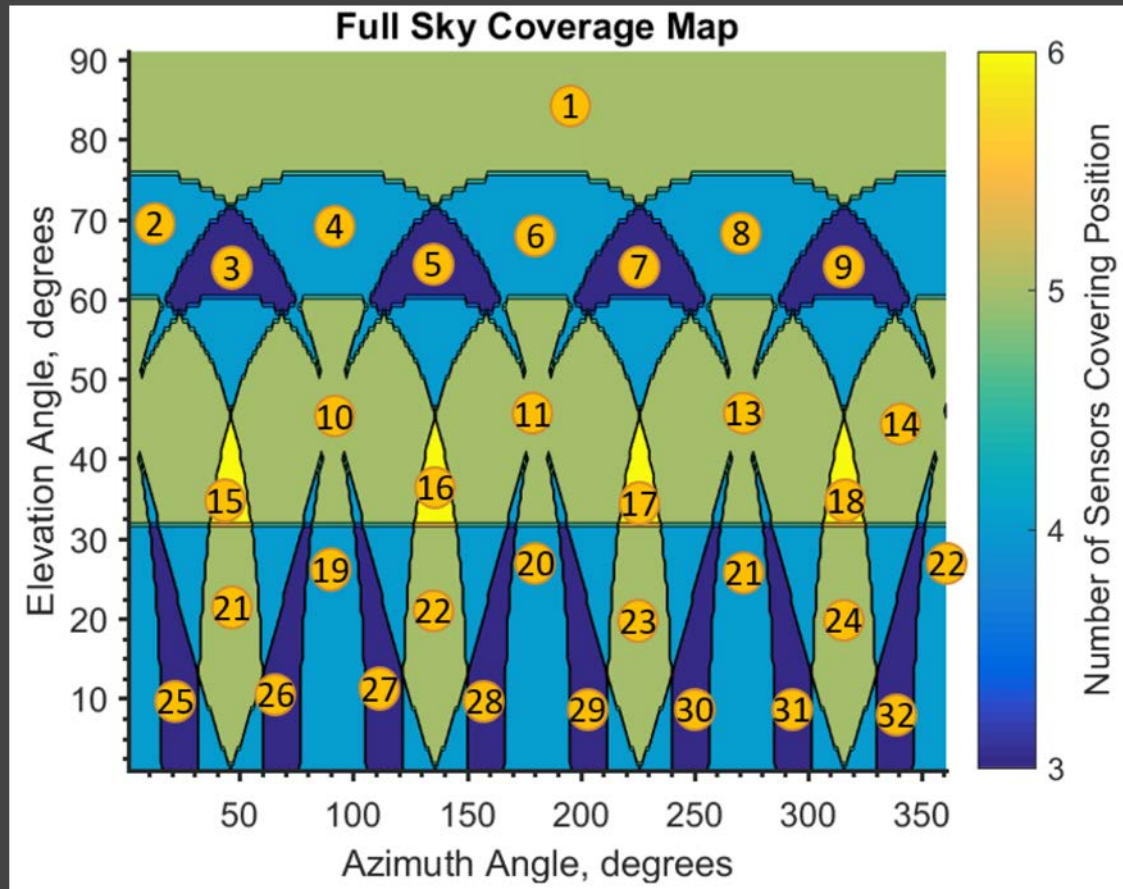
Light Source (bike light)

5V Power Supply

Measurements: Output voltage to microcontroller, resulting sun angles



# Sun Sensing Characterization Locations



# Accelerometer Testing



Verify that accelerometer can resolve less than 0.5 degree tilt angle

Characterization of noise levels of  
digital output

Machine Shop

ADXL345 Triple Axis

Accelerometer

CNC

Accelerometer mount

Procedure (this can also be a diagram)

Calibrate accelerometer

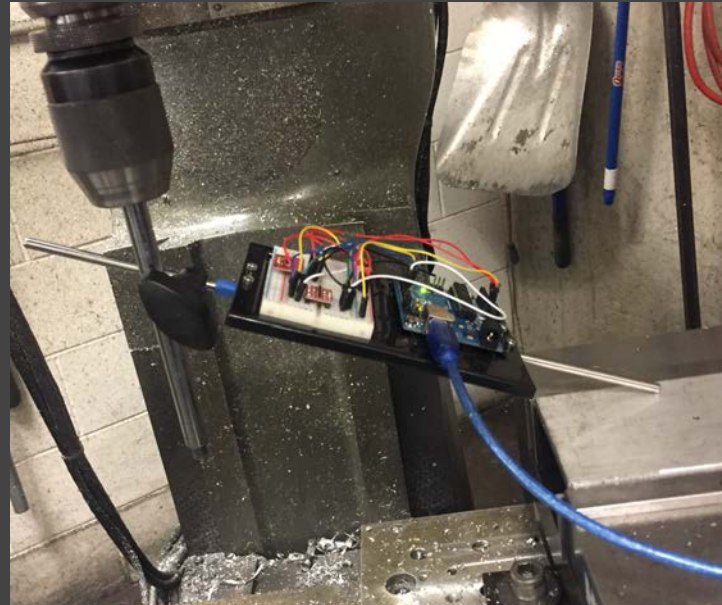
Take data at level (0 deg tilt) (10 s)

Move CNC known amount

Take data at tilt (10s)

Compare measure to computed

Repeat



# Vacuum Chamber Preparations



## Cleaning

- Alcohol/flux remover cleaning for PCBs

- Acetone and ethanol cleaning in ultrasonic bath for machined components

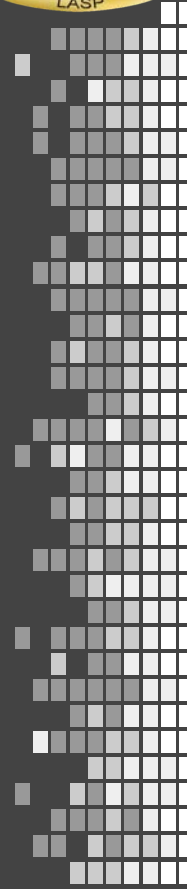
- Cleaned instrument stored in ESD bag for transport

## Proper Material Selection

- Low outgassing materials: aluminum, PEEK, Delrin

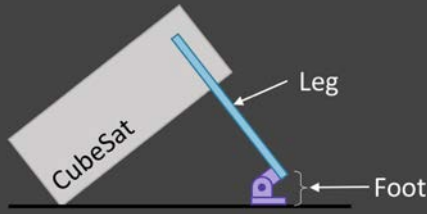
- Vented Bolts

# Tilting Backup Slides

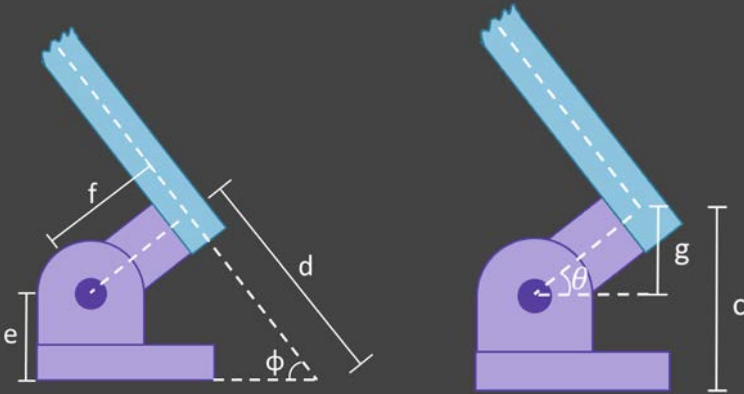
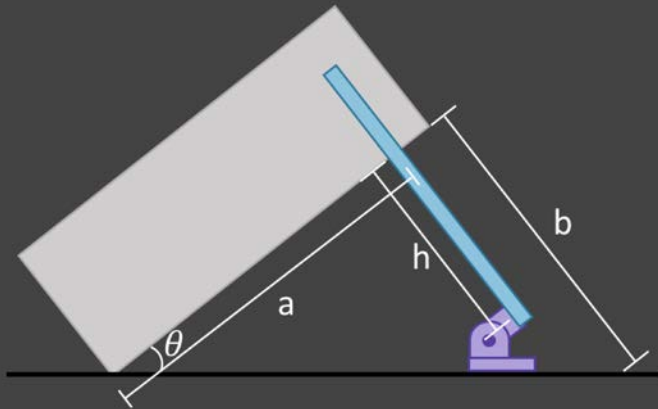




# Scissor Lift Tilting Algorithm



$$b = a * \tan(\theta)$$



$$d = c * \cos(\theta)$$

$$g = f * \sin(\theta)$$

$$c = e + g$$

$$h = b - d$$



# Scissor Lift Tilting Increment



Can't solve for the tilt angle from leg length

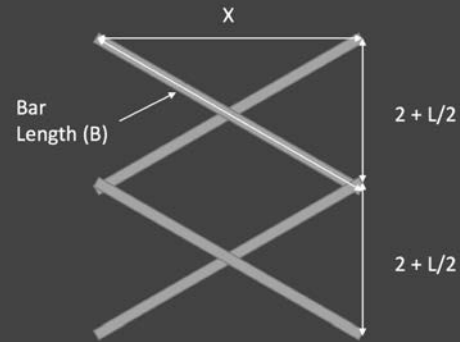
Iteratively solve for leg length based on tilt angle

Compare leg length to closest possible from model to the right.

At all times, leg length error is  $< 10 \mu\text{m}$

Error in angle is  $< 38.4 \text{ mas}$

Then Need To Determine Horizontal Actuation



$$X = \sqrt{B^2 - (2)^2}$$

$$X' = \sqrt{B^2 - \left(2 + \frac{L}{2}\right)^2}$$

$$\text{Horizontal Actuation} = \Delta X = X - X'$$



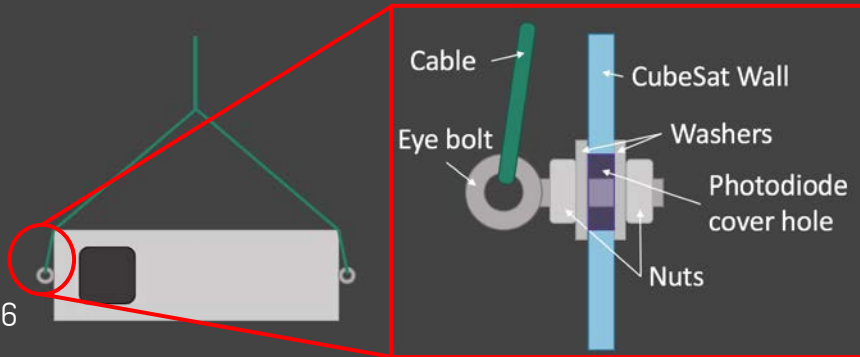
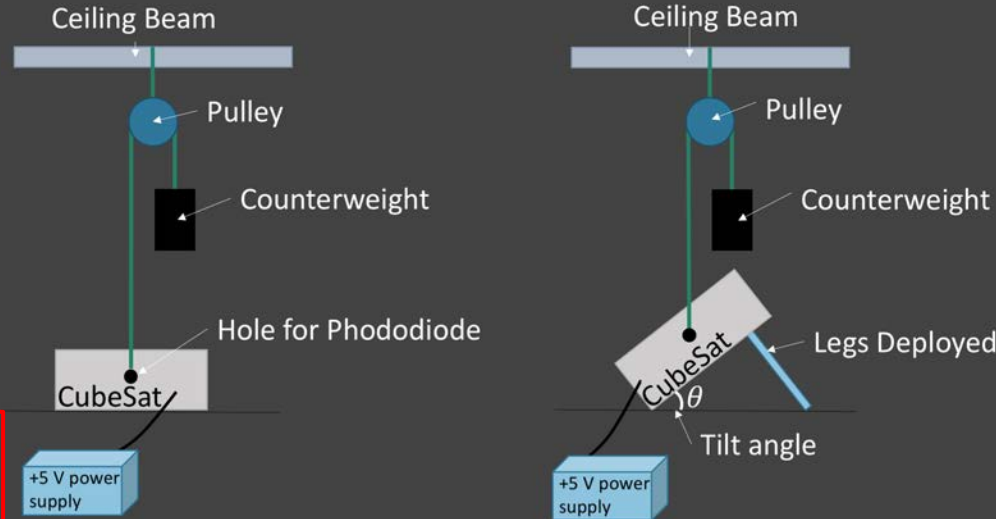
# Open Loop Tilt Testing

Verify the tilting mechanism can tilt the instrument up to  $45^\circ$  in  $1^\circ$  increments ( $\pm 0.5^\circ$  accuracy) - Requirements 4.12,4.121

**Purpose:** Measure the tilt angle of the Cubesat relative to level ground in  $1^\circ$  increments

**Facility:** Senior Project Depot

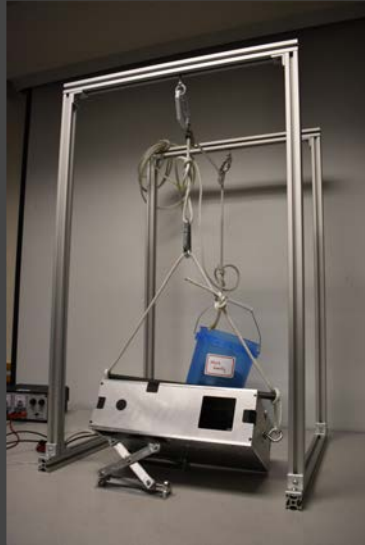
**Measurements:** Tilting angle of the CubeSat using accelerometer



# Tilt Testing Changes



Added a second pulley to reduce risk of bucket hitting cubesat



Added a support to prevent rope from resting on body



# Other Evidence of Friction

Cubesat became suspended while tilting back down over large increments

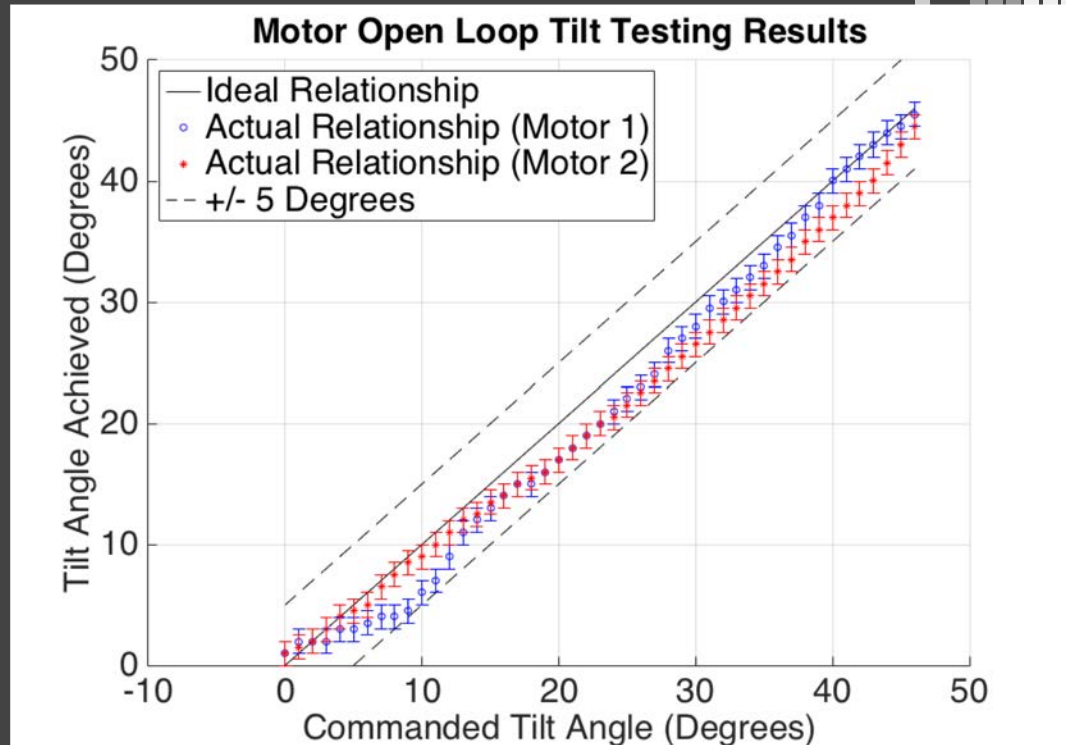


# Open-Loop Tilting Results



Sending commands to the Teensy to step the motors by a predetermined amount based on our model

Meets 2nd level of success  
(Open loop tilting accuracy of  $\pm 5^\circ$ )



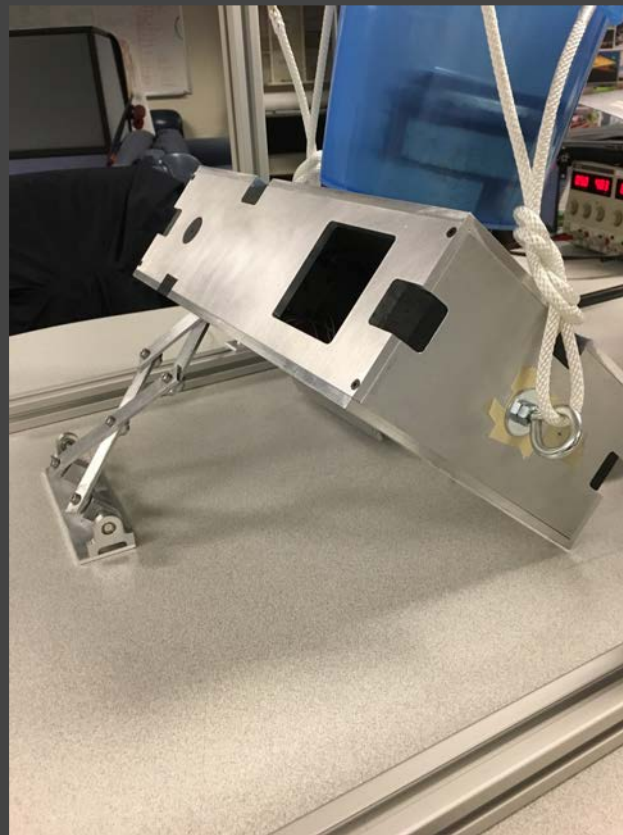
# “Locked” Tilting Results



After tilting, another requirement was to ensure that the motor could hold the weight of the cubesat

- Turned off power and left cubesat tilted for 5 minutes and overnight
- Tilt angle did not change in either case

Requirement 4.123 Verified: The actuators shall lock when they reach the desired angle to maintain the tilt within 1 degree.



# Door Testing



**Purpose: Ensure the Door  
Opens Correctly**

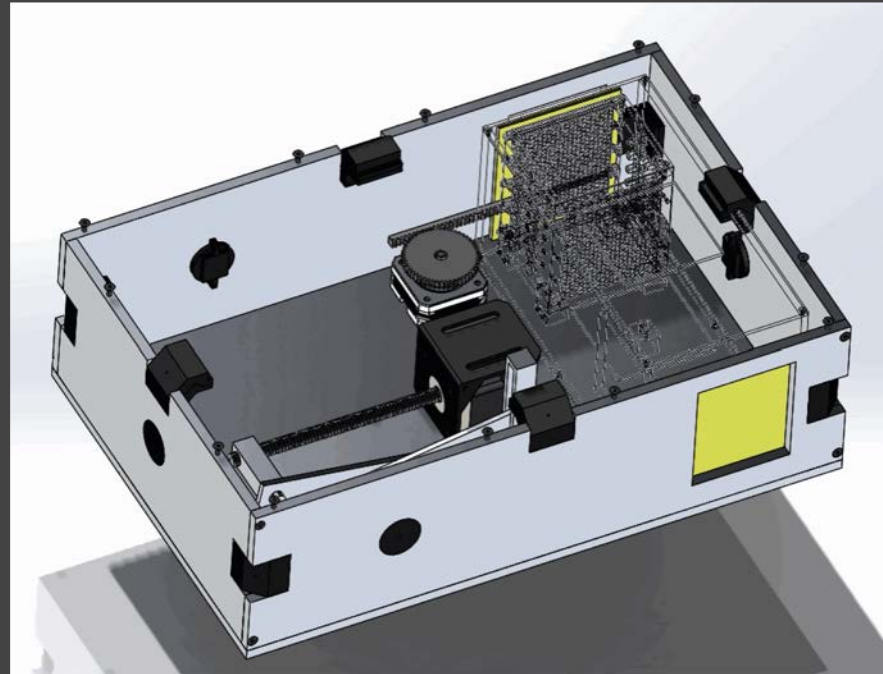
Facility: Senior Project Depot

Measurements:

Does the door protect  
this instrument

Procedure:

Attach door to power  
supply and Teensy  
Activate door  
mechanism at level and  
tilting platform



# Door Testing Results



Manufacturing issues led to Doors not being able to fit inside of Cubesat

Unable to test if the door operated as intended

Would require more time to implement some fixes

Requirement 3.11, 3.12  
Incomplete



# Photodiodes Boards

Verify functionality of PCB and overall design

Voltage relative to intensity of light

Ambient light \_\_\_mV

Electronics lab

Power supply (5V)

Oscilloscope/multimeter

Procedure

Connect PCB to power supply and measuring device

Turn on and check readout in ambient light

In a dark room, position light source 5ft away and check readout at different angles



# Teensy Shield Test (backup)

## Verify functionality of PCB and filter design

Fit check, verify all components  
are powered correctly and  
outputting information

Electronics lab

Power supply (5V)

Oscilloscope

Multimeter

## Procedure

Fit check all COTS boards (do  
not solder on yet)

Connect to power supply  
and check proper power  
distribution

Connect photodiode and  
check output after filter

Solder on COTS boards one  
at a time and check  
functionality of each



# Impact Testing Models



## Rigid Bar Statics Model

Wire's fail at 4 N impact force

Unable to correlate impact velocity to impact force without impact time

## Solidworks Model

Proper Material Selection

10 m/s impact results show stresses not exceeding failure stress

# Impact Testing Model



## Assumptions

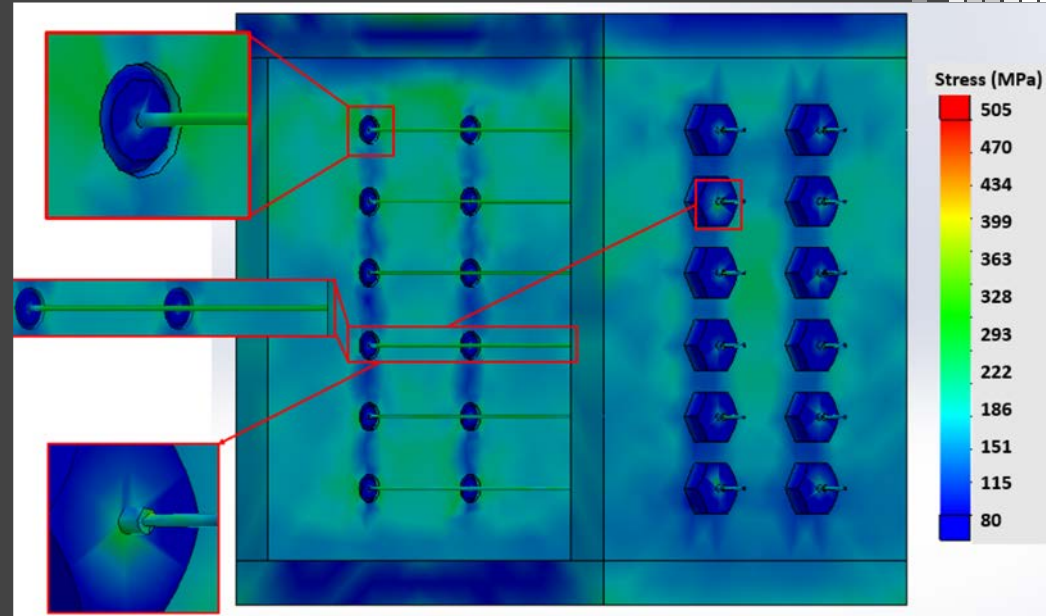
- Entire DTS is bonded
- Landing on rigid surface
- Perfectly inelastic collision

## Stainless steel 304 wire electrodes

Ultimate Tensile Strength: 505 MPa

## Solder Stoppers

- Length (~ 2.2 mm) designed to shear at 520 MPa normal stress
- Wire will fracture before solder joint shears off



# Lansmont Drop Test Procedure



Step 1: Input desired drop height.

2: Raise testbed to desired drop height.

3: Once in position, run LabView VI to record voltage and drop the testbed.

4: After completing drop, stop the VI (VI will save the drop data).

5. Repeat procedure for new drop height

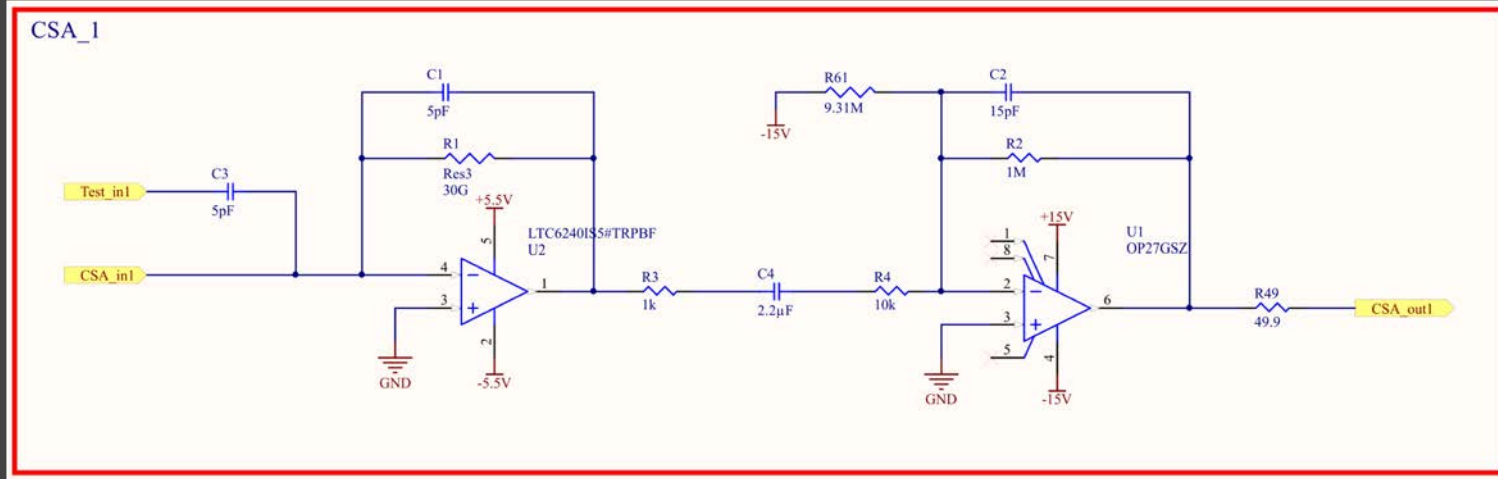
Post-process voltage data to calculate acceleration. Integrate acceleration to determine impact velocity.

Drop Height (cm)	10	20	30	40	50	60	70	80	90	100	110	120	127
Impact Velocity (m/s)	0.8	1.6	2.1	2.5	2.9	3.2	3.5	3.7	4.0	4.3	4.5	4.7	4.9

# Drop Test Footage



# CSA Verification: Model



Ideal op-amp model assumed

$$V_{out} = \frac{Q_{dust} G_2}{C_{fb}}, \quad Q_{dust} \approx Q_{test\ cap}$$

$$Q_{test\ cap} = C_{test} V_{test}$$

# Embedded System Status cont.

Hardware/software integration incomplete  
Infeasible given time and resources—two team members responsible for:

Custom instrument embedded system (low-noise analog electronics and digital system)

Real-time embedded software designed and implemented using LASP Ada-based flight software framework, Adamant

Functional requirements not met:

5. The electronics subsystem shall collect signals and issue commands to and from the instrument [...]

6. The software shall be capable of [...] detecting dust events [...]





# Software Framework



## What is Completed

- Implemented dust detection algorithm
- Error events for ADC missampling or incorrect timing
- User serial input commands to start and stop data collection, reset data buffers, and flip polarity of the instrument
- Serial output of dust event data once dust particle is found

## What could not be finished

- Hardware/Software integration which includes setting up the ADCs, DMA, MCU, and hardware interrupts

## Why it wasn't finished

- Lack of team knowledge and time for software/hardware integration
- Difficulty in using open-source Ada STM32F4 drivers within framework



# Integrated Tilting and Sun-sensing

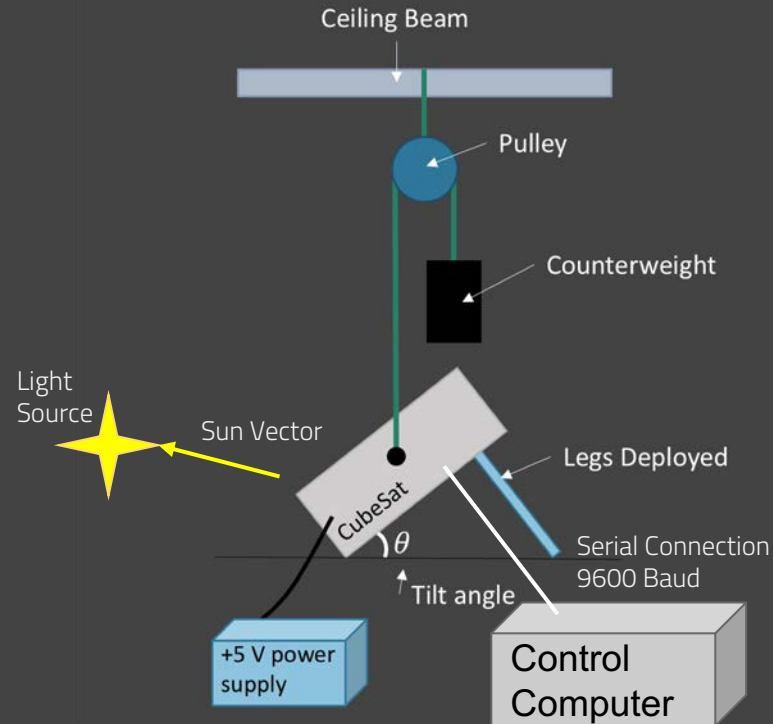
Verify integration of tilting mechanism, door, and sun sensing for  $1^\circ$  accuracy and closed-loop tilting - Requirements 3 and 4

**Purpose:** Measure the tilt angle of the Cubesat as it responds to light locations

Facility: Senior Project Depot

Measurements:

Tilting angle of the cubesat using accelerometer - compare to calculated ideal tilt based on actual light source position





# Photodiode Cover Calibration

Verify the photodiodes can measure the sun angle to within  $0.5^\circ$  over the  $60^\circ$  field of view. Requirements 3.21 and 3.22

Purpose: Provide a calibration for the photodiode output to sun angle

Facility: Bobby's Lab

Cubesat

QB50 Turntable

Light Source (bike light)

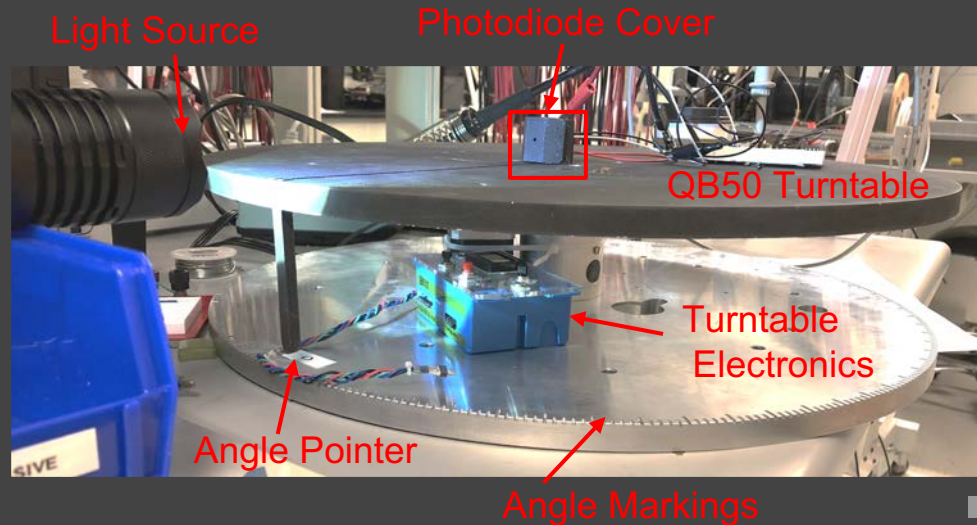
5V Power Supply

Measurements: Output voltage to oscilloscope

Procedure:

Set up turntable and photodiode

Turn  $1^\circ$  increments, measure voltage



# Photodiode Vector Calibration



Verify the pointing of each individual photodiode. Requirements 3.21 and 3.22 ■

Purpose: Provide a calibration for the pointing of each photodiode on the CubeSat

Facility: Bobby's Lab

Cubesat

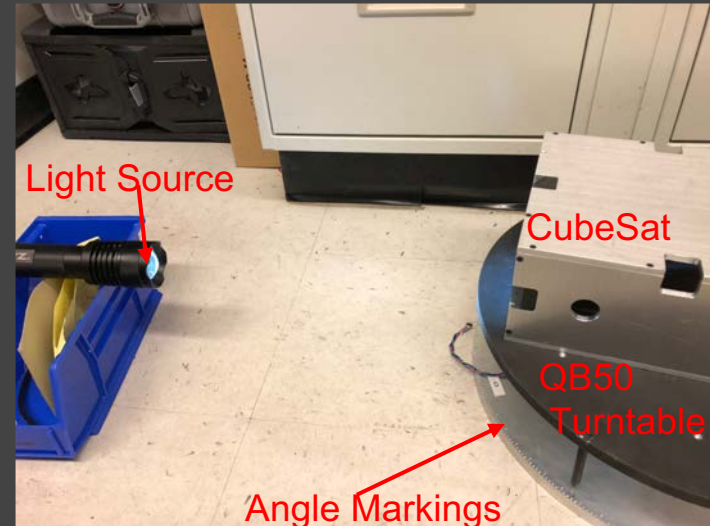
QB50 Turntable

1 increments, 0.25" to within 0.005"

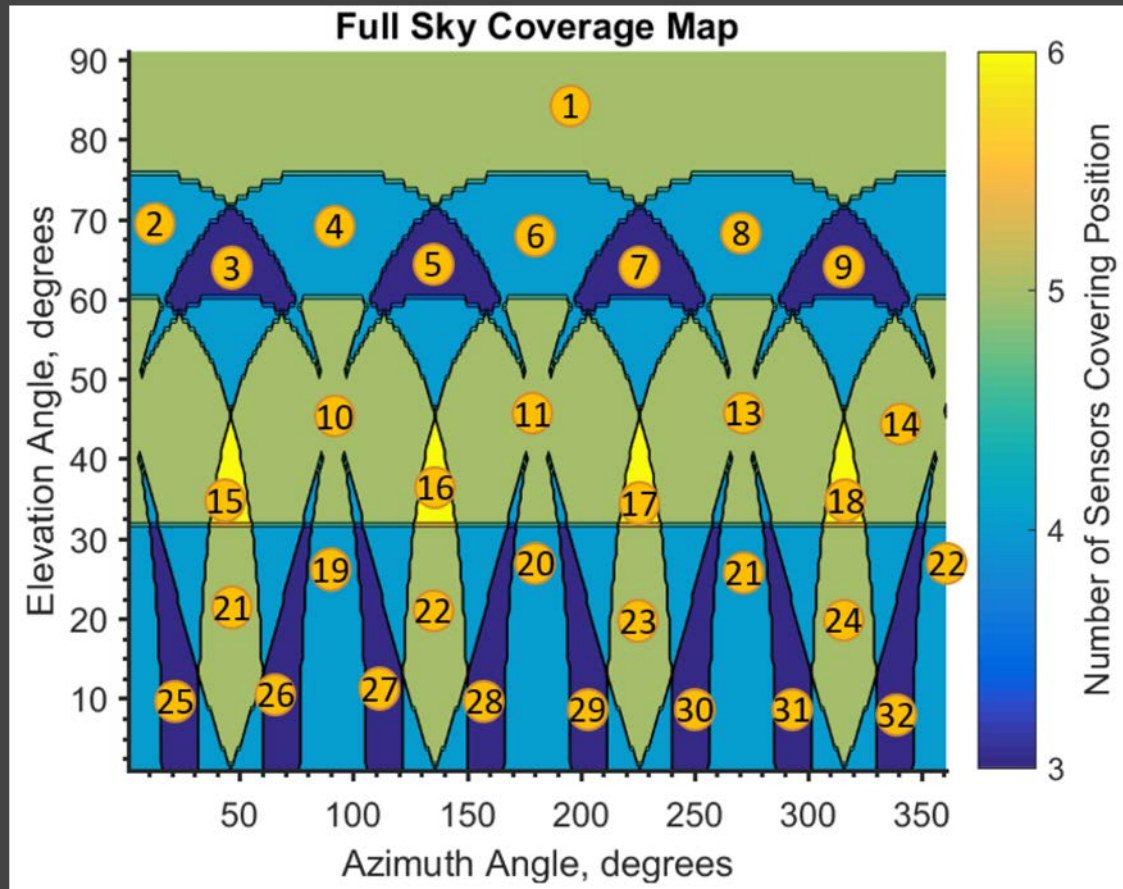
Light Source (bike light)

5V Power Supply

Measurements: Output voltage to microcontroller, resulting sun angles



# Sun Sensing Characterization Locations



# Photodiodes Boards

## Verify functionality of PCB and overall design

Voltage relative to intensity of light

Ambient light 550mV

Electronics lab

Power supply (5V)

Oscilloscope/multimeter

Procedure

Connect PCB to power supply and measuring device

Turn on and check readout in ambient light

In a dark room, position light source 5ft away and check readout at different angles



# Teensy Shield Test (backup)

## Verify functionality of PCB and filter design

Fit check, verify all components  
are powered correctly and  
outputting information

Electronics lab

Power supply (5V)

Oscilloscope

Multimeter

## Procedure

Fit check all COTS boards (do  
not solder on yet)

Connect to power supply  
and check proper power  
distribution

Connect photodiode and  
check output after filter

Solder on COTS boards one  
at a time and check  
functionality of each



# Sun Determination Requirement



## Specific Requirement:

3.2.4 - The ARS shall maintain full sky view in a  $180^\circ$  half dome over the  $+Z$  hemisphere.

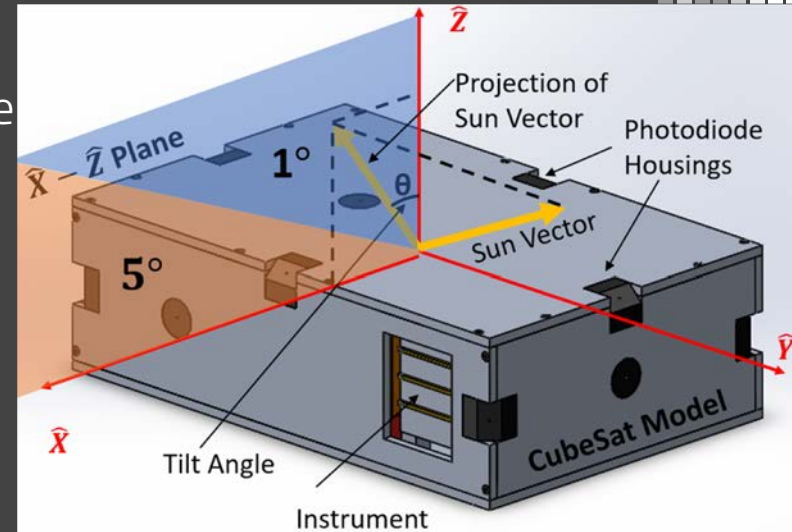
3.2.2 - The ARS shall determine Sun position within  $\pm 5^\circ$  up to  $45^\circ$  above the surface and within  $\pm 1$  degree from  $45^\circ$  to  $90^\circ$  above the surface, in the XZ plane.

## Why?

Must actuate CubeSat to  $45^\circ$ , or as close as possible without allowing solar wind to enter instrument

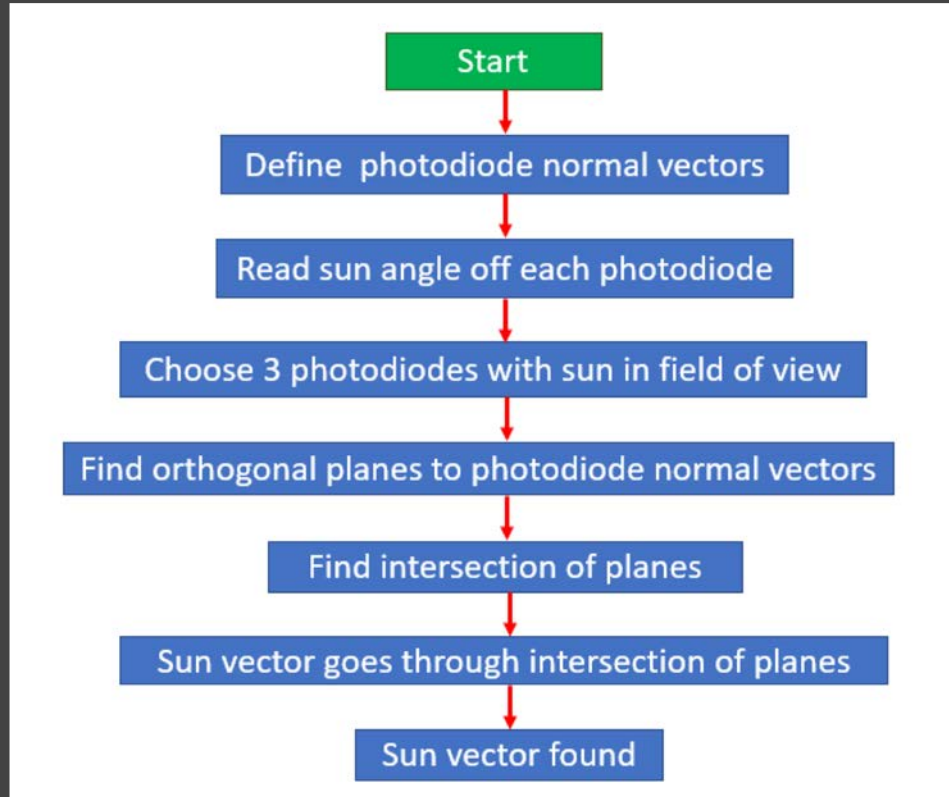
## Designs Driven:

Sun determination algorithm  
Photodiode placement





# Sun Finding Algorithm



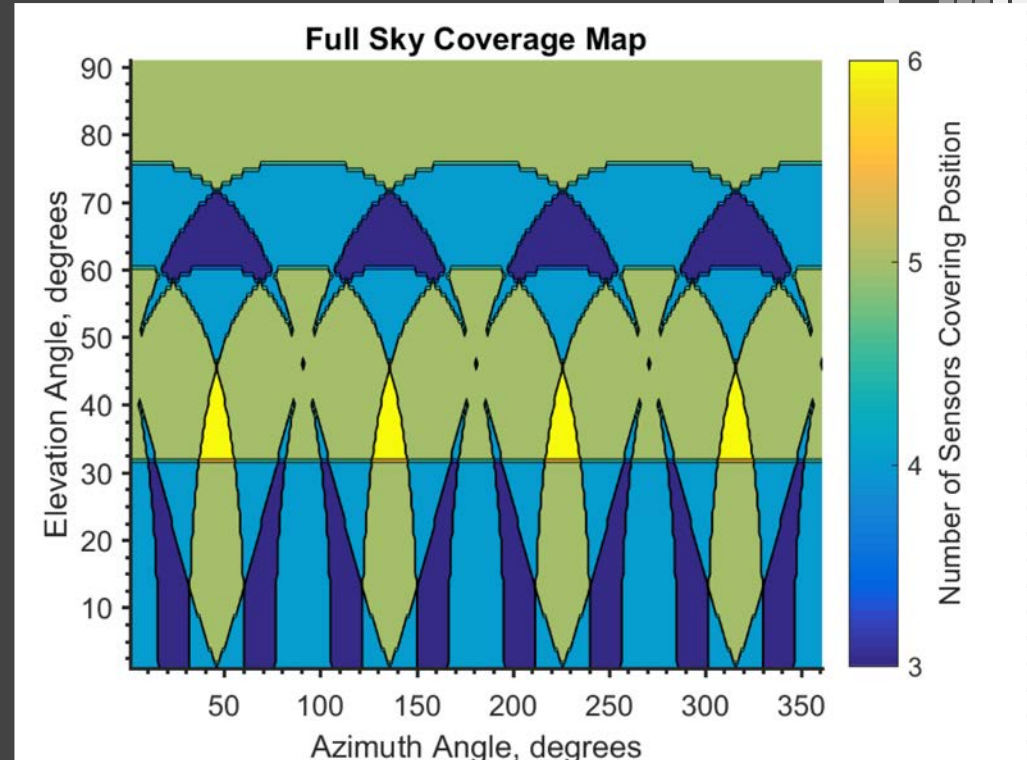
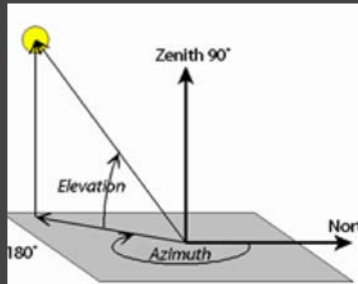


# Full Sky Coverage

3 measurements required to find sun  
Full sky must be covered by 3  
photodiodes at minimum  
Map shows number of sensors  
that see each position in the sky

3 Photodiode Minimum

Requirement 3.2.4 satisfied





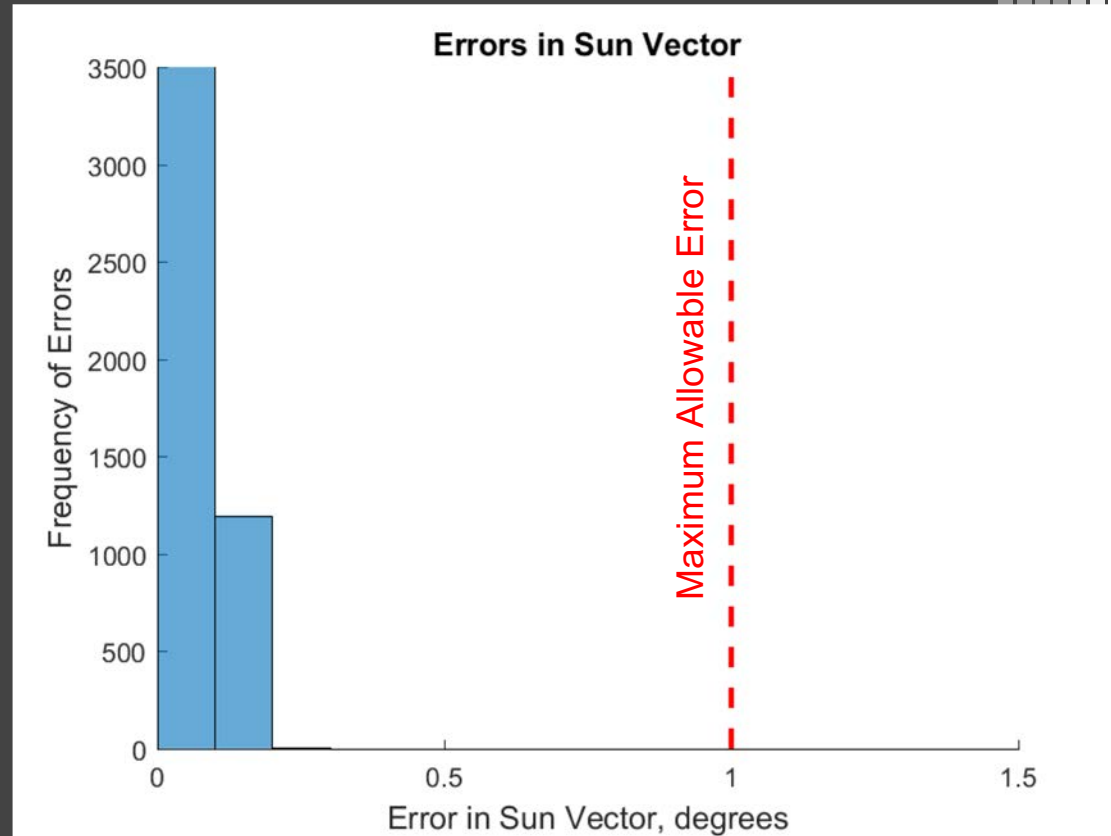
# Nominal Design Case

Varied thermal and sampling noise uniformly  
Move sun vector over full sky  
Maximum error in sun vector is  $0.26^\circ$

Worst Errors  $0.26^\circ < 1^\circ$

Requirement 3.2.2 satisfied

More than  $0.9^\circ$  error margin for  $> 95\%$  of iterations



# ARS Component Level Tests



## Sensor Tests

Testing and calibration:

Individual photodiode outputs.

Individual photodiodes and covers for manufacturing tolerances.

Photodiode housing mounting on CubeSat structure.

Accelerometer mounting

## Mechanisms Tests

Testing

Individual parts for errors in manufacturing

Test tilting matches model (independent of other systems)

## Software Tests

Module level testing of algorithms

# Sun Knowledge - Accuracy



## Need to know the current output of the photodiodes

Solar irradiance spectrum is well known and provides power at every wavelength  
Photodiode relative spectral sensitivity gives relative power absorbed at every wavelength

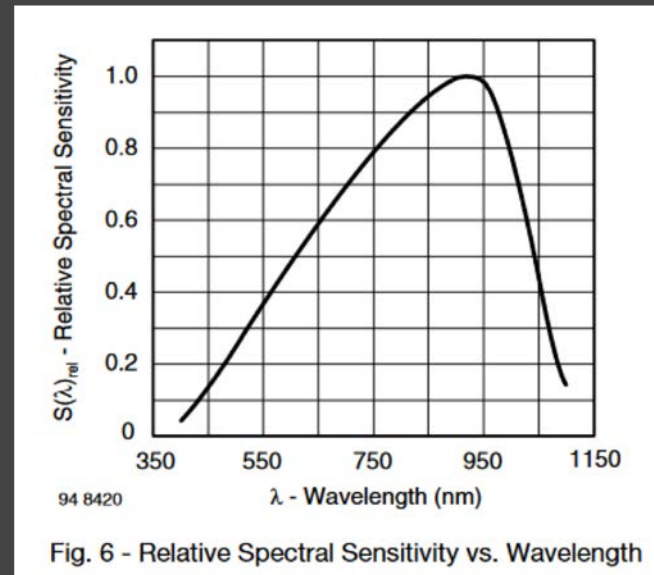
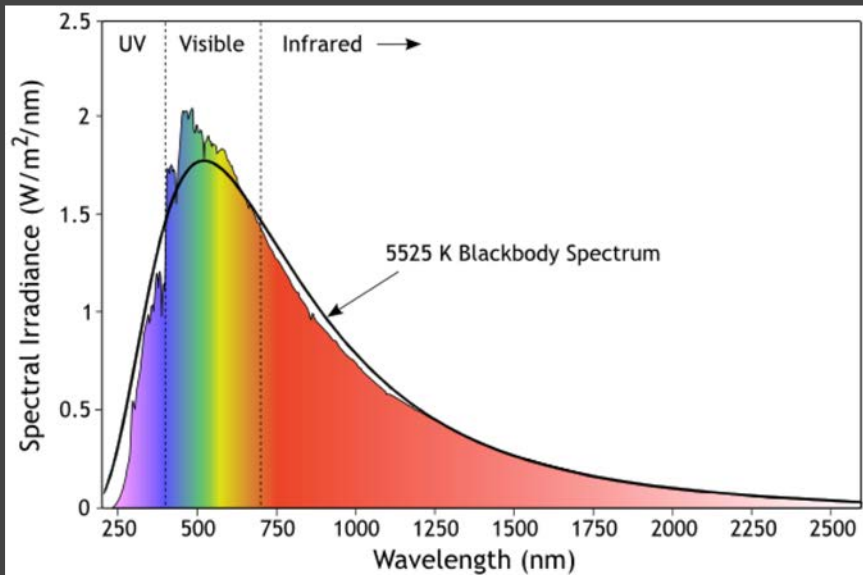
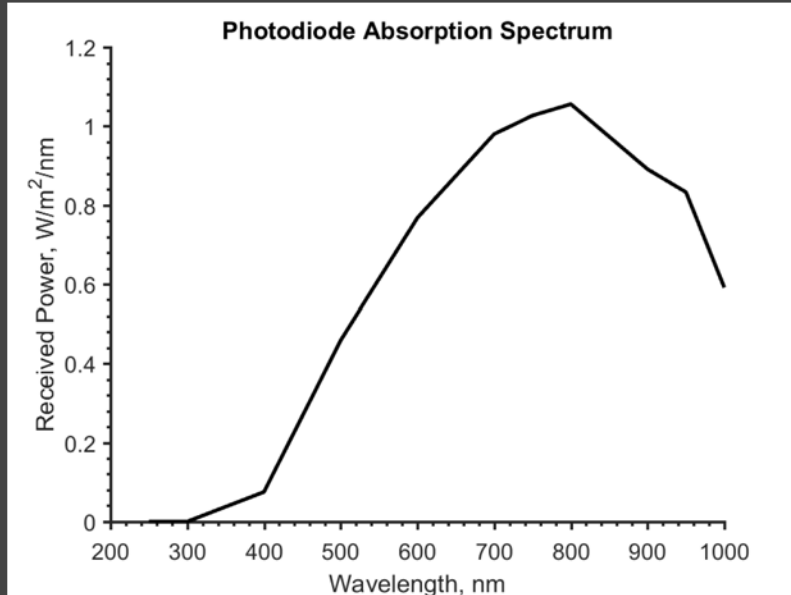


Fig. 6 - Relative Spectral Sensitivity vs. Wavelength

# Sun Knowledge - Accuracy



Multiply solar irradiance spectrum and photodiode relative spectral sensitivity at each wavelength  
Result is photodiode power per area across the full spectrum

Integrate the photodiode absorption spectrum to get the total power the photodiode will receive.

$$I_r = 457.5 \text{ W/m}^2$$

$$P = IA = \mathbf{3.4 \text{ mW}}$$

# Sun Knowledge - Accuracy



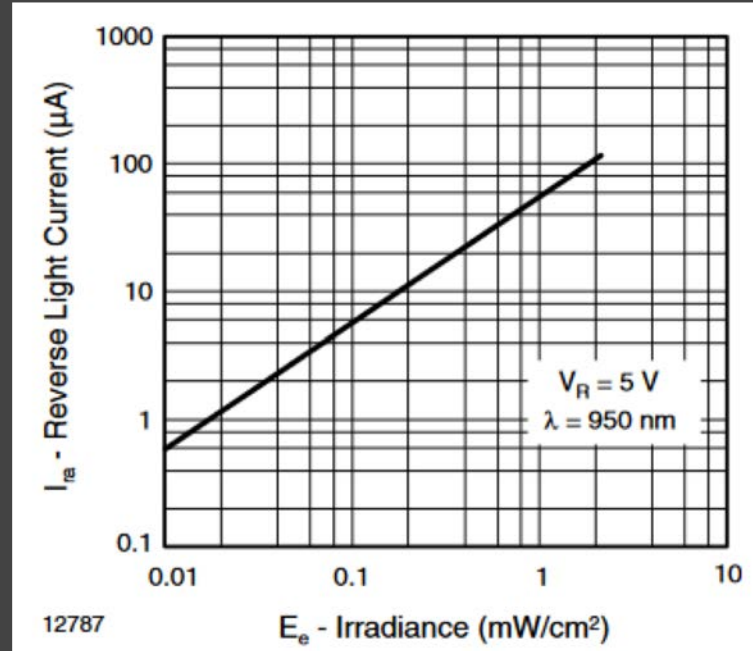
Expected Irradiance on photodiodes:

$$E_e = 0.4575 \text{ mW/cm}^2$$

From gain curve on datasheet

$$I = 30 \text{ } \mu\text{A}$$

Microcontrollers measure voltage, not current  
Voltage measured across a resistor to ground  
would be too small for Teensy microcontroller,  
so **voltage needs to be amplified**





# Sun Knowledge - Accuracy

Implement a transimpedance amplifier to boost the signal and convert current to voltage.

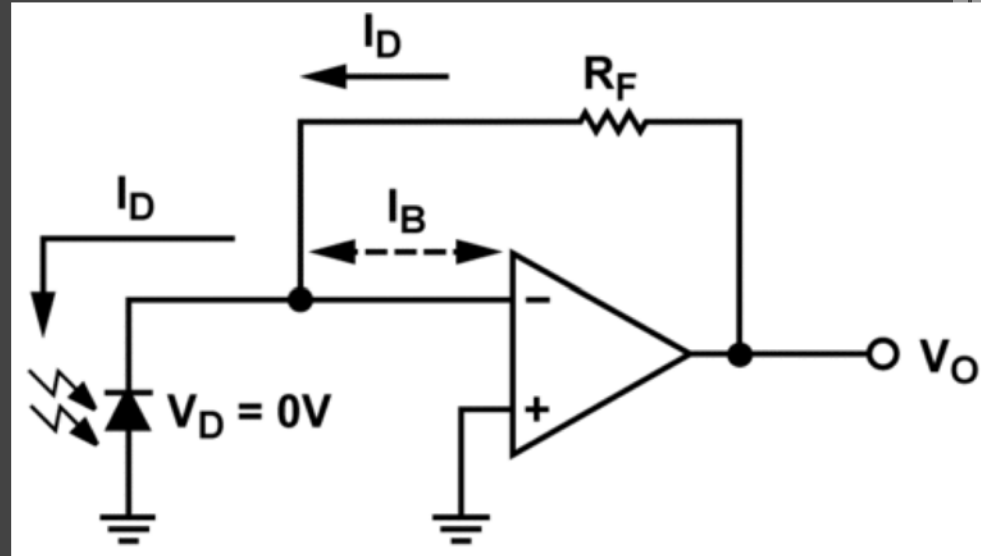
$$V_o = I_D \cdot R_f$$

Maximum current of  $30 \mu\text{A}$

$R_f$  of  $200 \text{ k}\Omega$

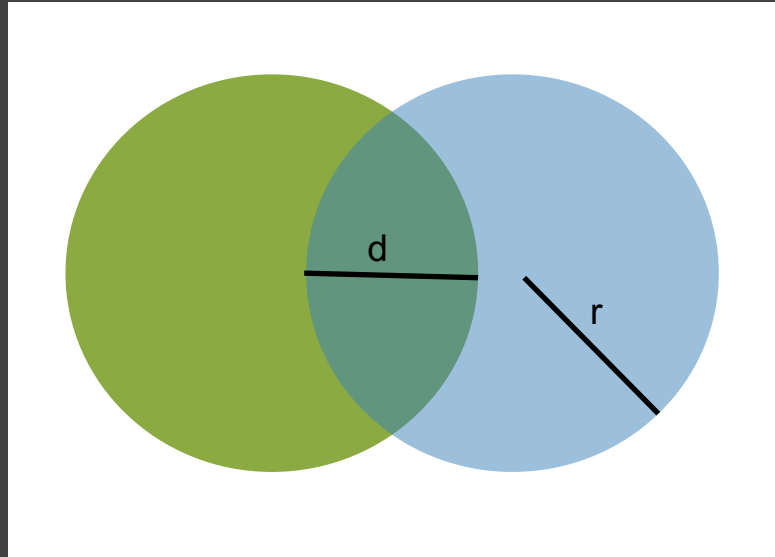
$V_o \text{ max} = 4.8 \text{ V}$

Output voltage is **within microcontroller range**





# Photodiode Covers – Exposed Area



$$A = 2R^2 \cos^{-1} \left( \frac{d}{2R} \right) - \frac{1}{2} d \sqrt{4R^2 - d^2}$$



# Sun Sensor Design

Why do we need the Sun position?

Need to know which side of the CubeSat to actuate

Solar wind from the Sun can create erroneous data

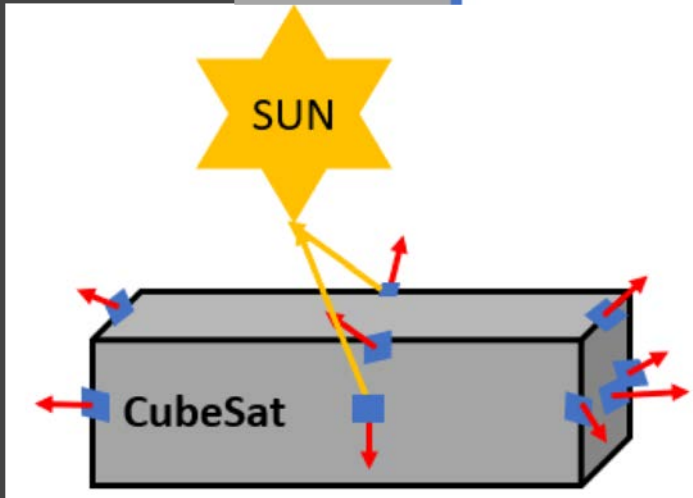
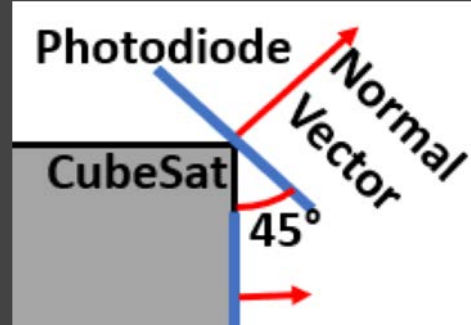
Solar keep-out and  $45^\circ$  actuation not always possible

Actuate to within 1 of highest possible angle

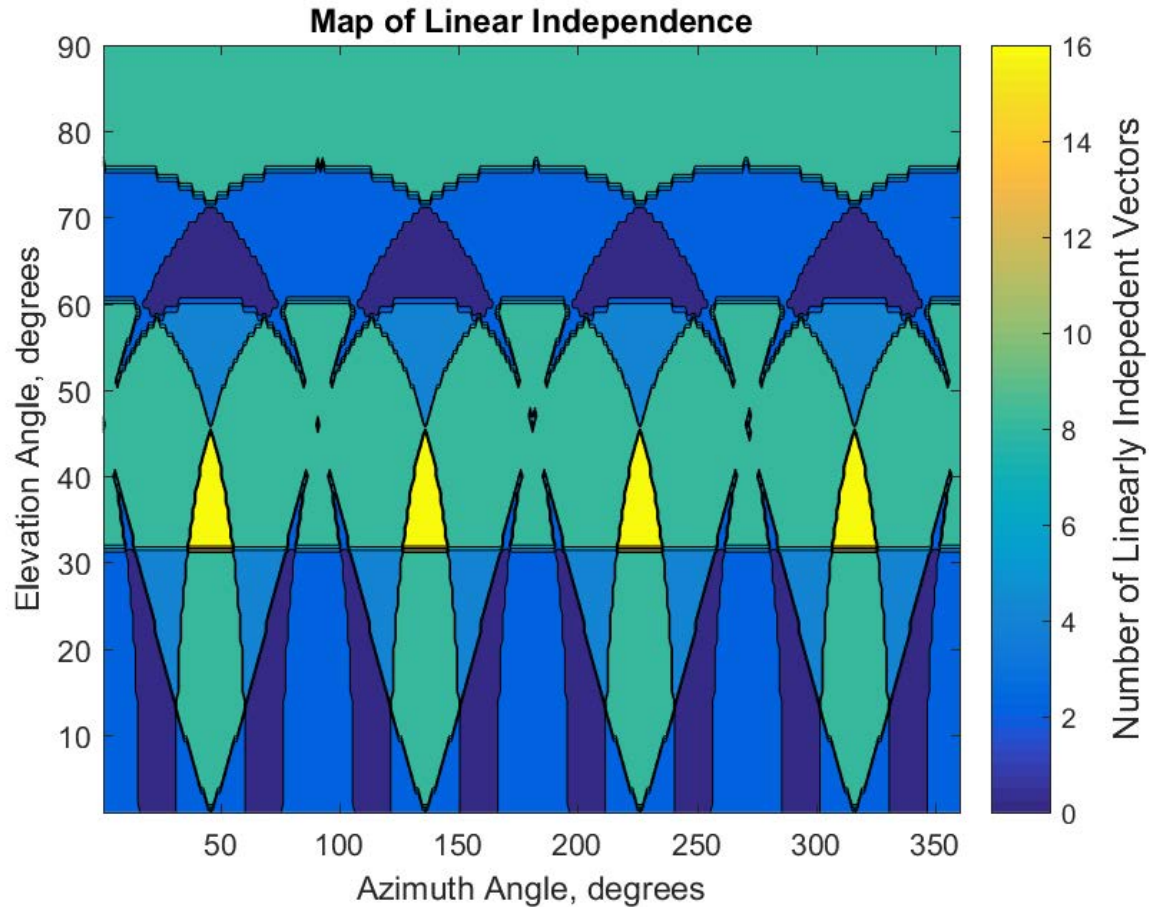
How? - Photodiodes

Edges and side faces will have a sensor

Edges mounted  $45^\circ$  off sides, faces flat



# Linear Independence Sky Map





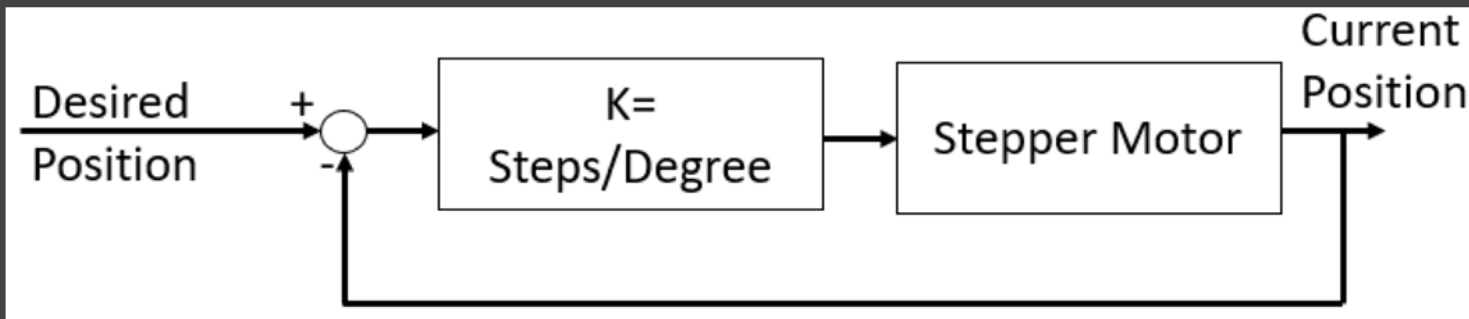
# ARS Software: Control Loop Design

Why?

Stepper Motors aren't perfect, they can skip a step

How?

Use a closed loop control system for the stepper motors  
Due to discrete steps of stepper motor, only proportional control needed  
No rise time or overshoot requirements



# ARS Software



## Why?

Need to be able to determine optimal angle for Cubesat to tilt and send motor commands for actuation

How? Sample 13 photodiodes for sun position and sample accelerometer for closed loop control

Read in analog values from photodiodes and convert to digital

Convert digital photodiode values to relative sun vector angles

Determine 3D sun vector

Determine correct angle to tilt and which side

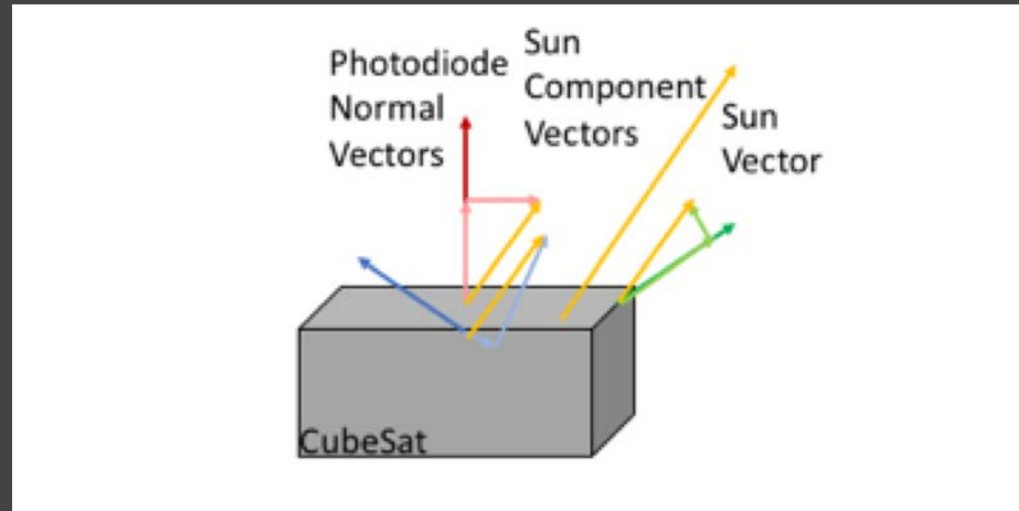
Ensure tilting is correct with accelerometer feedback

Send correct voltage and step amounts to motors

# Determining the Sun Vector

The Sun  
1 vector

From 3 diodes  
3 vectors  
3 angles



# Determining the Sun Vector

The Sun

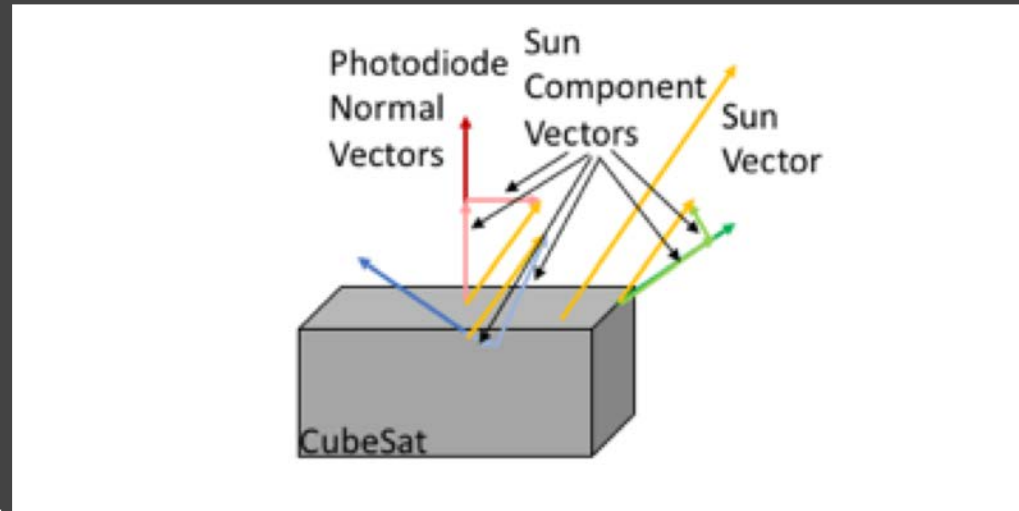
1 vector

From 3 diodes

3 vectors

3 angles

3 Sun vector components



# Determining the Sun Vector

The Sun

1 vector

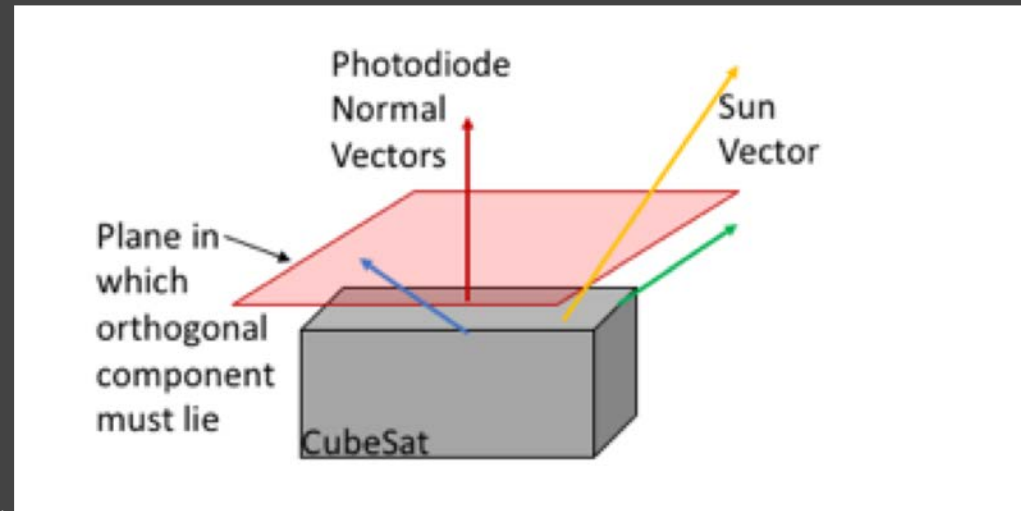
From 3 diodes

3 vectors

3 angles

3 Sun vector components

Define 1 plane





# Determining the Sun Vector

The Sun

1 vector

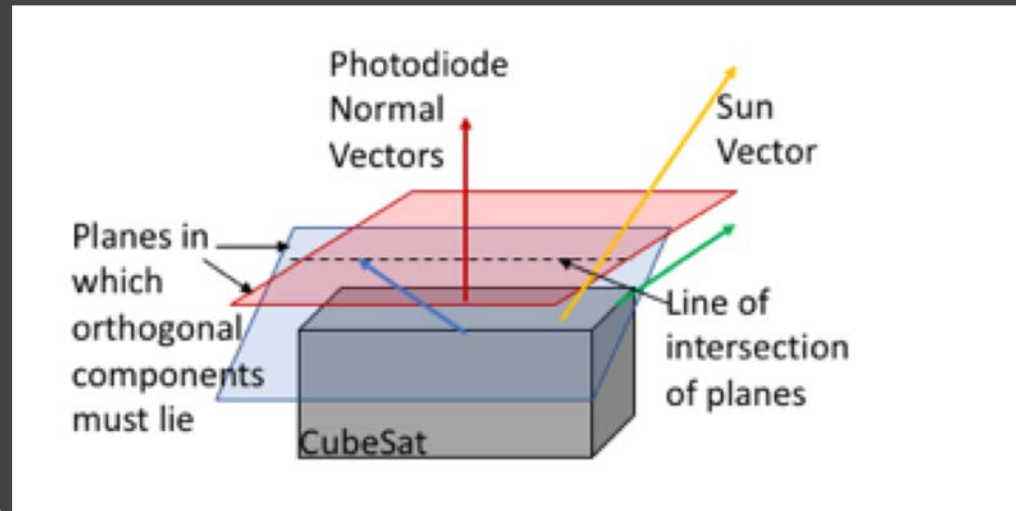
From 3 diodes

3 vectors

3 angles

3 Sun vector components

Define 2 planes



# Determining the Sun Vector

The Sun

1 vector

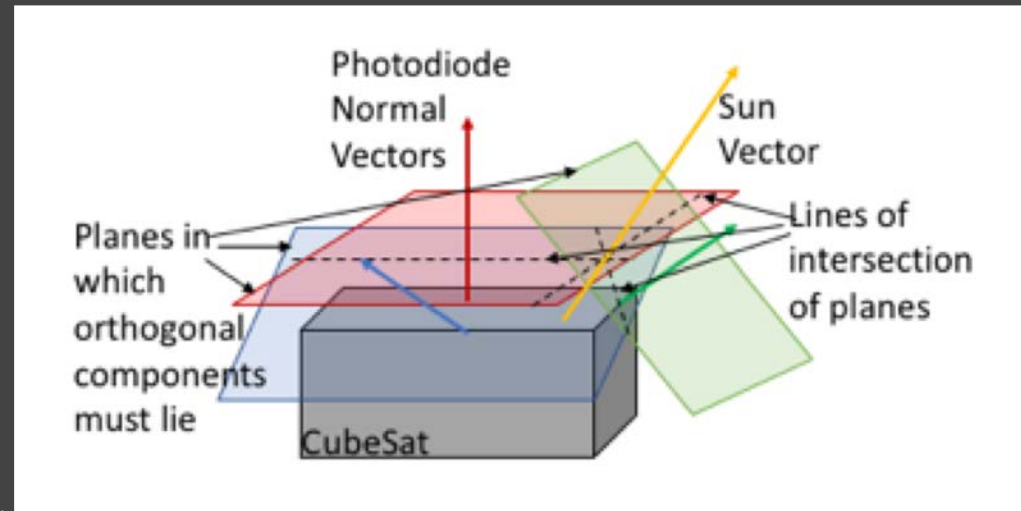
From 3 diodes

3 vectors

3 angles

3 Sun vector components

Define 3 planes





# Determining the Sun Vector

The Sun

1 vector

From 3 diodes

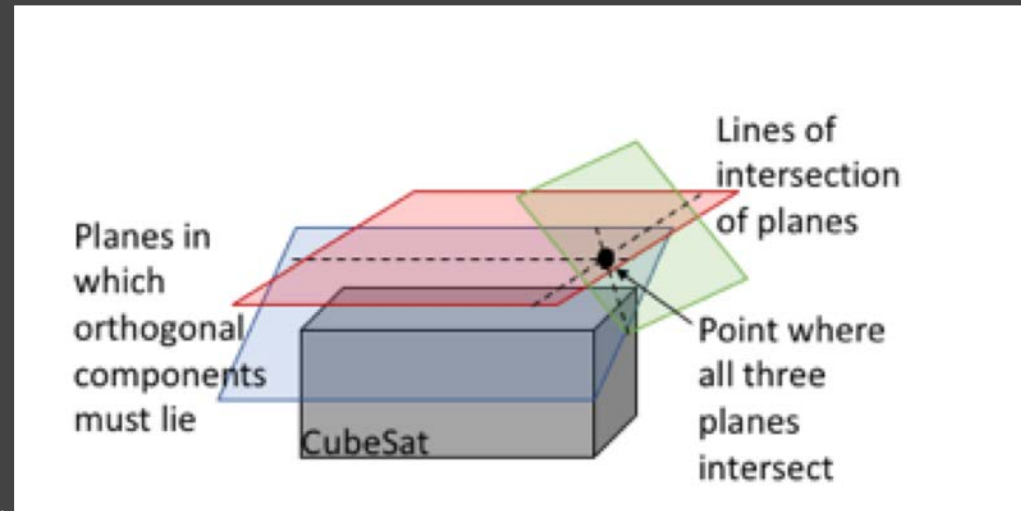
3 vectors

3 angles

3 Sun vector components

Define 3 planes

Intersection point



# Determining the Sun Vector

The Sun

1 vector

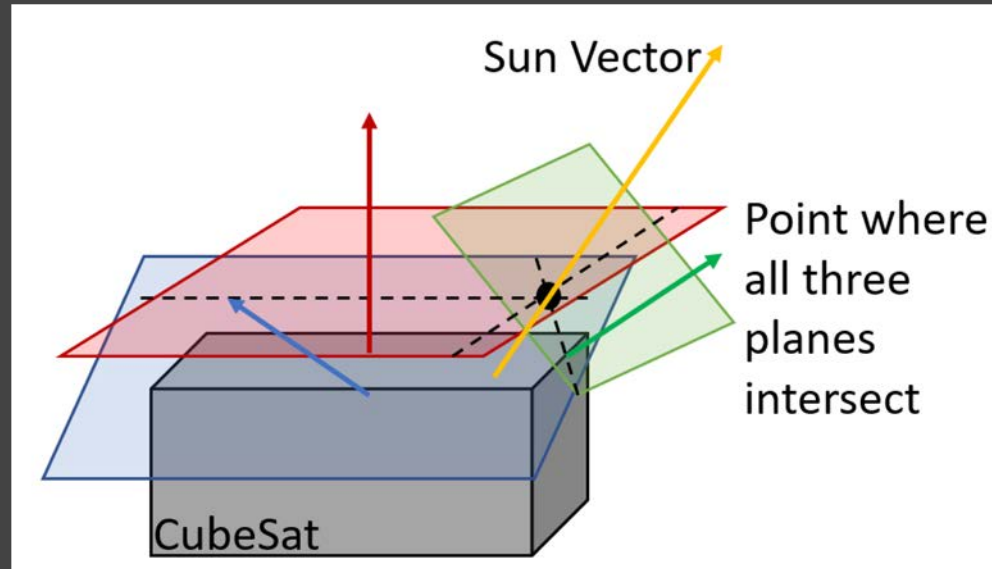
From 3 diodes

3 vectors

3 angles

3 planes

Intersection point



Sun Vector

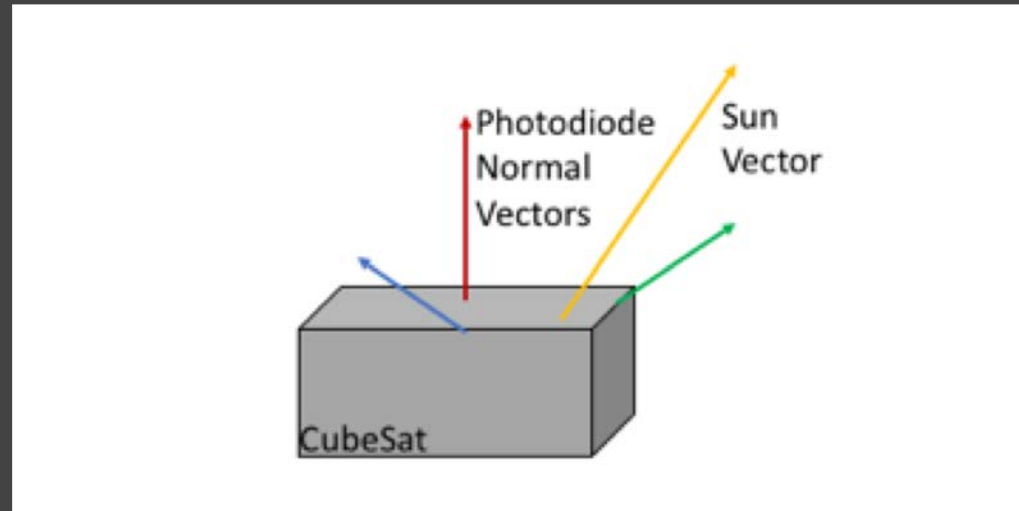
# Determining the Sun Vector

The Sun

1 vector

From 3 diodes

3 vectors



# Determining the Sun Vector

The Sun

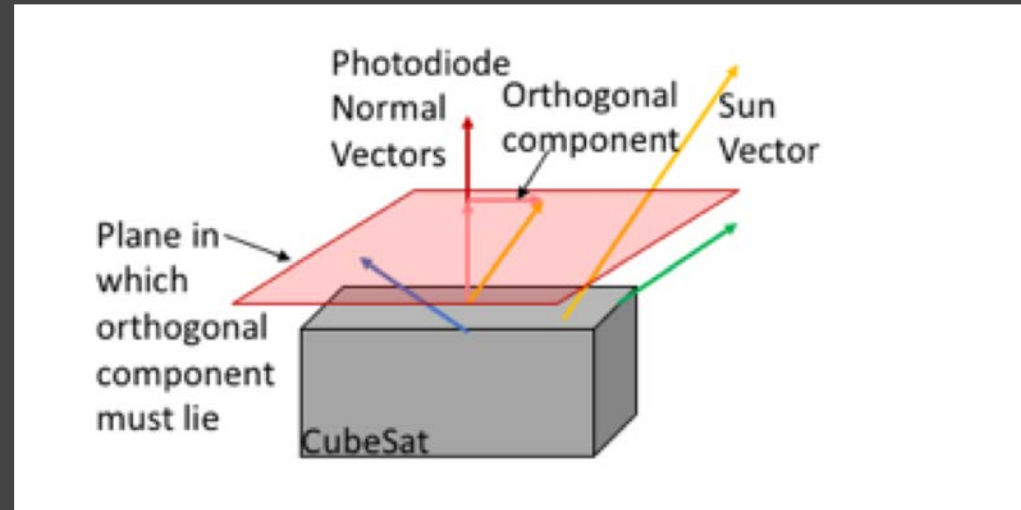
1 vector

From 3 diodes

3 vectors

3 angles

3 planes



# Equations for Intersection



$$\hat{Z}_{11}(X - \hat{Z}_{11}\cos(\alpha_1)) + \hat{Z}_{12}(Y - \hat{Z}_{12}\cos(\alpha_1)) + \hat{Z}_{13}(Z - \hat{Z}_{13}\cos(\alpha_1)) = 0$$

$$\hat{Z}_{21}(X - \hat{Z}_{21}\cos(\alpha_2)) + \hat{Z}_{22}(Y - \hat{Z}_{22}\cos(\alpha_2)) + \hat{Z}_{23}(Z - \hat{Z}_{23}\cos(\alpha_2)) = 0$$

$$\hat{Z}_{31}(X - \hat{Z}_{31}\cos(\alpha_3)) + \hat{Z}_{32}(Y - \hat{Z}_{32}\cos(\alpha_3)) + \hat{Z}_{33}(Z - \hat{Z}_{33}\cos(\alpha_3)) = 0$$

$\hat{Z}_{xy}$  is the  $x^{\text{th}}$  photodiode vector  $y^{\text{th}}$  component

$\alpha_x$  is the  $x^{\text{th}}$  photodiode sun angle

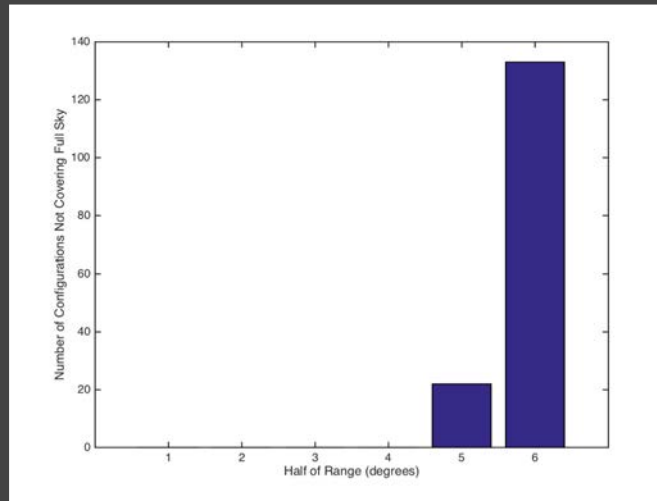
X,Y,Z are the body components of the sun vector

# ARS Photodiode Mounting

Photodiodes will not be placed with perfect angular position

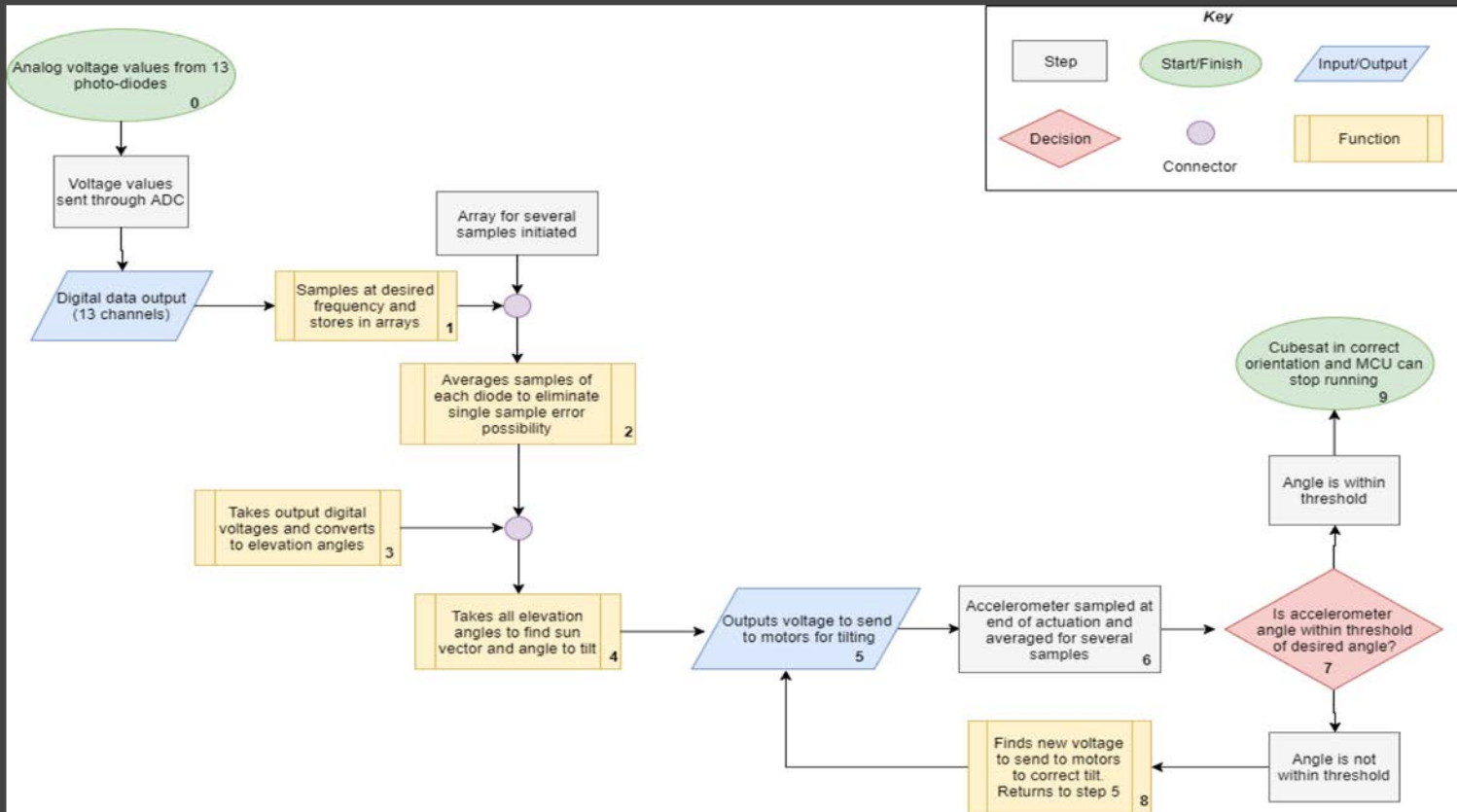
Need to maintain full sky coverage

Based on a Monte-Carlo analysis, we can maintain full sky coverage with 5 of mounting accuracy





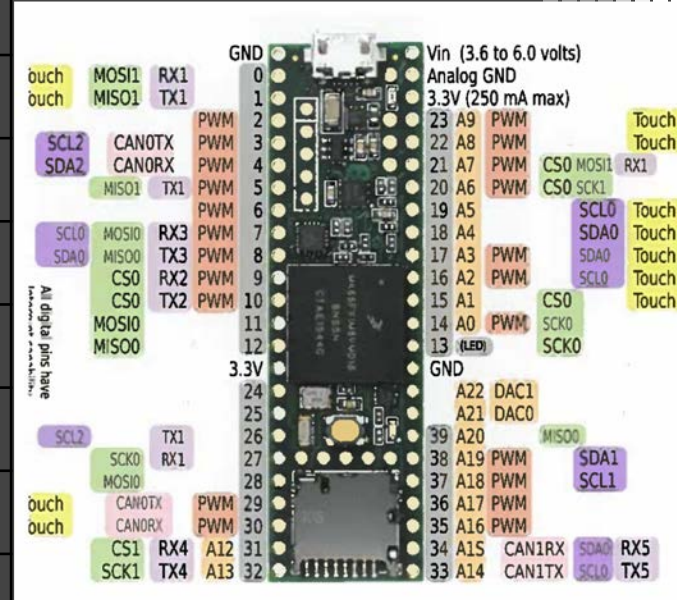
# ARS Software



# ARS Microcontroller

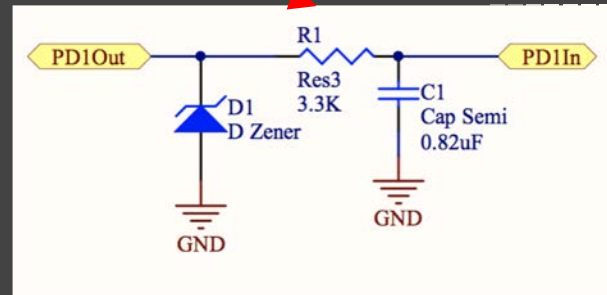
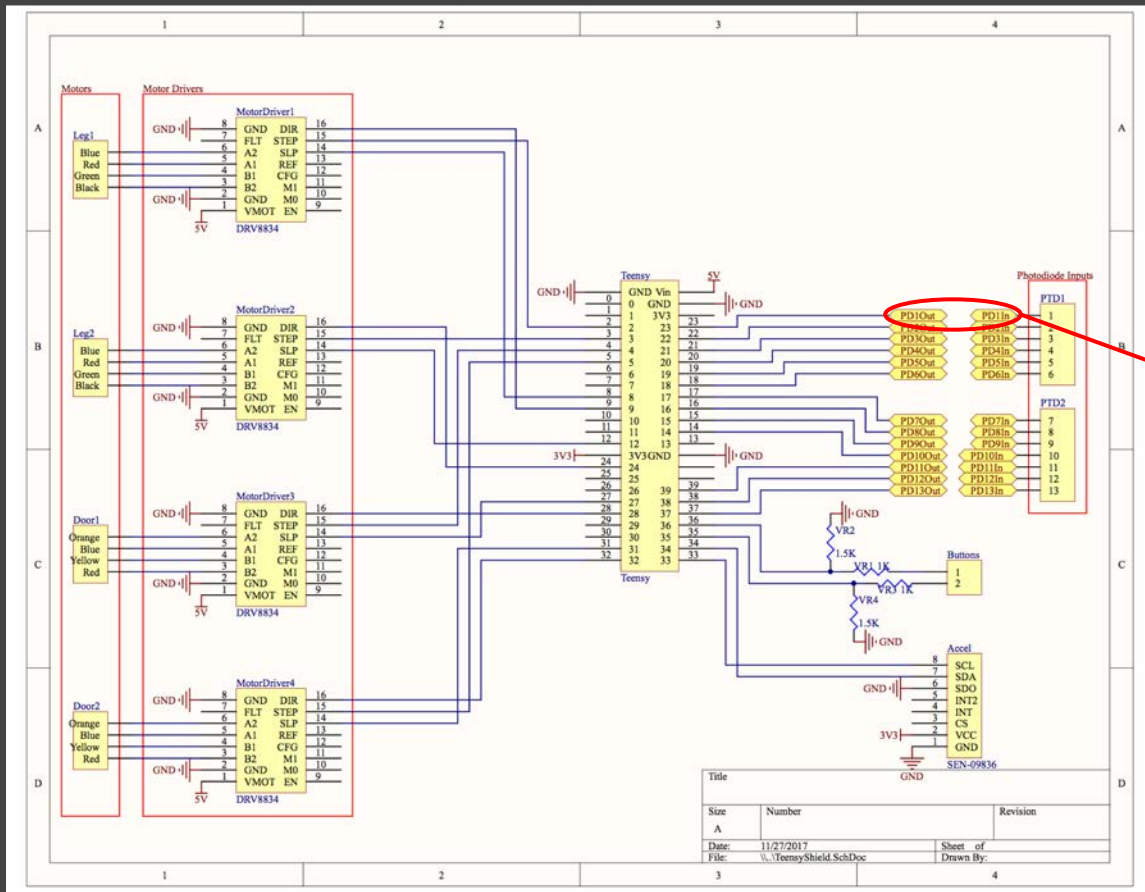


Component	Type/# of Component Pins	Pins on Teensy
Motor Drivers (x4)	Digital/4 (x4)*	6-12 and 24-32
	PWM/1 (x4)	2-5
Buttons (x2)	Digital/1 (x2)	35-36
Accelerometer	SPI/2	33-34
Photodiodes (x13)	Analog/1 (x13)	14-23
Door Command	Digital/1	0
Data Transmit	Serial/1	USB



\* Note: 2 pins on each motor driver can be permanently set and do not require connection to Teensy reducing total pins required to 8

# ARS Teensy Shield



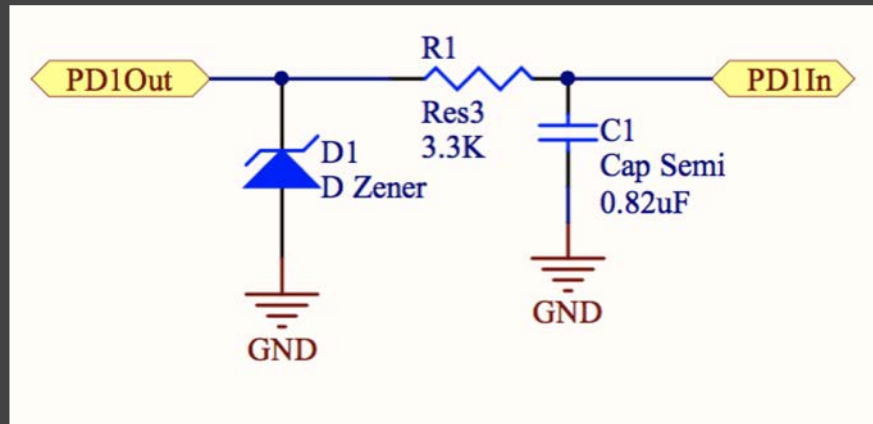
Title		
Size	Number	Revision
A		
Date:	11/27/2017	Sheet of
File:	\\...TeensyShield SchDoc	Drawn By:



# ARS Photodiode Noise

Photodiode, amplifiers, and transmission wires will create noise in signal.

To reduce noise, low-pass filters were added to the design to remove random noise.



# ARS Requirements Development

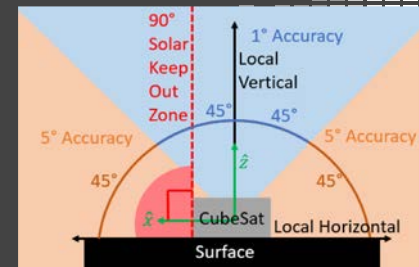


Due to the 1D tilting design, only the projection of the sun vector onto the X-Z plane must be accurate to within 1 degree

However, full sky coverage requirement forces us to know sun vector to within 1 degree

At +/- Y sides of CubeSat 1 degree of error in full vector is 1 degree of error in projection

Result is that we must know sun vector to 1 accuracy.



# ARS Photodiode Resolution



Covers restrict field of view to increase resolution

Resolution must be less than  $1^\circ$  to meet accuracy of  $1^\circ$

Assumptions:

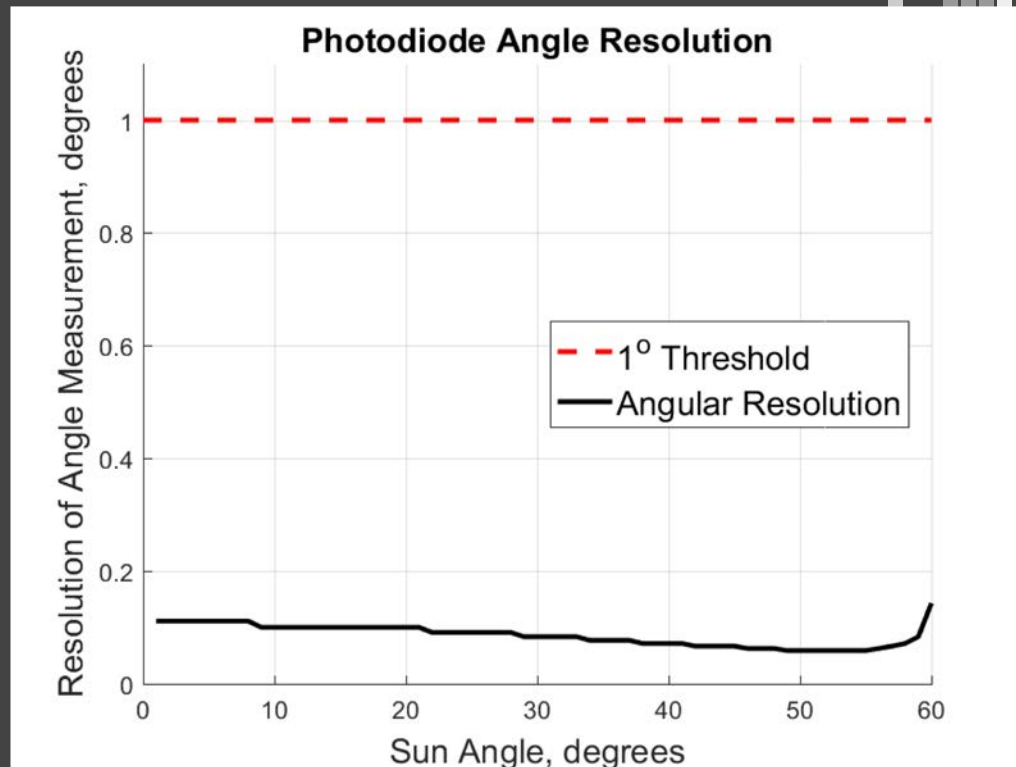
Background brightness is  $\frac{1}{4}$

Earth maximum

Only  $\frac{3}{4}$  of 10 bit ADC range used for angle measurement

Voltage at  $0^\circ$  (direct sun) is ADC maximum

Worst resolution  $0.15^\circ < 1^\circ$





# Nominal Design Case - Unfiltered Signal

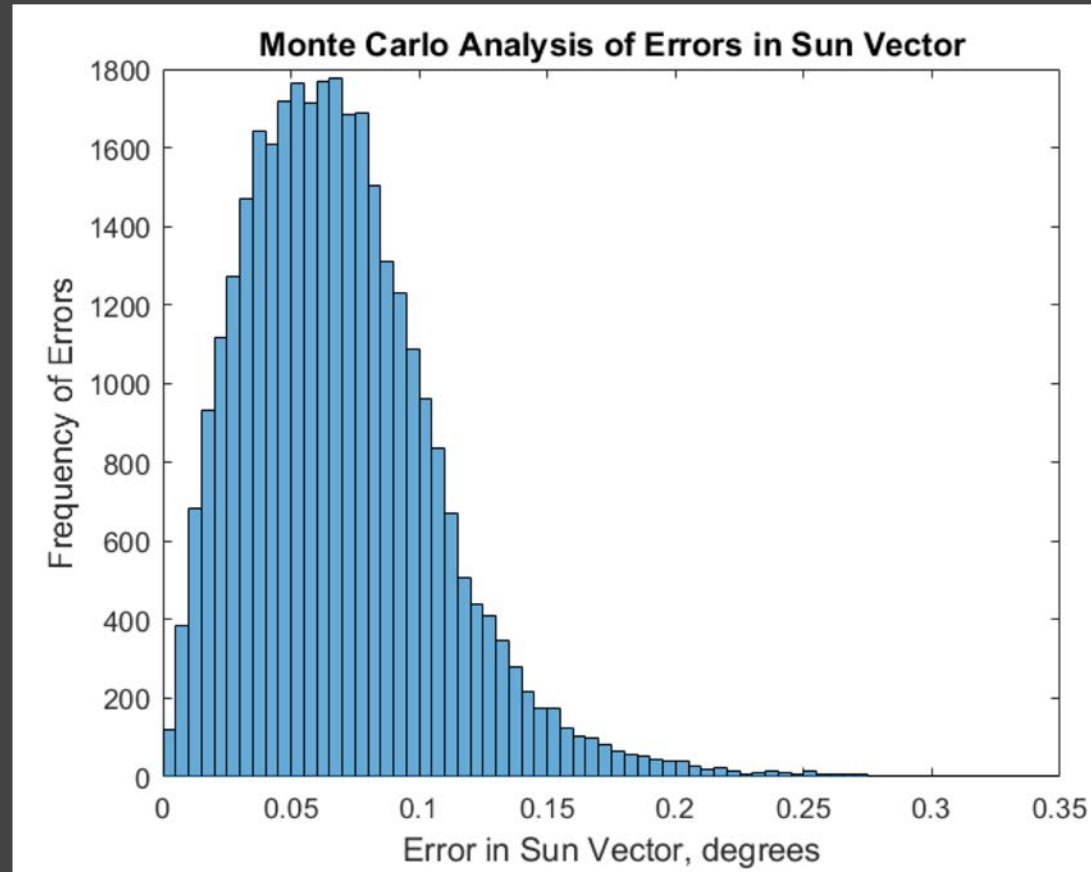
Varied thermal and sampling noise uniformly  
30,000 iterations  
Maximum error in sun vector is  $0.35^\circ$

Worst Errors  $0.35^\circ < 1^\circ$



Requirement 3.2.2 satisfied

However, margin is a concern  
Manufacturing tolerances could push above  $1^\circ$





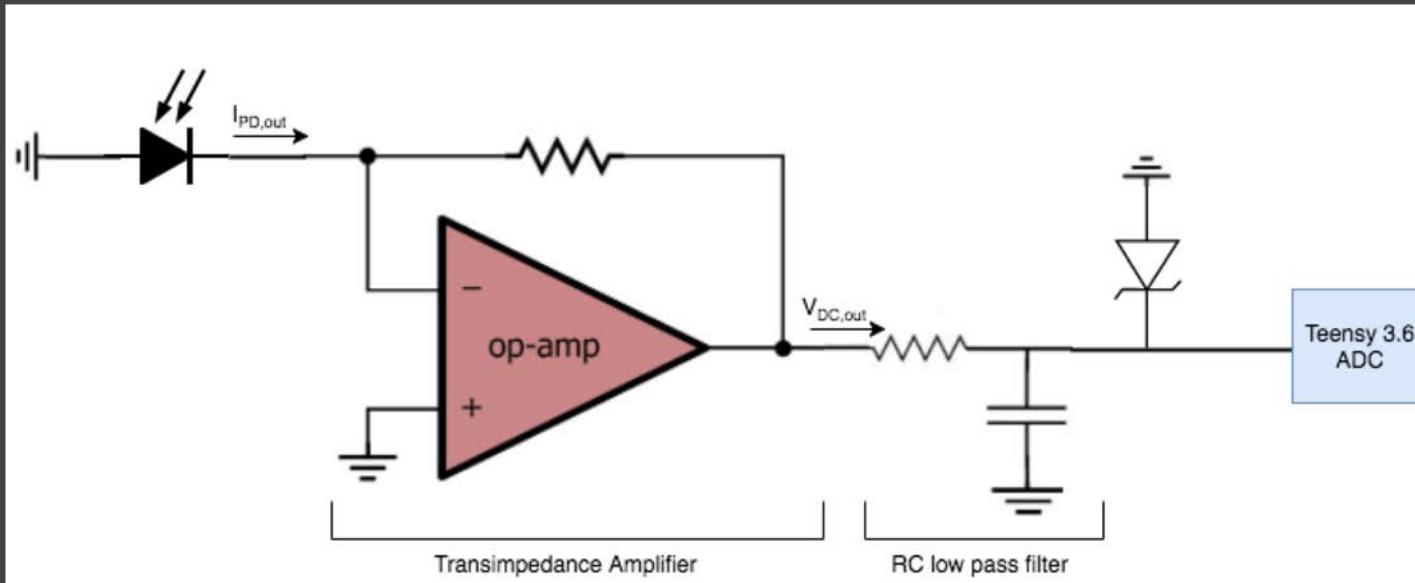
# ARS Photodiode Signal Processing

Transimpedance amplifier

Converts current to voltage and amplifies signal

RC low pass filter:  $R = 3.6\text{k}\Omega$ ,  $C = 0.82\mu\text{F}$

Filters signals  $F_c \geq 51.4\text{Hz}$  (filters lab environment noise at 60Hz)





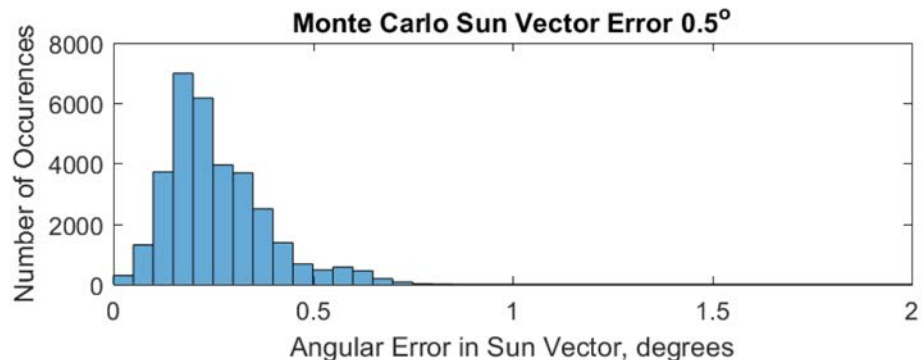
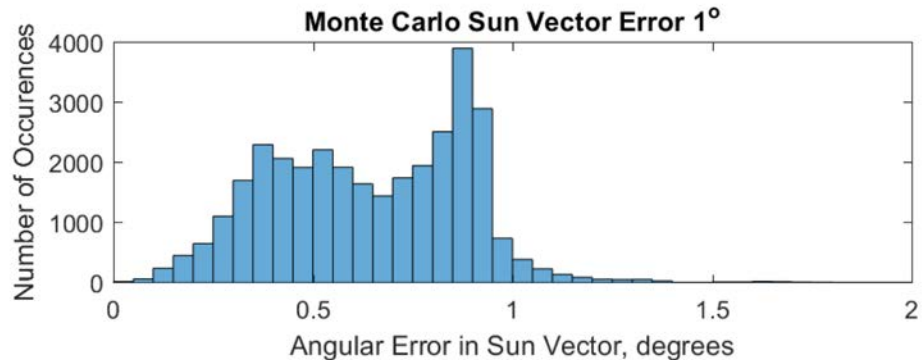
# Off-Nominal Design Case



Photodiodes won't be mounted perfectly  
Knowing position improves accuracy  
ARS component level testing will allow us to find these errors

Worst Errors  $0.75^\circ < 1^\circ$

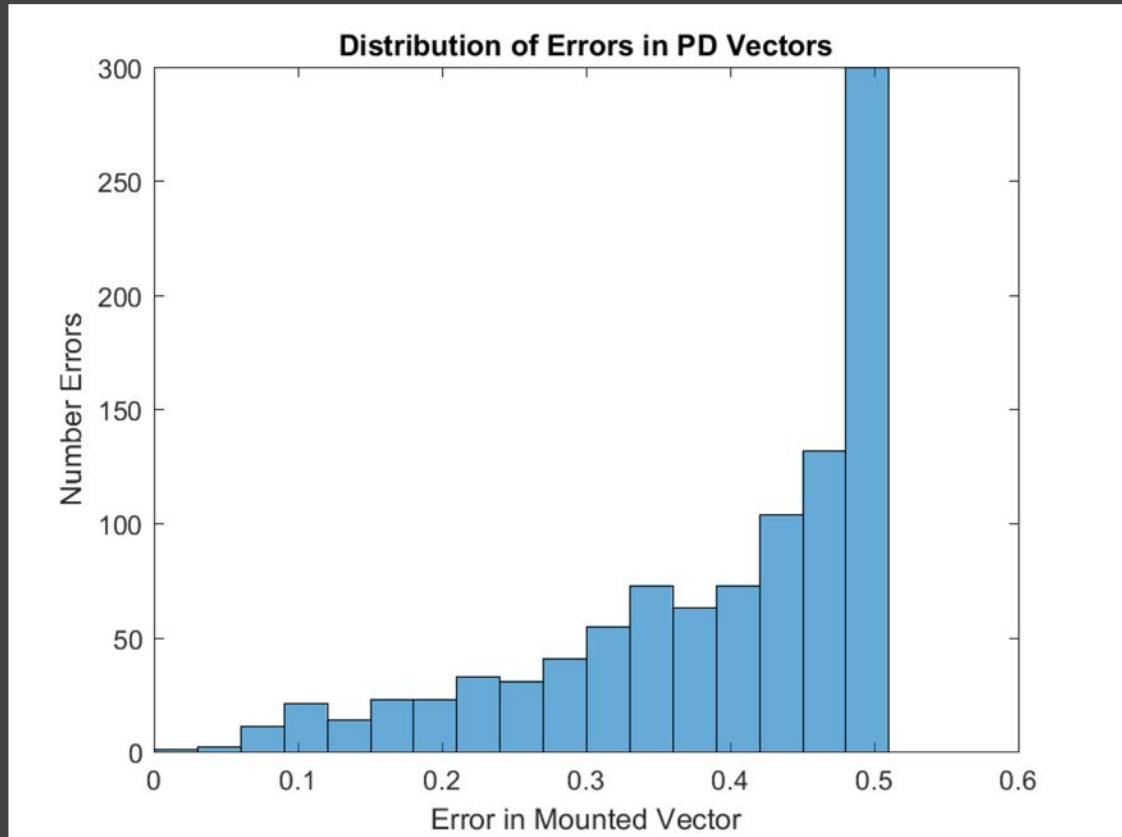
Requirement 3.2.2 satisfied



# Off-Nominal Design Case



Distribution of Errors in  
Off-Nominal simulation  
Difficulty making a 'good'  
distribution





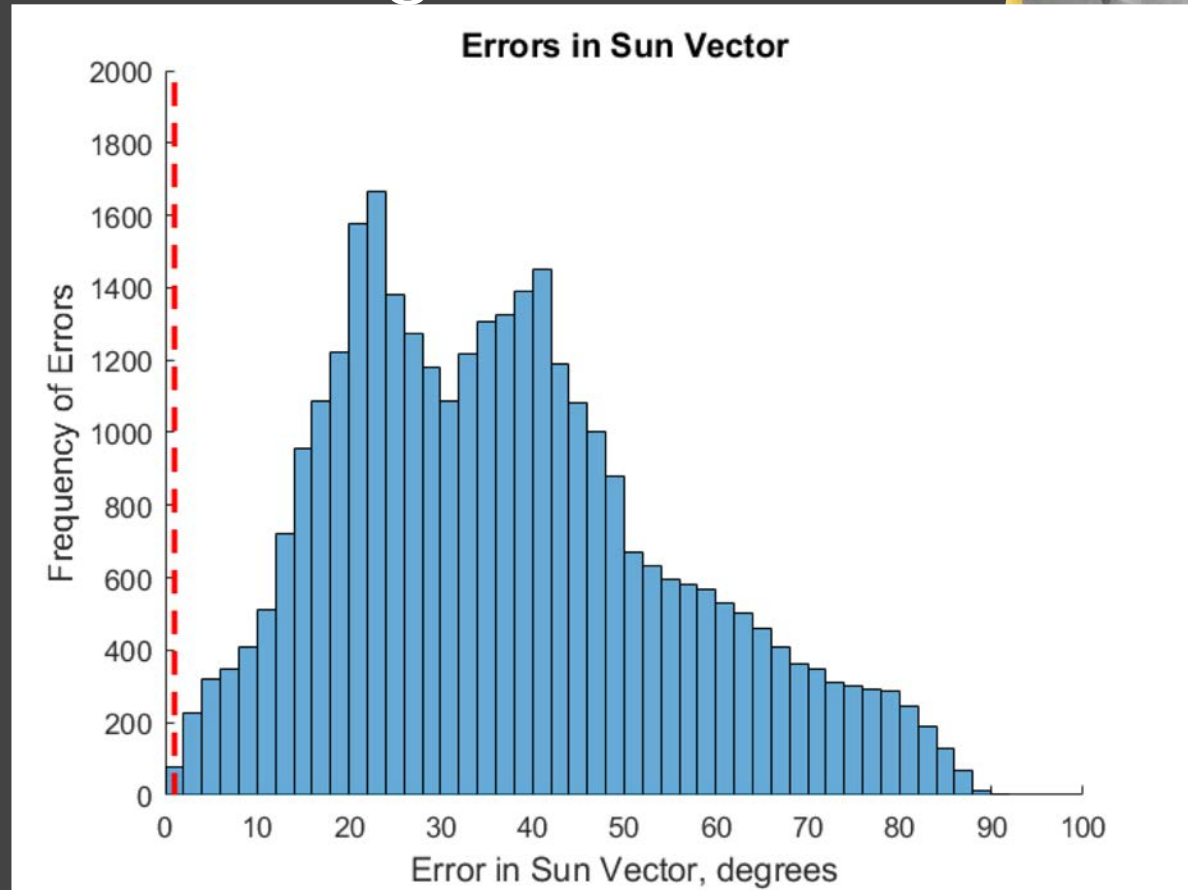
# Off-Nominal Design Case

We are having issues correctly modeling the error from photodiode covers  
Minute (0.0005 mm) changes in manufacturing tolerances cause outrageous errors

- Sun angle
- Photodiode Voltage

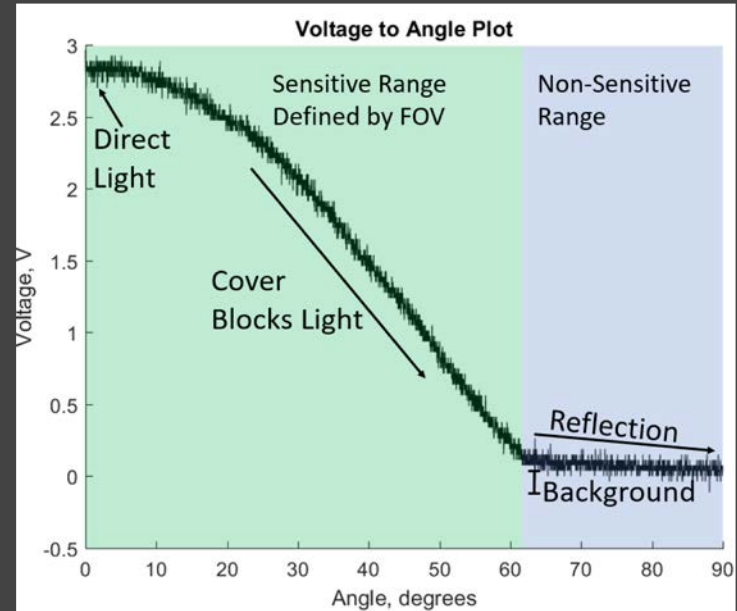
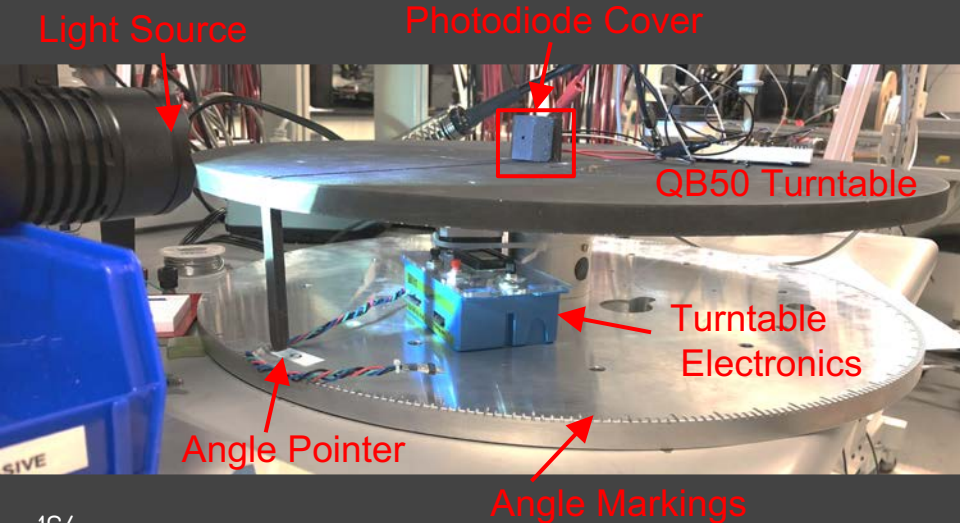
Two Options:

- Off ramp to which side is sunnier
- Calibrate out photodiode cover error



# Photodiode Calibration

QB50 Turntable to measure angle  
 Oscilloscope to measure voltage  
 Build a table of Voltage vs Angle



# ARS Sensors Status



## Completed

- Test PCBs ordered and verifying
- Test cases printed

## Future Work

- Print all cases (Easy)
- Order all PCB copies and mount components (Easy, time consuming)
- Calibrate PCB and cover sets (Difficult, bulk of ARS work)
- Integrate with CubeSat (Medium)
- Cable routing (Unknown)